



Hewlett Packard
Enterprise

HPE ProLiant DL385p Gen8 Server

Maintenance and Service Guide

Abstract

This guide describes identification and maintenance procedures, diagnostic tools, specifications, and requirements for hardware components and software. This guide is for an experienced service technician. Hewlett Packard Enterprise assumes you are qualified in the servicing of computer equipment, trained in recognizing hazards in products, and are familiar with weight and stability precautions.

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Contents

Customer self repair	5
Parts only warranty service	5
Illustrated parts catalog.....	15
Mechanical components.....	15
System components.....	19
Removal and replacement procedures	25
Required tools	25
Preparation procedures.....	25
Power down the server.....	25
Extend the server from the rack	26
Remove the server from the rack	27
Access the Systems Insight Display.....	27
Access the product rear panel.....	28
Release the full-length expansion board retainer	28
Safety considerations	29
Symbols on equipment.....	29
Server warnings and cautions	30
Access panel	30
Remove the air baffle	31
2U rack bezel	32
PCIe riser blank.....	32
Remove the primary PCIe riser cage	33
Remove the secondary PCIe riser cage.....	34
PCIe riser board	35
Drive blank	36
Hot-plug drive	36
Power supply blank	37
AC power supply	37
Optical drive	38
Power supply backplane	39
Hot-plug fan.....	40
Fan cage	41
FlexibleLOM	42
SFF hard drive cage.....	44
Systems Insight Display	44
Front panel assembly	45
Flash-backed write cache procedures.....	46
Flash-backed write cache module	47
Flash-backed write cache capacitor pack.....	48
Recovering data from the flash-backed write cache	51
Expansion slot blanks.....	52
Expansion boards.....	52
Half-length expansion board.....	52
Full length expansion board	53
Heatsink	54
Processor	56
DIMMs	61
System battery	62
System board	63
150W PCIe power cable option.....	69
Chipset SATA cable option	70
HP Trusted Platform Module	71

Troubleshooting	72
Troubleshooting resources	72
HPE Insight Diagnostics	72
HPE Insight Diagnostics survey functionality	72
HPE ROM-Based Setup Utility	73
Integrated Management Log	73
USB support and functionality	73
USB support	73
Internal USB functionality	74
External USB functionality	74
Component identification	75
Front panel components	75
Front panel LEDs and buttons	77
Systems Insight Display LEDs	79
Systems Insight Display LED combinations	80
Rear panel components	81
Rear panel LEDs and buttons	81
Non-hot-plug PCIe riser board slot definitions	82
System board components	83
System maintenance switch	84
NMI functionality	84
DIMM slot locations	85
SAS and SATA device numbers	85
Hot-plug drive LED definitions	86
PCIe riser cage LED	87
FBWC module LEDs (P222, P420, P421)	88
Hot-plug fans	89
Cabling	90
SAS hard drive cabling	90
Optical drive cabling	91
FBWC cabling	92
Specifications	94
Environmental specifications	94
Mechanical specifications	94
Power supply specifications	94
460 W CS Gold power supply (92% efficiency)	95
460 W CS Platinum Plus power supply (94% efficiency)	95
750 W CS Gold power supply (92% efficiency)	95
750 W CS Platinum Plus power supply (94% efficiency)	96
750 W 48V CS DC power supply (94% efficiency)	96
1200 W CS Platinum Plus Power Supply (90% efficiency)	97
Acronyms and abbreviations	98
Documentation feedback	100
Index	101

Customer self repair

Hewlett Packard Enterprise products are designed with many Customer Self Repair (CSR) parts to minimize repair time and allow for greater flexibility in performing defective parts replacement. If during the diagnosis period Hewlett Packard Enterprise (or Hewlett Packard Enterprise service providers or service partners) identifies that the repair can be accomplished by the use of a CSR part, Hewlett Packard Enterprise will ship that part directly to you for replacement. There are two categories of CSR parts:

- **Mandatory**—Parts for which customer self repair is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.
- **Optional**—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that Hewlett Packard Enterprise replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

NOTE: Some Hewlett Packard Enterprise parts are not designed for customer self repair. In order to satisfy the customer warranty, Hewlett Packard Enterprise requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

Based on availability and where geography permits, CSR parts will be shipped for next business day delivery. Same day or four-hour delivery may be offered at an additional charge where geography permits. If assistance is required, you can call the Hewlett Packard Enterprise Support Center and a technician will help you over the telephone. Hewlett Packard Enterprise specifies in the materials shipped with a replacement CSR part whether a defective part must be returned to Hewlett Packard Enterprise. In cases where it is required to return the defective part to Hewlett Packard Enterprise, you must ship the defective part back to Hewlett Packard Enterprise within a defined period of time, normally five (5) business days. The defective part must be returned with the associated documentation in the provided shipping material. Failure to return the defective part may result in Hewlett Packard Enterprise billing you for the replacement. With a customer self repair, Hewlett Packard Enterprise will pay all shipping and part return costs and determine the courier/carrier to be used.

For more information about the Hewlett Packard Enterprise CSR program, contact your local service provider. For the North American program, go to the Hewlett Packard Enterprise CSR website (<http://www.hpe.com/support/selfrepair>).

Parts only warranty service

Your Hewlett Packard Enterprise Limited Warranty may include a parts only warranty service. Under the terms of parts only warranty service, Hewlett Packard Enterprise will provide replacement parts free of charge.

For parts only warranty service, CSR part replacement is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.

Réparation par le client (CSR)

Les produits Hewlett Packard Enterprise comportent de nombreuses pièces CSR (Customer Self Repair = réparation par le client) afin de minimiser les délais de réparation et faciliter le remplacement des pièces défectueuses. Si pendant la période de diagnostic, Hewlett Packard Enterprise (ou ses partenaires ou mainteneurs agréés) détermine que la réparation peut être effectuée à l'aide d'une pièce CSR, Hewlett Packard Enterprise vous l'envoie directement. Il existe deux catégories de pièces CSR :

- **Obligatoire**—Pièces pour lesquelles la réparation par le client est obligatoire. Si vous demandez à Hewlett Packard Enterprise de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.
- **Facultatif**—Pièces pour lesquelles la réparation par le client est facultative. Ces pièces sont également conçues pour permettre au client d'effectuer lui-même la réparation. Toutefois, si vous demandez à Hewlett Packard Enterprise de remplacer ces pièces, l'intervention peut ou non vous être facturée, selon le type de garantie applicable à votre produit.

REMARQUE: Certaines pièces Hewlett Packard Enterprise ne sont pas conçues pour permettre au client d'effectuer lui-même la réparation. Pour que la garantie puisse s'appliquer, Hewlett Packard Enterprise exige que le remplacement de la pièce soit effectué par un Mainteneur Agréé. Ces pièces sont identifiées par la mention "Non" dans le Catalogue illustré.

Les pièces CSR sont livrées le jour ouvré suivant, dans la limite des stocks disponibles et selon votre situation géographique. Si votre situation géographique le permet et que vous demandez une livraison le jour même ou dans les 4 heures, celle-ci vous sera facturée. Pour toute assistance, appelez le Centre d'assistance Hewlett Packard Enterprise pour qu'un technicien vous aide au téléphone. Dans les documents envoyés avec la pièce de rechange CSR, Hewlett Packard Enterprise précise s'il est nécessaire de lui retourner la pièce défectueuse. Si c'est le cas, vous devez le faire dans le délai indiqué, généralement cinq (5) jours ouvrés. La pièce et sa documentation doivent être retournées dans l'emballage fourni. Si vous ne retournez pas la pièce défectueuse, Hewlett Packard Enterprise se réserve le droit de vous facturer les coûts de remplacement. Dans le cas d'une pièce CSR, Hewlett Packard Enterprise supporte l'ensemble des frais d'expédition et de retour, et détermine la société de courses ou le transporteur à utiliser.

Pour plus d'informations sur le programme CSR de Hewlett Packard Enterprise, contactez votre Mainteneur Agréé local. Pour plus d'informations sur ce programme en Amérique du Nord, consultez le site Web Hewlett Packard Enterprise (<http://www.hpe.com/support/selfrepair>).

Service de garantie "pièces seules"

Votre garantie limitée Hewlett Packard Enterprise peut inclure un service de garantie "pièces seules". Dans ce cas, les pièces de rechange fournies par Hewlett Packard Enterprise ne sont pas facturées.

Dans le cadre de ce service, la réparation des pièces CSR par le client est obligatoire. Si vous demandez à Hewlett Packard Enterprise de remplacer ces pièces, les coûts de déplacement et main d'œuvre du service vous seront facturés.

Riparazione da parte del cliente

Per abbreviare i tempi di riparazione e garantire una maggiore flessibilità nella sostituzione di parti difettose, i prodotti Hewlett Packard Enterprise sono realizzati con numerosi componenti che possono essere riparati direttamente dal cliente (CSR, Customer Self Repair). Se in fase di diagnostica Hewlett Packard Enterprise (o un centro di servizi o di assistenza Hewlett Packard Enterprise) identifica il guasto come riparabile mediante un ricambio CSR, Hewlett Packard Enterprise lo spedisce direttamente al cliente per la sostituzione. Vi sono due categorie di parti CSR:

- **Obbligatorie**—Parti che devono essere necessariamente riparate dal cliente. Se il cliente ne affida la riparazione ad Hewlett Packard Enterprise, deve sostenere le spese di spedizione e di manodopera per il servizio.
- **Opzionali**—Parti la cui riparazione da parte del cliente è facoltativa. Si tratta comunque di componenti progettati per questo scopo. Se tuttavia il cliente ne richiede la sostituzione ad Hewlett Packard Enterprise, potrebbe dover sostenere spese aggiuntive a seconda del tipo di garanzia previsto per il prodotto.

NOTA: alcuni componenti Hewlett Packard Enterprise non sono progettati per la riparazione da parte del cliente. Per rispettare la garanzia, Hewlett Packard Enterprise richiede che queste parti siano sostituite da un centro di assistenza autorizzato. Tali parti sono identificate da un "No" nel Catalogo illustrato dei componenti.

In base alla disponibilità e alla località geografica, le parti CSR vengono spedite con consegna entro il giorno lavorativo seguente. La consegna nel giorno stesso o entro quattro ore è offerta con un supplemento di costo solo in alcune zone. In caso di necessità si può richiedere l'assistenza telefonica di un addetto del centro di supporto tecnico Hewlett Packard Enterprise. Nel materiale fornito con una parte di ricambio CSR, Hewlett Packard Enterprise specifica se il cliente deve restituire dei componenti. Qualora sia richiesta la resa ad Hewlett Packard Enterprise del componente difettoso, lo si deve spedire ad Hewlett Packard Enterprise entro un determinato periodo di tempo, generalmente cinque (5) giorni lavorativi. Il componente difettoso deve essere restituito con la documentazione associata nell'imballo di spedizione fornito. La mancata restituzione del componente può comportare la fatturazione del ricambio da parte di Hewlett Packard Enterprise. Nel caso di riparazione da parte del cliente, Hewlett Packard Enterprise sostiene tutte le spese di spedizione e resa e sceglie il corriere/vettore da utilizzare.

Per ulteriori informazioni sul programma CSR di Hewlett Packard Enterprise, contattare il centro di assistenza di zona. Per il programma in Nord America fare riferimento al sito Web (<http://www.hpe.com/support/selfrepair>).

Servizio di garanzia per i soli componenti

La garanzia limitata Hewlett Packard Enterprise può includere un servizio di garanzia per i soli componenti. Nei termini di garanzia del servizio per i soli componenti, Hewlett Packard Enterprise fornirà gratuitamente le parti di ricambio.

Per il servizio di garanzia per i soli componenti è obbligatoria la formula CSR che prevede la riparazione da parte del cliente. Se il cliente invece richiede la sostituzione ad Hewlett Packard Enterprise dovrà sostenere le spese di spedizione e di manodopera per il servizio.

Customer Self Repair

Hewlett Packard Enterprise Produkte enthalten viele CSR-Teile (Customer Self Repair), um Reparaturzeiten zu minimieren und höhere Flexibilität beim Austausch defekter Bauteile zu ermöglichen. Wenn Hewlett Packard Enterprise (oder ein Hewlett Packard Enterprise Servicepartner) bei der Diagnose feststellt, dass das Produkt mithilfe eines CSR-Teils repariert werden kann, sendet Ihnen Hewlett Packard Enterprise dieses Bauteil zum Austausch direkt zu. CSR-Teile werden in zwei Kategorien unterteilt:

- **Zwingend**—Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.
- **Optional**—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

HINWEIS: Einige Hewlett Packard Enterprise Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem Hewlett Packard Enterprise Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

CSR-Teile werden abhängig von der Verfügbarkeit und vom Lieferziel am folgenden Geschäftstag geliefert. Für bestimmte Standorte ist eine Lieferung am selben Tag oder innerhalb von vier Stunden gegen einen Aufpreis verfügbar. Wenn Sie Hilfe benötigen, können Sie das Hewlett Packard Enterprise

Support Center anrufen und sich von einem Mitarbeiter per Telefon helfen lassen. Den Materialien von Hewlett Packard Enterprise, die mit einem CSR-Ersatzteil geliefert werden, können Sie entnehmen, ob das defekte Teil an Hewlett Packard Enterprise zurückgeschickt werden muss. Wenn es erforderlich ist, das defekte Teil an Hewlett Packard Enterprise zurückzuschicken, müssen Sie dies innerhalb eines vorgegebenen Zeitraums tun, in der Regel innerhalb von fünf (5) Geschäftstagen. Das defekte Teil muss mit der zugehörigen Dokumentation in der Verpackung zurückgeschickt werden, die im Lieferumfang enthalten ist. Wenn Sie das defekte Teil nicht zurückschicken, kann Hewlett Packard Enterprise Ihnen das Ersatzteil in Rechnung stellen. Im Falle von Customer Self Repair kommt Hewlett Packard Enterprise für alle Kosten für die Lieferung und Rücksendung auf und bestimmt den Kurier-/Frachtdienst.

Weitere Informationen über das Hewlett Packard Enterprise Customer Self Repair Programm erhalten Sie von Ihrem Servicepartner vor Ort. Informationen über das CSR-Programm in Nordamerika finden Sie auf der Hewlett Packard Enterprise Website unter (<http://www.hpe.com/support/selfrepair>).

Parts-only Warranty Service (Garantieservice ausschließlich für Teile)

Ihre Hewlett Packard Enterprise Garantie umfasst möglicherweise einen Parts-only Warranty Service (Garantieservice ausschließlich für Teile). Gemäß den Bestimmungen des Parts-only Warranty Service stellt Hewlett Packard Enterprise Ersatzteile kostenlos zur Verfügung.

Für den Parts-only Warranty Service ist das CSR-Verfahren zwingend vorgegeben. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

Reparaciones del propio cliente

Los productos de Hewlett Packard Enterprise incluyen muchos componentes que el propio usuario puede reemplazar (Customer Self Repair, CSR) para minimizar el tiempo de reparación y ofrecer una mayor flexibilidad a la hora de realizar sustituciones de componentes defectuosos. Si, durante la fase de diagnóstico, Hewlett Packard Enterprise (o los proveedores o socios de servicio de Hewlett Packard Enterprise) identifica que una reparación puede llevarse a cabo mediante el uso de un componente CSR, Hewlett Packard Enterprise le enviará dicho componente directamente para que realice su sustitución. Los componentes CSR se clasifican en dos categorías:

- **Obligatorio**—Componentes cuya reparación por parte del usuario es obligatoria. Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.
- **Opcional**—Componentes cuya reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que Hewlett Packard Enterprise realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

NOTA: Algunos componentes de Hewlett Packard Enterprise no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, Hewlett Packard Enterprise pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

Según la disponibilidad y la situación geográfica, los componentes CSR se enviarán para que lleguen a su destino al siguiente día laborable. Si la situación geográfica lo permite, se puede solicitar la entrega en el mismo día o en cuatro horas con un coste adicional. Si precisa asistencia técnica, puede llamar al Centro de asistencia técnica de Hewlett Packard Enterprise y recibirá ayuda telefónica por parte de un técnico. Con el envío de materiales para la sustitución de componentes CSR, Hewlett Packard Enterprise especificará si los componentes defectuosos deberán devolverse a Hewlett Packard Enterprise. En aquellos casos en los que sea necesario devolver algún componente a Hewlett Packard Enterprise,

deberá hacerlo en el periodo de tiempo especificado, normalmente cinco días laborables. Los componentes defectuosos deberán devolverse con toda la documentación relacionada y con el embalaje de envío. Si no enviara el componente defectuoso requerido, Hewlett Packard Enterprise podrá cobrarle por el de sustitución. En el caso de todas sustituciones que lleve a cabo el cliente, Hewlett Packard Enterprise se hará cargo de todos los gastos de envío y devolución de componentes y escogerá la empresa de transporte que se utilice para dicho servicio.

Para obtener más información acerca del programa de Reparaciones del propio cliente de Hewlett Packard Enterprise, póngase en contacto con su proveedor de servicios local. Si está interesado en el programa para Norteamérica, visite la página web de Hewlett Packard Enterprise CSR (<http://www.hpe.com/support/selfrepair>).

Servicio de garantía exclusivo de componentes

La garantía limitada de Hewlett Packard Enterprise puede que incluya un servicio de garantía exclusivo de componentes. Según las condiciones de este servicio exclusivo de componentes, Hewlett Packard Enterprise le facilitará los componentes de repuesto sin cargo adicional alguno.

Para este servicio de garantía exclusivo de componentes, es obligatoria la sustitución de componentes por parte del usuario (CSR). Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

Customer Self Repair

Veel onderdelen in Hewlett Packard Enterprise producten zijn door de klant zelf te repareren, waardoor de reparatieduur tot een minimum beperkt kan blijven en de flexibiliteit in het vervangen van defecte onderdelen groter is. Deze onderdelen worden CSR-onderdelen (Customer Self Repair) genoemd. Als Hewlett Packard Enterprise (of een Hewlett Packard Enterprise Service Partner) bij de diagnose vaststelt dat de reparatie kan worden uitgevoerd met een CSR-onderdeel, verzendt Hewlett Packard Enterprise dat onderdeel rechtstreeks naar u, zodat u het defecte onderdeel daarmee kunt vervangen. Er zijn twee categorieën CSR-onderdelen:

- **Verplicht**—Onderdelen waarvoor reparatie door de klant verplicht is. Als u Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht.
- **Optioneel**—Onderdelen waarvoor reparatie door de klant optioneel is. Ook deze onderdelen zijn ontworpen voor reparatie door de klant. Als u echter Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, kunnen daarvoor extra kosten in rekening worden gebracht, afhankelijk van het type garantieservice voor het product.

OPMERKING: Sommige Hewlett Packard Enterprise onderdelen zijn niet ontwikkeld voor reparatie door de klant. In verband met de garantievoorwaarden moet het onderdeel door een geautoriseerde Service Partner worden vervangen. Deze onderdelen worden in de geïllustreerde onderdelencatalogus aangemerkt met "Nee".

Afhankelijk van de leverbaarheid en de locatie worden CSR-onderdelen verzonden voor levering op de eerstvolgende werkdag. Levering op dezelfde dag of binnen vier uur kan tegen meerkosten worden aangeboden, indien dit mogelijk is gezien de locatie. Indien assistentie is gewenst, belt u het Hewlett Packard Enterprise Support Center om via de telefoon ondersteuning van een technicus te ontvangen. Hewlett Packard Enterprise vermeldt in de documentatie bij het vervangende CSR-onderdeel of het defecte onderdeel aan Hewlett Packard Enterprise moet worden geretourneerd. Als het defecte onderdeel aan Hewlett Packard Enterprise moet worden teruggezonden, moet u het defecte onderdeel binnen een bepaalde periode, gewoonlijk vijf (5) werkdagen, retourneren aan Hewlett Packard Enterprise. Het defecte onderdeel moet met de bijbehorende documentatie worden geretourneerd in het meegeleverde verpakkingsmateriaal. Als u het defecte onderdeel niet terugzendt, kan Hewlett Packard

Enterprise u voor het vervangende onderdeel kosten in rekening brengen. Bij reparatie door de klant betaalt Hewlett Packard Enterprise alle verzendkosten voor het vervangende en geretourneerde onderdeel en kiest Hewlett Packard Enterprise zelf welke koerier/transportonderneming hiervoor wordt gebruikt.

Neem contact op met een Service Partner voor meer informatie over het Customer Self Repair programma van Hewlett Packard Enterprise. Informatie over Service Partners vindt u op de Hewlett Packard Enterprise website (<http://www.hpe.com/support/selfrepair>).

Garantieservice "Parts Only"

Het is mogelijk dat de Hewlett Packard Enterprise garantie alleen de garantieservice "Parts Only" omvat. Volgens de bepalingen van de Parts Only garantieservice zal Hewlett Packard Enterprise kosteloos vervangende onderdelen ter beschikking stellen.

Voor de Parts Only garantieservice is vervanging door CSR-onderdelen verplicht. Als u Hewlett Packard Enterprise verzoekt deze onderdelen voor u te vervangen, worden u voor deze service reiskosten en arbeidsloon in rekening gebracht

Reparo feito pelo cliente

Os produtos da Hewlett Packard Enterprise são projetados com muitas peças para reparo feito pelo cliente (CSR) de modo a minimizar o tempo de reparo e permitir maior flexibilidade na substituição de peças com defeito. Se, durante o período de diagnóstico, a Hewlett Packard Enterprise (ou fornecedores/parceiros da Hewlett Packard Enterprise) concluir que o reparo pode ser efetuado pelo uso de uma peça CSR, a Hewlett Packard Enterprise enviará a peça diretamente ao cliente. Há duas categorias de peças CSR:

- **Obrigatória**—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.
- **Opcional**—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a Hewlett Packard Enterprise as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

OBSERVAÇÃO: Algumas peças da Hewlett Packard Enterprise não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a Hewlett Packard Enterprise exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

Conforme a disponibilidade e o local geográfico, as peças CSR serão enviadas no primeiro dia útil após o pedido. Onde as condições geográficas permitirem, a entrega no mesmo dia ou em quatro horas pode ser feita mediante uma taxa adicional. Se precisar de auxílio, entre em contato com o Centro de suporte técnico da Hewlett Packard Enterprise para que um técnico o ajude por telefone. A Hewlett Packard Enterprise especifica nos materiais fornecidos com a peça CSR de reposição se a peça com defeito deve ser devolvida à Hewlett Packard Enterprise. Nos casos em que isso for necessário, é preciso enviar a peça com defeito à Hewlett Packard Enterprise, você deverá enviar a peça com defeito de volta para a Hewlett Packard Enterprise dentro do período de tempo definido, normalmente em 5 (cinco) dias úteis. A peça com defeito deve ser enviada com a documentação correspondente no material de transporte fornecido. Caso não o faça, a Hewlett Packard Enterprise poderá cobrar a reposição. Para as peças de reparo feito pelo cliente, a Hewlett Packard Enterprise paga todas as despesas de transporte e de devolução da peça e determina a transportadora/serviço postal a ser utilizado.

Para obter mais informações sobre o programa de reparo feito pelo cliente da Hewlett Packard Enterprise, entre em contato com o fornecedor de serviços local. Para o programa norte-americano, visite o site da Hewlett Packard Enterprise (<http://www.hpe.com/support/selfrepair>).

Serviço de garantia apenas para peças

A garantia limitada da Hewlett Packard Enterprise pode incluir um serviço de garantia apenas para peças. Segundo os termos do serviço de garantia apenas para peças, a Hewlett Packard Enterprise fornece as peças de reposição sem cobrar nenhuma taxa.

No caso desse serviço, a substituição de peças CSR é obrigatória. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

カスタマーセルフリペア

修理時間を短縮し、故障部品の交換における高い柔軟性を確保するために、Hewlett Packard Enterprise製品には多数のカスタマーセルフリペア（CSR）部品があります。診断の際に、CSR部品を使用すれば修理ができるかとHewlett Packard Enterprise（Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店）が判断した場合、Hewlett Packard Enterpriseはその部品を直接、お客様に発送し、お客様に交換していただきます。CSR部品には以下の2種類があります。

- **必須** - カスタマーセルフリペアが必須の部品。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。
- **任意** - カスタマーセルフリペアが任意である部品。この部品もカスタマーセルフリペア用です。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

注：Hewlett Packard Enterprise製品の一部の部品は、カスタマーセルフリペアの対象外です。製品の保証を継続するためには、Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

部品供給が可能な場合、地域によっては、CSR部品を翌営業日に届くように発送します。また、地域によっては、追加費用を負担いただくことにより同日または4時間以内に届くように発送することも可能な場合があります。サポートが必要なときは、Hewlett Packard Enterpriseサポートセンターに電話していただければ、技術者が電話でアドバイスします。交換用のCSR部品または同梱物には、故障部品をHewlett Packard Enterpriseに返送する必要があるかどうかが表示されています。故障部品をHewlett Packard Enterpriseに返送する必要がある場合は、指定期限内（通常は5営業日以内）に故障部品をHewlett Packard Enterpriseに返送してください。故障部品を返送する場合は、届いた時の梱包箱に関連書類とともにに入れてください。故障部品を返送しない場合、Hewlett Packard Enterpriseから部品費用が請求されます。カスタマーセルフリペアの際には、Hewlett Packard Enterpriseは送料および部品返送費を全額負担し、使用する宅配便会社や運送会社を指定します。

部品のみ保証サービス

Hewlett Packard Enterprise保証サービスには、部品のみ保証サービスが適用される場合があります。このサービスでは、交換部品は無償で提供されます。

部品のみ保証サービスにおいては、CSR部品をお客様により交換作業していただくことが必須となります。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様のご負担となります。

客户自行维修

Hewlett Packard Enterprise 产品提供许多客户自行维修 (CSR) 部件，以尽可能缩短维修时间和在更换缺陷部件方面提供更大的灵活性。如果在诊断期间 Hewlett Packard Enterprise (或 Hewlett Packard Enterprise 服务提供商或服务合作伙伴) 确定可以通过使用 CSR 部件完成维修，Hewlett Packard Enterprise 将直接把该部件发送给您进行更换。有两类 CSR 部件：

- **强制性的** — 要求客户必须自行维修的部件。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。
- **可选的** — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 Hewlett Packard Enterprise 为您更换这些部件，则根据为您的产品指定的保修服务类型，Hewlett Packard Enterprise 可能收取或不再收取任何附加费用。

注：某些 Hewlett Packard Enterprise 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，Hewlett Packard Enterprise 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

CSR 部件将在下一个工作日发运 (取决于备货情况和允许的地理范围)。在允许的地理范围内，可在当天或四小时内发运，但要收取额外费用。如果需要帮助，您可以致电 Hewlett Packard Enterprise 技术支持中心，将会有技术人员通过电话为您提供帮助。Hewlett Packard Enterprise 会在随更换的 CSR 部件发运的材料中指明是否必须将有缺陷的部件返还给 Hewlett Packard Enterprise。如果要求您将有缺陷的部件返还给 Hewlett Packard Enterprise，那么您必须在规定的期限内 (通常是五 (5) 个工作日) 将缺陷部件发给 Hewlett Packard Enterprise。有缺陷的部件必须随所提供的发运材料中的相关文件一起返还。如果未能送还有缺陷的部件，Hewlett Packard Enterprise 可能会要求您支付更换费用。客户自行维修时，Hewlett Packard Enterprise 将承担所有相关运输和部件返回费用，并指定快递商/承运商。

有关 Hewlett Packard Enterprise 客户自行维修计划的详细信息，请与您当地的服务提供商联系。有关北美地区的计划，请访问 Hewlett Packard Enterprise 网站 (<http://www.hpe.com/support/selfrepair>)。

仅部件保修服务

您的 Hewlett Packard Enterprise 有限保修服务可能涉及仅部件保修服务。根据仅部件保修服务条款的规定，Hewlett Packard Enterprise 将免费提供更换的部件。

仅部件保修服务要求进行 CSR 部件更换。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。

客戶自行維修

Hewlett Packard Enterprise 產品設計了許多「客戶自行維修」(CSR) 的零件以減少維修時間，並且使得更換瑕疵零件時能有更大的彈性。如果在診斷期間，Hewlett Packard Enterprise (或 Hewlett Packard Enterprise 服務供應商或維修夥伴) 辨認出此項維修工作可以藉由使用 CSR 零件來完成，則 Hewlett Packard Enterprise 將直接寄送該零件給您作更換。CSR 零件分為兩種類別：

- **強制的** — 客戶自行維修所使用的零件是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。
- **選購的** — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 Hewlett Packard Enterprise 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

備註：某些 Hewlett Packard Enterprise 零件沒有消費者可自行維修的設計。為符合客戶保固，Hewlett Packard Enterprise 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

基於材料取得及環境允許的情況下，CSR 零件將於下一個工作日以快遞寄送。在環境的允許下當天或四小時內送達，則可能需要額外的費用。若您需要協助，可致電 Hewlett Packard Enterprise 支援中心，會有一位技術人員透過電話來協助您。不論損壞的零件是否必須退回，Hewlett Packard Enterprise 皆會在與 CSR 替換零件一起運送的材料中註明。若要將損壞的零件退回 Hewlett Packard Enterprise，您必須在指定的一段時間內 (通常為五 (5) 個工作天)，將損壞的零件寄回 Hewlett Packard Enterprise。損壞的零件必須與寄送資料中隨附的相關技術文件一併退還。如果無法退還損壞的零件，Hewlett Packard Enterprise 可能要向您收取替換費用。針對客戶自行維修情形，Hewlett Packard Enterprise 將負責所有運費及零件退還費用，並指定使用何家快遞/貨運公司。

如需 Hewlett Packard Enterprise 的 CSR 方案詳細資訊，請連絡您當地的服務供應商。至於北美方案，請參閱 Hewlett Packard Enterprise 的 CSR 網站 [selfrepair \(http://www.hpe.com/support/selfrepair\)](http://www.hpe.com/support/selfrepair)。

僅限零件的保固服務

您的「Hewlett Packard Enterprise 有限保固」可能包含僅限零件的保固服務。在僅限零件的保固服務情況下，Hewlett Packard Enterprise 將免費提供替換零件。

針對僅限零件的保固服務，CSR 零件替換是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。

고객 셀프 수리

Hewlett Packard Enterprise 제품은 수리 시간을 최소화하고 결함이 있는 부품 교체 시 더욱 융통성을 발휘할 수 있도록 하기 위해 고객 셀프 수리(CSR) 부품을 다량 사용하여 설계되었습니다. 진단 기간 동안 Hewlett Packard Enterprise(또는 Hewlett Packard Enterprise 서비스 공급업체 또는 서비스 협력업체)에서 CSR 부품을 사용하여 수리가 가능하다고 판단되면 Hewlett Packard Enterprise는 해당 부품을 바로 사용자에게 보내어 사용자가 교체할 수 있도록 합니다. CSR 부품에는 두 가지 종류가 있습니다.

- 필수 - 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.
- 선택 사항 - 고객 셀프 수리가 선택 사항인 부품. 이 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

참고: 일부 Hewlett Packard Enterprise 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. Hewlett Packard Enterprise는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 “No”라고 표시되어 있습니다.

CSR 부품은 재고 상태와 지리적 조건이 허용하는 경우 다음 영업일 납품이 가능하도록 배송이 이루어집니다. 지리적 조건이 허용하는 경우 추가 비용이 청구되는 조건으로 당일 또는 4시간 배송이 가능할 수도 있습니다. 도움이 필요하시면 Hewlett Packard Enterprise Support Center로 전화하십시오. 전문 기술자가 전화로 도움을 줄 것입니다. Hewlett Packard Enterprise는 결함이 발생한 부품을 Hewlett Packard Enterprise로 반환해야 하는지 여부를 CSR 교체 부품과 함께 배송된 자료에 지정합니다. 결함이 발생한 부품을 Hewlett Packard Enterprise로 반환해야 하는 경우에는 지정된 기간 내(통상 영업일 기준 5일)에 Hewlett Packard Enterprise로 반환해야 합니다. 이때 결함이 발생한 부품은 제공된 포장 재료에 넣어 관련 설명서와 함께 반환해야 합니다. 결함이 발생한 부품을 반환하지 않는 경우 Hewlett Packard Enterprise가 교체 부품에 대해 비용을 청구할 수 있습니다. 고객 셀프 수리의 경우, Hewlett Packard Enterprise는 모든 운송 및 부품 반환 비용을 부담하며 이용할 운송업체 및 택배 서비스를 결정합니다.

Hewlett Packard Enterprise CSR 프로그램에 대한 자세한 내용은 가까운 서비스 제공업체에 문의하십시오. 북미 지역의 프로그램에 대해서는 Hewlett Packard Enterprise CSR 웹 사이트(<http://www.hpe.com/support/selfrepair>)를 참조하십시오.

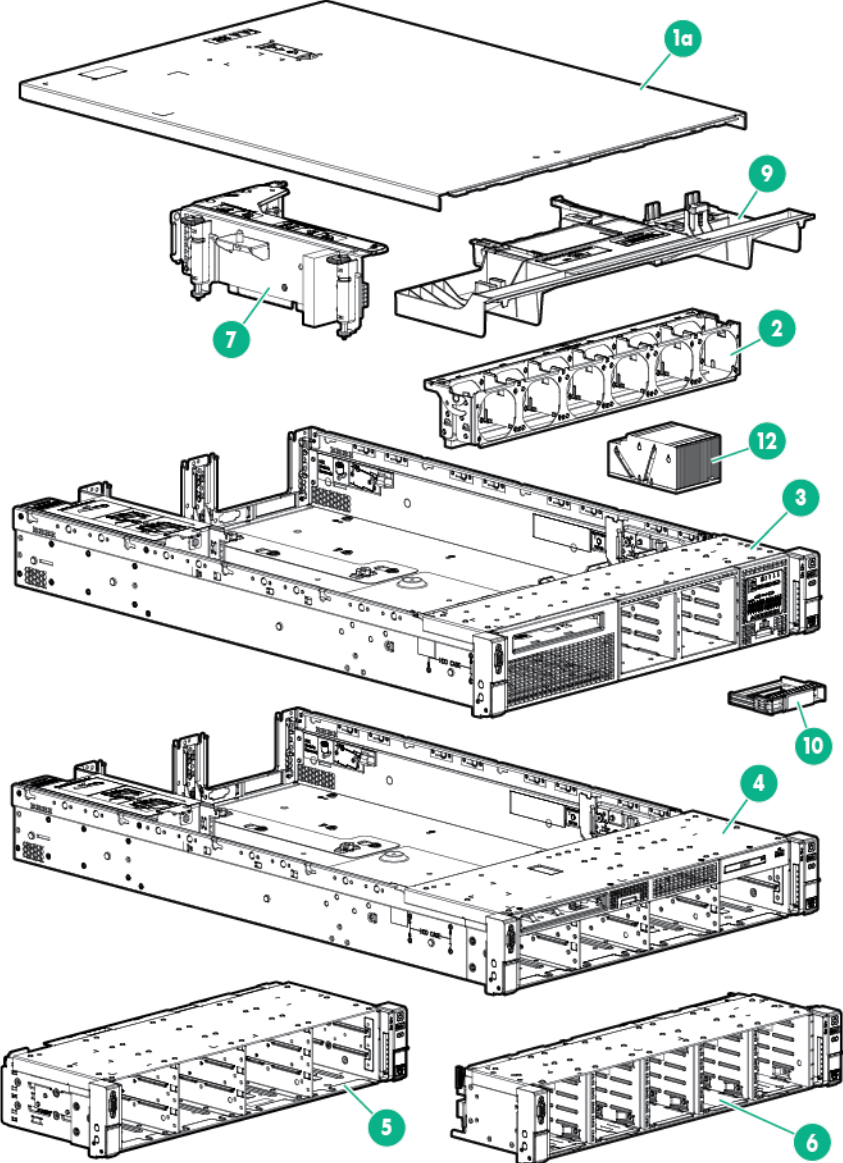
부품 제공 보증 서비스

Hewlett Packard Enterprise 제한 보증에는 부품 제공 보증 서비스가 포함될 수 있습니다. 이러한 경우 Hewlett Packard Enterprise는 부품 제공 보증 서비스의 조건에 따라 교체 부품만을 무료로 제공합니다.

부품 제공 보증 서비스 제공 시 CSR 부품 교체는 의무 사항입니다. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 이 서비스에 대한 출장비 및 작업비가 청구됩니다.

Illustrated parts catalog

Mechanical components



Item	Description	Spare part number	Customer self repair (on page 5)
1	Access panel	—	—
	a) Access panel, 8 drive SFF, 8 drive LFF	691272-001	Mandatory ¹
	b) Access panel, 25 drive SFF, 12 drive LFF*	691273-001	Mandatory ¹
2	Fan cage	662518-001	Mandatory ¹

Item	Description	Spare part number	Customer self repair (on page 5)
3	8 drive SFF front end	—	—
	a) 8 drive SFF front end, with cables, left and right ears (no backplane)	696955-001	Optional ²
	b) 8 drive SFF backplane, with cables	670943-001	Optional ²
4	8 drive LFF front end, with cables, left and right ears, with backplane	696956-001	Optional ²
5	12 drive LFF front end, with cables, left and right ears, with backplane	696957-001	Optional ²
6	25 drive SFF front end, with cables, left and right ears, with backplane	691265-001	Optional ²
7	Primary PCIe riser cage	662526-001	Mandatory ¹
8	Secondary PCIe riser cage, with PCA*	691268-001	Mandatory ¹
9	Air baffle kit	691270-001	Mandatory ¹
10	Hard drive blank	—	—
	a) Hard drive blank, SFF	667276-001	Mandatory ¹
	b) Hard drive blank, LFF*	667279-001	Mandatory ¹
11	Hardware blank kit	662519-001	Mandatory ¹
	a) Optical device blank*	—	—
	b) Fan blank*	—	—
	c) FlexibleLOM blank*	—	—
	d) PCI riser cage blank*	—	—
	e) Expansion slot blank*	—	—
12	Power supply blank*	699833-001	Mandatory ¹
13	Heatsink	679333-001	Optional ²
14	Heatsink HE*	691267-001	Optional ²
15	Heatsink blank*	691275-001	Mandatory ¹
16	Processor cage*	691274-001	Optional ²
17	2U rack bezel*	662529-001	Mandatory ¹
18	Miscellaneous hardware kit*	662523-001	Mandatory ¹
	a) Fan bracket, left	—	—
	b) Fan bracket, right	—	—
	c) Trough cable routing guide	—	—
	d) Clip cable retainer	—	—
	e) DIMM cable guide	—	—
19	Miscellaneous hardware kit S2*	699832-001	Mandatory ¹
	a) Plastic battery holder	—	—
	b) PCIe riser cage divider	—	—
	Rack mounting hardware	—	—
20	Ball bearing rail kit, SFF*	662535-001	Mandatory ¹
21	Ball bearing rail kit, LFF*	692480-001	Mandatory ¹
22	Friction rail kit*	662536-001	Mandatory ¹
23	Cable management arm (not supported with the friction rail kit)*	675606-001	Mandatory ¹

* Not shown

¹Mandatory—Parts for which customer self repair is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.

²Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that Hewlett Packard Enterprise replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

³No—Some Hewlett Packard Enterprise parts are not designed for customer self repair. In order to satisfy the customer warranty, Hewlett Packard Enterprise requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

¹Obligatoire—Pièces pour lesquelles le client doit procéder lui-même aux réparations. Si vous demandez à Hewlett Packard Enterprise de procéder au remplacement de ces pièces, les frais de transport et de main d'œuvre pour ce service vous seront facturés.

²Facultatif—Pièces pour lesquelles une réparation par le client est facultative. Ces pièces sont également conçues pour que le client puisse procéder lui-même aux réparations. Cependant, les frais supplémentaires engendrés par le remplacement de ces pièces par Hewlett Packard Enterprise dépendent du type de service de garantie désigné pour votre produit.

³Non—Certaines pièces Hewlett Packard Enterprise ne sont pas conçues pour être remplacées par le client. Afin de se conformer aux exigences de la garantie la garantie du client, Hewlett Packard Enterprise demande à un fournisseur de services agréé de procéder au remplacement de la pièce. Ces pièces sont signalées par le mot « Non » dans le Catalogue de pièces illustré.

¹Obbligatorio—Parti per le quali il cliente è tenuto a effettuare autonomamente la riparazione. Se si richiede l'intervento di Hewlett Packard Enterprise per la sostituzione di queste parti, al cliente verranno addebitate le spese di viaggio e manodopera dell'operazione.

²Facoltativo—Parti per le quali la riparazione in autonomia da parte del cliente è facoltativa. Queste parti sono progettate per consentire anche la riparazione da parte del cliente. Tuttavia, se il cliente richiede l'intervento di Hewlett Packard Enterprise per la sostituzione, potrebbero essere addebitate spese aggiuntive a seconda del tipo di garanzia in assistenza previsto per il prodotto.

³No—Alcune parti Hewlett Packard Enterprise non sono progettate la riparazione in autonomia da parte del cliente. In base a quanto previsto dalla garanzia per il cliente, Hewlett Packard Enterprise richiede l'intervento di un tecnico autorizzato per la sostituzione della parte. Queste parti sono contrassegnate con "No" nel catalogo parti illustrato.

¹Zwingend—Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

²Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

³Nein—Einige Hewlett Packard Enterprise Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem Hewlett Packard Enterprise Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

¹Obligatorio—Componentes cuya reparación por parte del usuario es obligatoria. Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

²Opcional—Componentes cuya reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que Hewlett Packard Enterprise realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

³No—Algunos componentes de Hewlett Packard Enterprise no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, Hewlett Packard Enterprise pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

¹Verplicht—Onderdelen die de klant zelf moet vervangen. Als u Hewlett Packard Enterprise vraagt deze onderdelen te vervangen, worden er reis- en arbeidskosten voor deze service in rekening gebracht.

²Optioneel—Onderdelen die de klant zelf kan vervangen. Deze onderdelen zijn ook ontworpen om door de klant zelf te worden vervangen. Als u Hewlett Packard Enterprise verzoekt om deze te vervangen, kan het zijn dat hiervoor extra kosten in rekening worden gebracht, afhankelijk van het soort garantie dat op uw product van toepassing is.

³Geen—Sommige onderdelen van Hewlett Packard Enterprise zijn niet ontworpen om door de klant zelf te worden vervangen. Om te voldoen aan de garantievoorwaarden eist Hewlett Packard Enterprise dat een geautoriseerde serviceverlener het onderdeel vervangt. Deze onderdelen worden aangeduid met 'Geen' in de geïllustreerde onderdelencatalogus.

¹Obrigatório—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

²Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a Hewlett Packard Enterprise as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

³Não—Algumas peças da Hewlett Packard Enterprise não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a Hewlett Packard Enterprise exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

¹Mandatory : 必須 — カスタマーセルフリペアが必須の部品。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、その修理サービスに関する交通費および人件費がお客様に請求されます。

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³No : 除外 — Hewlett Packard Enterprise製品の一部の部品は、カスタマーセルフリペアの対象外です。製品の保証を継続するためには、Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

¹Mandatory — 客户必须自行维修的部件。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。

²Optional — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 Hewlett Packard Enterprise 为您更换这些部件，则根据为您的产品指定的保修服务类型，Hewlett Packard Enterprise 可能收取或不再收取任何附加费用。

³No — 某些 Hewlett Packard Enterprise 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，Hewlett Packard Enterprise 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

¹Mandatory — 客戶自行維修所使用的零件是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。

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³No — 某些 Hewlett Packard Enterprise 零件沒有消費者可自行維修的設計。為符合客戶保固，Hewlett Packard Enterprise 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

¹Mandatory — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 해당 서비스에 대한 출장비 및 작업비가 청구됩니다.

²Optional — 고객 셀프 수리가 선택 사항인 부품. 이러한 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 Hewlett Packard Enterprise에 이러한 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

³No — 일부 Hewlett Packard Enterprise 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. Hewlett Packard Enterprise는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 요구하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

Item	Description	Spare part number	Customer self repair (on page 5)
	b) 10GbE 2-port, 530FLR Adapter FIO Kit*	649869-001	Mandatory ¹
	c) Ff 10Gb 2-port, 554FLR-SFP+ Adapter FIO Kit*	634026-001	Mandatory ¹
	d) InfiniBand FDR/EN 10/40Gb 2-port, 544FLR-QSFP Adapter*	656090-001	Mandatory ¹
	e) InfiniBand QDR/EN 10Gb 2-port, 544FLR-QSFP Adapter*	656091-001	Mandatory ¹
	Memory	—	—
33	DIMMs	—	—
	a) 4-GB, 1Rx4 PC3U-10600R-9	687457-001	Mandatory ¹
	b) 4-GB, 1Rx4 PC3L-10600R-9	687458-001	Mandatory ¹
	c) 4-GB, 1Rx4 PC3-12800R-11	687459-001	Mandatory ¹
	d) 8-GB, 2Rx4 PC3U-10600R-9	687460-001	Mandatory ¹
	e) 8-GB, 2Rx4 PC3L-16000R-9	687461-001	Mandatory ¹
	f) 8-GB, 2Rx4-PC3 12800R-11	698808-001	Mandatory ¹
	g) 8-GB, 1Rx4 PC3-12800R-11	687462-001	Mandatory ¹
	h) 16-GB, 2Rx4 PC3U-10600R-9	687463-001	Mandatory ¹
	i) 16-GB, 2Rx4 PC3L-10600R-9	687464-001	Mandatory ¹
	j) 16-GB, 2Rx4 PC3-12800R-11	687465-001	Mandatory ¹
	k) 32-GB, 4Rx4 PC3L-10600L-9	687466-001	Mandatory ¹
34	Processors **	—	—
	a) 1.60-GHz AMD Opteron processor 6262HE, 85W	662841-001	Optional ²
	b) 1.80-GHz AMD Opteron processor 6366HE, 16c, 85W*	705225-001	Optional ²
	b) 2.10-GHz AMD Opteron processor 6272, 115W*	662836-001	Optional ²
	c) 2.20-GHz AMD Opteron processor 6274, 115W*	662835-001	Optional ²
	d) 2.30-GHz AMD Opteron processor 6276, 115W*	662834-001	Optional ²
	e) 2.30-GHz AMD Opteron processor 6376, 16c, 115W*	705219-001	Optional ²
	f) 2.40-GHz AMD Opteron processor 6234, 115W*	662838-001	Optional ²
	g) 2.40-GHz AMD Opteron processor 6278, 115W*	689494-001	Optional ²
	h) 2.40-GHz AMD Opteron processor 6378, 16c, 115W*	705218-001	Optional ²
	i) 2.50-GHz AMD Opteron processor 6380, 16c, 115W*	705217-001	Optional ²
	j) 2.60-GHz AMD Opteron processor 6212, 115W*	662840-001	Optional ²
	k) 2.60-GHz AMD Opteron processor 6238, 115W*	662837-001	Optional ²
	l) 2.60-GHz AMD Opteron processor 6344, 12c, 115W*	705221-001	Optional ²
	m) 2.70-GHz AMD Opteron processor 6284SE, 140W*	696244-001	Optional ²
	n) 2.80-GHz AMD Opteron processor 6320, 8c, 115W*	705223-001	Optional ²

Item	Description	Spare part number	Customer self repair (on page 5)
	o) 2.80-GHz AMD Opteron processor 6348, 12c, 115W*	705220-001	Optional ²
	p) 2.80-GHz AMD Opteron processor 6386SE, 16c, 140W*	705216-001	Optional ²
	q) 3.00-GHz AMD Opteron processor 6220, 115W*	662839-001	Optional ²
	r) 3.20-GHz AMD Opteron processor 6328, 8c, 115W*	705222-001	Optional ²
	s) 3.30-GHz AMD Opteron processor 6204, 115W*	672234-001	Optional ²
	t) 3.50-GHz AMD Opteron processor 6308, 4c, 115W*	705224-001	Optional ²
	Drives	—	—
35	Hot-plug SATA	—	—
	a) 500-GB, 7,200-rpm, LFF, 6G	658103-001	Mandatory ¹
	b) 1-TB, 7,200-rpm, LFF, 6G*	657739-001	Mandatory ¹
	c) 2-TB, 7,200-rpm, LFF, 6G*	658102-001	Mandatory ¹
	d) 3-TB, 7,200-rpm, LFF, 6G*	628182-001	Mandatory ¹
	e) 500-GB, 7,200-rpm, SFF, 6G	656107-001	Mandatory ¹
	f) 1-TB, 7,200-rpm, SFF, 6G	656108-001	Mandatory ¹
36	Hot-plug SAS*	—	—
	a) 2-TB, 7,200-rpm, LFF, 6G, dual port	653948-001	Mandatory ¹
	b) 3-TB, 7,200-rpm, LFF, 6G, dual port	653959-001	Mandatory ¹
	c) 300-GB, 10,000-rpm, SFF, 6G, dual port	653955-001	Mandatory ¹
	d) 450-GB, 10,000-rpm, SFF, 6G, dual port	653956-001	Mandatory ¹
	e) 600-GB, 10,000-rpm, SFF, 6G, dual port	653957-001	Mandatory ¹
	f) 900-GB, 10,000-rpm, SFF, 6G, dual port	653971-001	Mandatory ¹
	g) 72-GB, 15,000-rpm, SFF, 6G, dual port	653949-001	Mandatory ¹
	h) 146-GB, 15,000-rpm, SFF, 6G, dual port	653950-001	Mandatory ¹
	i) 300-GB, 15,000-rpm, SFF, 6G, dual port	653960-001	Mandatory ¹
	j) 450-GB, 15,000-rpm, LFF, 6G, dual port	653951-001	Mandatory ¹
	k) 600-GB, 15,000-rpm, LFF, 6G, dual port	653952-001	Mandatory ¹
	l) 500-GB, 7,200-rpm, SFF, 6G, dual port	653953-001	Mandatory ¹
	m) 1-TB, 7,200-rpm, SFF, 6G, dual port	653954-001	Mandatory ¹
	n) 1-TB, 7,200-rpm, LFF, 6G, dual port	653947-001	Mandatory ¹
37	Hot-plug solid state SATA*	—	—
	a) 100-GB, SFF, MLC, 3G	653965-001	Mandatory ¹
	b) 200-GB, SFF, MLC, 3G	653966-001	Mandatory ¹
	c) 400-GB, SFF, MLC, 3G	653967-001	Mandatory ¹
	d) 100-GB, LFF, MLC, 3G	653968-001	Mandatory ¹

Item	Description	Spare part number	Customer self repair (on page 5)
	e) 200-GB, LFF, MLC, 3G	653969-001	Mandatory ¹
	f) 400-GB, LFF, MLC, 3G	653970-001	Mandatory ¹
38	Hot-plug solid state SAS*	—	—
	a) 200-GB, SFF, SLC	653961-001	Mandatory ¹
	b) 200-GB, SFF, SC, MLC	691025-001	Mandatory ¹
	c) 400-GB, SFF, SLC	653962-001	Mandatory ¹
	d) 400-GB, SFF, MLC	653963-001	Mandatory ¹
	e) 400-GB, SFF, SC, MLC	691026-001	Mandatory ¹
	f) 800-GB, SFF, MLC	653964-001	Mandatory ¹
	g) 800-GB, SFF, SC, MLC	691027-001	Mandatory ¹
	Optical drives	—	—
39	Optical drive module*	675601-001	Mandatory ¹
40	Slimline 8x/24x DVD-ROM drive	652294-001	Mandatory ¹
41	Slimline 8x DVD+R/RW drive*	652295-001	Mandatory ¹
	Cables	—	—
42	LFF ribbon Mini-SAS storage cable*	675609-001	Mandatory ¹
43	SFF ribbon Mini-SAS storage cable*	675610-001	Mandatory ¹
44	SFF Mini-SAS hard drive backplane to storage card*	675611-001	Mandatory ¹
45	LFF power cable*	675612-001	Mandatory ¹
46	SFF power cable*	675613-001	Mandatory ¹
47	Slim SATA cable*	675614-001	Mandatory ¹
48	Mini-SAS STR to STR, 93.98 cm (37 in)*	675615-001	Mandatory ¹
49	12 LFF power cable*	675612-001	Mandatory ¹
50	25 SFF power cable*	675613-001	Mandatory ¹
51	12 LFF Mini-SAS SR cable*	675609-001	Mandatory ¹
52	25 SFF Mini-SAS SR cable*	675610-001	Mandatory ¹
	Battery	—	—
53	System battery, 3.3-V, lithium*	153099-001	Mandatory ¹
	Controller option	—	—
54	FBWC cache module	—	—
	a) 512-MB cache	633540-001	Optional ²
	b) 1-GB cache*	633542-001	Optional ²
	c) 2-GB cache*	633543-001	Optional ²
55	FBWC capacitor pack with cable	660093-001	Optional ²
56	Controllers*	—	—
	a) Smart Array P222	633537-001	Optional ²
	b) Smart Array P421	633539-001	Optional ²
	c) Smart Array P420	633538-001	Optional ²

*Not shown

**All processors in this HPE ProLiant server must have the same cache size, speed, number of cores, and rated maximum power consumption.

¹Mandatory—Parts for which customer self repair is mandatory. If you request Hewlett Packard Enterprise to replace these parts, you will be charged for the travel and labor costs of this service.

²Optional—Parts for which customer self repair is optional. These parts are also designed for customer self repair. If, however, you require that Hewlett Packard Enterprise replace them for you, there may or may not be additional charges, depending on the type of warranty service designated for your product.

³No—Some Hewlett Packard Enterprise parts are not designed for customer self repair. In order to satisfy the customer warranty, Hewlett Packard Enterprise requires that an authorized service provider replace the part. These parts are identified as "No" in the Illustrated Parts Catalog.

¹Obligatoire—Pièces pour lesquelles le client doit procéder lui-même aux réparations. Si vous demandez à Hewlett Packard Enterprise de procéder au remplacement de ces pièces, les frais de transport et de main d'œuvre pour ce service vous seront facturés.

²Facultatif—Pièces pour lesquelles une réparation par le client est facultative. Ces pièces sont également conçues pour que le client puisse procéder lui-même aux réparations. Cependant, les frais supplémentaires engendrés par le remplacement de ces pièces par Hewlett Packard Enterprise dépendent du type de service de garantie désigné pour votre produit.

³Non—Certaines pièces Hewlett Packard Enterprise ne sont pas conçues pour être remplacées par le client. Afin de se conformer aux exigences de la garantie la garantie du client, Hewlett Packard Enterprise demande à un fournisseur de services agréé de procéder au remplacement de la pièce. Ces pièces sont signalées par le mot « Non » dans le Catalogue de pièces illustré.

¹Obbligatorio—Parti per le quali il cliente è tenuto a effettuare autonomamente la riparazione. Se si richiede l'intervento di Hewlett Packard Enterprise per la sostituzione di queste parti, al cliente verranno addebitate le spese di viaggio e manodopera dell'operazione.

²Facoltativo—Parti per le quali la riparazione in autonomia da parte del cliente è facoltativa. Queste parti sono progettate per consentire anche la riparazione da parte del cliente. Tuttavia, se il cliente richiede l'intervento di Hewlett Packard Enterprise per la sostituzione, potrebbero essere addebitate spese aggiuntive a seconda del tipo di garanzia in assistenza previsto per il prodotto.

³No—Alcune parti Hewlett Packard Enterprise non sono progettate la riparazione in autonomia da parte del cliente. In base a quanto previsto dalla garanzia per il cliente, Hewlett Packard Enterprise richiede l'intervento di un tecnico autorizzato per la sostituzione della parte. Queste parti sono contrassegnate con "No" nel catalogo parti illustrato.

¹Zwingend—Teile, für die das Customer Self Repair-Verfahren zwingend vorgegeben ist. Wenn Sie den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen, werden Ihnen die Anfahrt- und Arbeitskosten für diesen Service berechnet.

²Optional—Teile, für die das Customer Self Repair-Verfahren optional ist. Diese Teile sind auch für Customer Self Repair ausgelegt. Wenn Sie jedoch den Austausch dieser Teile von Hewlett Packard Enterprise vornehmen lassen möchten, können bei diesem Service je nach den für Ihr Produkt vorgesehenen Garantiebedingungen zusätzliche Kosten anfallen.

³Nein—Einige Hewlett Packard Enterprise Teile sind nicht für Customer Self Repair ausgelegt. Um den Garantieanspruch des Kunden zu erfüllen, muss das Teil von einem Hewlett Packard Enterprise Servicepartner ersetzt werden. Im illustrierten Teilekatalog sind diese Teile mit „No“ bzw. „Nein“ gekennzeichnet.

¹Obligatorio—Componentes cuya reparación por parte del usuario es obligatoria. Si solicita a Hewlett Packard Enterprise que realice la sustitución de estos componentes, tendrá que hacerse cargo de los gastos de desplazamiento y de mano de obra de dicho servicio.

²Opcional—Componentes cuya reparación por parte del usuario es opcional. Estos componentes también están diseñados para que puedan ser reparados por el usuario. Sin embargo, si precisa que Hewlett Packard Enterprise realice su sustitución, puede o no conllevar costes adicionales, dependiendo del tipo de servicio de garantía correspondiente al producto.

³No—Algunos componentes de Hewlett Packard Enterprise no están diseñados para que puedan ser reparados por el usuario. Para que el usuario haga valer su garantía, Hewlett Packard Enterprise pone como condición que un proveedor de servicios autorizado realice la sustitución de estos componentes. Dichos componentes se identifican con la palabra "No" en el catálogo ilustrado de componentes.

¹Verplicht—Onderdelen die de klant zelf moet vervangen. Als u Hewlett Packard Enterprise vraagt deze onderdelen te vervangen, worden er reis- en arbeidskosten voor deze service in rekening gebracht.

²Optioneel—Onderdelen die de klant zelf kan vervangen. Deze onderdelen zijn ook ontworpen om door de klant zelf te worden vervangen. Als u Hewlett Packard Enterprise verzoekt om deze te vervangen, kan het zijn dat hiervoor extra kosten in rekening worden gebracht, afhankelijk van het soort garantie dat op uw product van toepassing is.

³Geen—Sommige onderdelen van Hewlett Packard Enterprise zijn niet ontworpen om door de klant zelf te worden vervangen. Om te voldoen aan de garantievoorwaarden eist Hewlett Packard Enterprise dat een geautoriseerde serviceverlener het onderdeel vervangt. Deze onderdelen worden aangeduid met 'Geen' in de geïllustreerde onderdelencatalogus.

¹Obrigatório—Peças cujo reparo feito pelo cliente é obrigatório. Se desejar que a Hewlett Packard Enterprise substitua essas peças, serão cobradas as despesas de transporte e mão-de-obra do serviço.

²Opcional—Peças cujo reparo feito pelo cliente é opcional. Essas peças também são projetadas para o reparo feito pelo cliente. No entanto, se desejar que a Hewlett Packard Enterprise as substitua, pode haver ou não a cobrança de taxa adicional, dependendo do tipo de serviço de garantia destinado ao produto.

³Não—Algumas peças da Hewlett Packard Enterprise não são projetadas para o reparo feito pelo cliente. A fim de cumprir a garantia do cliente, a Hewlett Packard Enterprise exige que um técnico autorizado substitua a peça. Essas peças estão identificadas com a marca "No" (Não), no catálogo de peças ilustrado.

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²Optional : 任意 — カスタマーセルフリペアが任意である部品。この部品もカスタマーセルフリペア用です。当該部品について、もしもお客様がHewlett Packard Enterpriseに交換作業を依頼される場合には、お買い上げの製品に適用される保証サービス内容の範囲内においては、別途費用を負担していただくことなく保証サービスを受けることができます。

³No : 除外 — Hewlett Packard Enterprise製品の一部の部品は、カスタマーセルフリペアの対象外です。製品の保証を継続するためには、Hewlett Packard EnterpriseまたはHewlett Packard Enterprise正規保守代理店による交換作業が必須となります。部品カタログには、当該部品がカスタマーセルフリペア除外品である旨が記載されています。

¹Mandatory — 客户必须自行维修的部件。如果您请求 Hewlett Packard Enterprise 更换这些部件，则必须为该服务支付差旅费和人工费用。

²Optional — 客户可以选择是否自行维修的部件。这些部件也是为客户自行维修设计的。不过，如果您要求 Hewlett Packard Enterprise 为您更换这些部件，则根据为您的产品指定的保修服务类型，Hewlett Packard Enterprise 可能收取或不再收取任何附加费用。

³No — 某些 Hewlett Packard Enterprise 部件的设计并未考虑客户自行维修。为了满足客户保修的需要，Hewlett Packard Enterprise 要求授权服务提供商更换相关部件。这些部件在部件图解目录中标记为“否”。

¹Mandatory — 客戶自行維修所使用的零件是強制性的。如果您要求 Hewlett Packard Enterprise 更換這些零件，Hewlett Packard Enterprise 將會向您收取此服務所需的外出費用與勞動成本。

²Optional — 客戶自行維修所使用的零件是選購的。這些零件也設計用於客戶自行維修之用。不過，如果您要求 Hewlett Packard Enterprise 為您更換，則可能需要也可能不需要負擔額外的費用，端視針對此產品指定的保固服務類型而定。

³No — 某些 Hewlett Packard Enterprise 零件沒有消費者可自行維修的設計。為符合客戶保固，Hewlett Packard Enterprise 需要授權的服務供應商更換零件。這些零件在圖示的零件目錄中，被標示為「否」。

¹Mandatory — 고객 셀프 수리가 의무 사항인 필수 부품. 사용자가 Hewlett Packard Enterprise에 이 부품의 교체를 요청할 경우 해당 서비스에 대한 출장비 및 작업비가 청구됩니다.

²Optional — 고객 셀프 수리가 선택 사항인 부품. 이러한 부품들도 고객 셀프 수리가 가능하도록 설계되었습니다. 하지만 사용자가 Hewlett Packard Enterprise에 이러한 부품의 교체를 요청할 경우 사용자가 구입한 제품에 해당하는 보증 서비스 유형에 따라 추가 비용 없이 교체가 가능할 수 있습니다.

³No — 일부 Hewlett Packard Enterprise 부품은 고객 셀프 수리가 불가능하도록 설계되었습니다. Hewlett Packard Enterprise는 만족스러운 고객 보증을 위해 공인 서비스 제공업체를 통해 부품을 교체하도록 요구하고 있습니다. 이러한 부품들은 Illustrated Parts Catalog에 "No"라고 표시되어 있습니다.

Removal and replacement procedures

Required tools

You need the following item for some procedures:

- T-10/T-15 Torx screwdriver
- HPE Insight Diagnostics software ("HPE Insight Diagnostics" on page 72)

Preparation procedures

To access some components and perform certain service procedures, you must perform one or more of the following procedures:

- Extend the server from the rack (on page 26).
If you are performing service procedures in a Hewlett Packard Enterprise, Compaq-branded, Telco, or third-party rack cabinet, you can use the locking feature of the rack rails to support the server and gain access to internal components.
For more information about telco rack solutions, refer to the RackSolutions.com website (<http://www.racksolutions.com/hpe>).
- Power down the server (on page 25).
If you must remove a server from a rack or a non-hot-plug component from a server, power down the server.
- Remove the server from the rack (on page 27).
If the rack environment, cabling configuration, or the server location in the rack creates awkward conditions, remove the server from the rack.
- Access the product rear panel (on page 28).
- Access the Systems Insight Display (on page 27).
- Release the full-length expansion board retainer (on page 28).

Power down the server

Before powering down the server for any upgrade or maintenance procedures, perform a backup of critical server data and programs.



IMPORTANT: When the server is in standby mode, auxiliary power is still being provided to the system.

To power down the server, use one of the following methods:

- Press and release the Power On/Standby button.
This method initiates a controlled shutdown of applications and the OS before the server enters standby mode.
- Press and hold the Power On/Standby button for more than 4 seconds to force the server to enter standby mode.

This method forces the server to enter standby mode without properly exiting applications and the OS. If an application stops responding, you can use this method to force a shutdown.

- Use a virtual power button selection through iLO.

This method initiates a controlled remote shutdown of applications and the OS before the server enters standby mode.

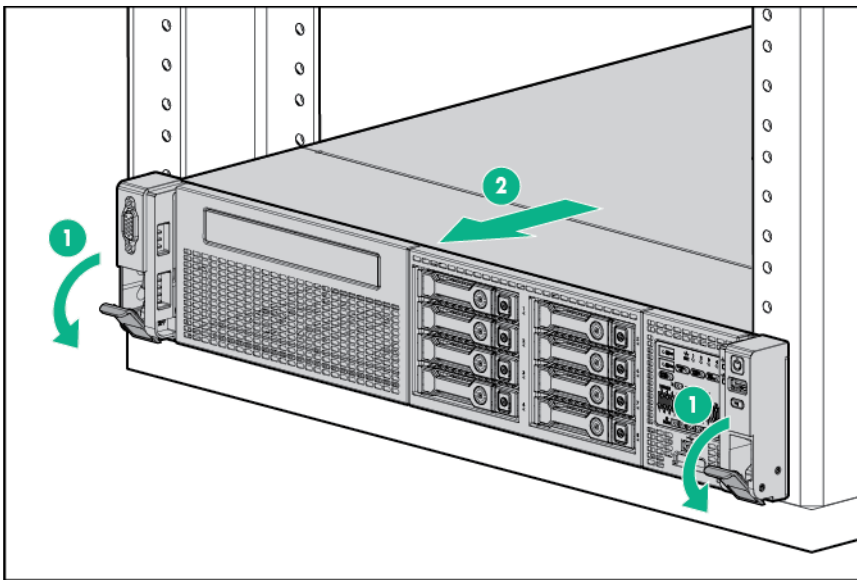
Before proceeding, verify the server is in standby mode by observing that the system power LED is amber.

Extend the server from the rack

1. Pull down the quick release levers on each side of the server.
2. Extend the server from the rack.



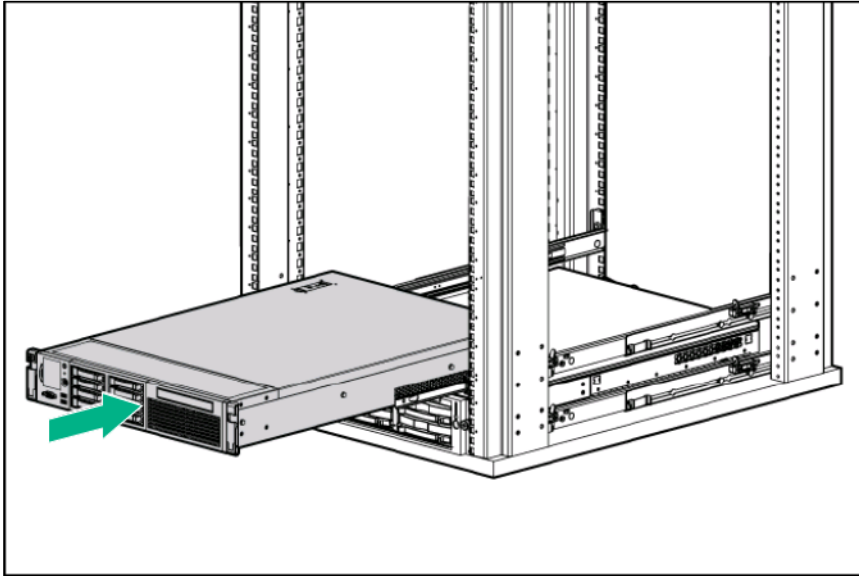
WARNING: To reduce the risk of personal injury or equipment damage, be sure that the rack is adequately stabilized before extending a component from the rack.



3. After performing the installation or maintenance procedure, slide the server back into the rack, and then press the server firmly into the rack to secure it in place.



WARNING: To reduce the risk of personal injury, be careful when pressing the server rail-release latches and sliding the server into the rack. The sliding rails could pinch your fingers.



Remove the server from the rack

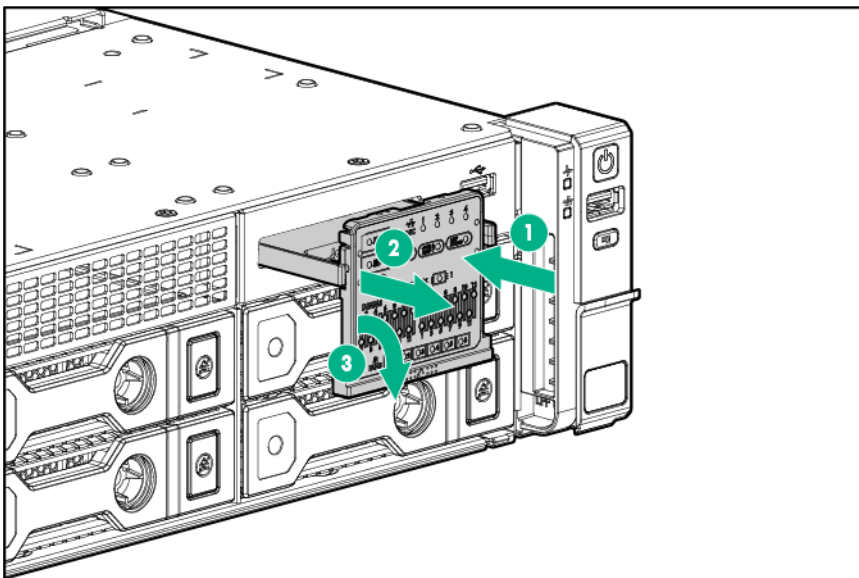
To remove the server from a Hewlett Packard Enterprise, Compaq branded, Telco, or third-party rack:

1. Power down the server (on page 25).
2. Extend the server from the rack (on page 26).
3. Disconnect the cabling and remove the server from the rack. For more information, refer to the documentation that ships with the rack mounting option.
4. Place the server on a sturdy, level surface.

Access the Systems Insight Display

To access the Systems Insight Display in a server with an 8-drive LFF configuration:

1. Press and release the panel.
2. After the display fully ejects, rotate the display downward to view the LEDs.



Access the product rear panel

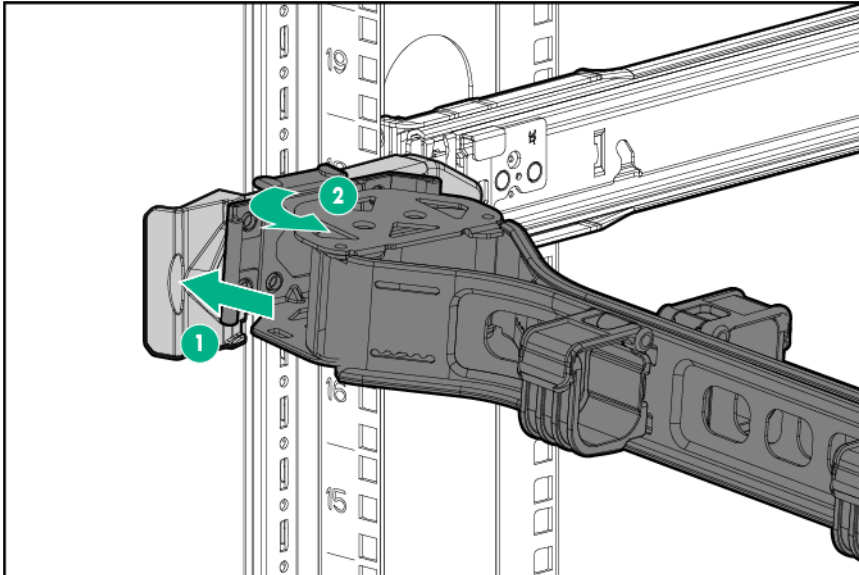
Opening the cable management arm



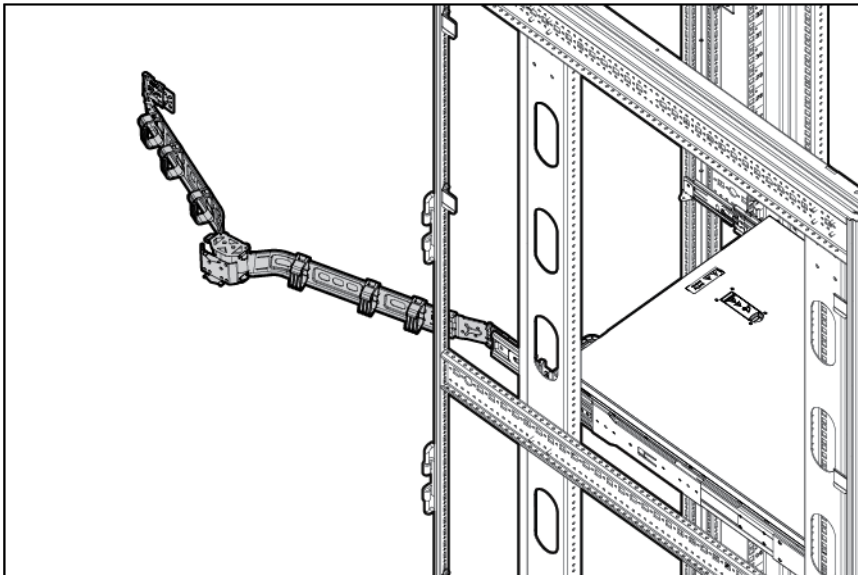
IMPORTANT: The cable management arm is not supported with the friction rail kit.

To access the server rear panel:

1. Release the cable management arm.



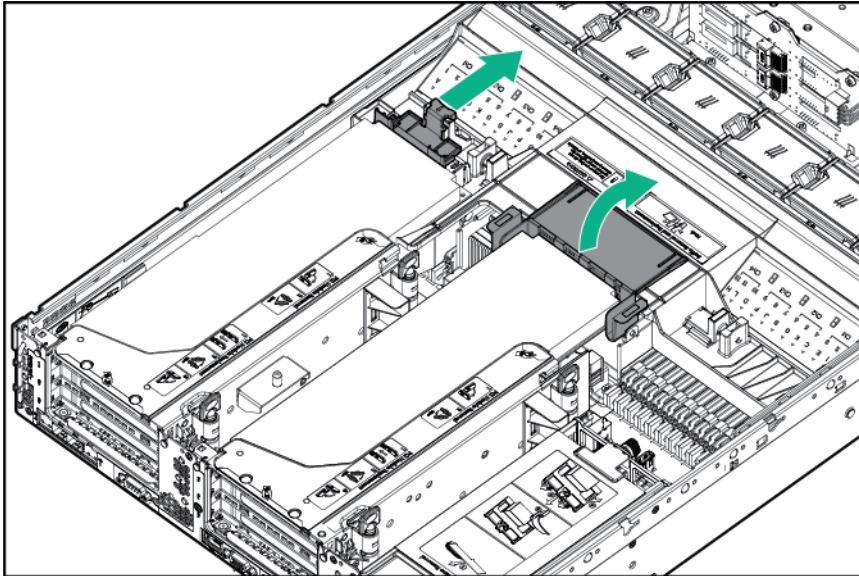
2. Open the cable management arm. Note that the cable management arm can be right-mounted or left-mounted.



Release the full-length expansion board retainer

The air baffle has full-length expansion board retainers for both the primary and secondary PCIe riser cages. To release the components:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
4. Remove the access panel ("Access panel" on page 30).
5. Release the full-length expansion board retainers.



To replace the component, reverse the removal procedure.

Safety considerations

Before performing service procedures, review all the safety information.

Symbols on equipment

The following symbols may be placed on equipment to indicate the presence of potentially hazardous conditions.



This symbol indicates the presence of hazardous energy circuits or electric shock hazards. Refer all servicing to qualified personnel.

WARNING: To reduce the risk of injury from electric shock hazards, do not open this enclosure. Refer all maintenance, upgrades, and servicing to qualified personnel.



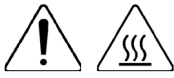
This symbol indicates the presence of electric shock hazards. The area contains no user or field serviceable parts. Do not open for any reason.

WARNING: To reduce the risk of injury from electric shock hazards, do not open this enclosure.



This symbol on an RJ-45 receptacle indicates a network interface connection.

WARNING: To reduce the risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into this receptacle.



This symbol indicates the presence of a hot surface or hot component. If this surface is contacted, the potential for injury exists.

WARNING: To reduce the risk of injury from a hot component, allow the surface to cool before touching.



23.53-28.08 kg
51.9-61.9 lb

This symbol indicates that the component exceeds the recommended weight for one individual to handle safely.

WARNING: To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.



These symbols, on power supplies or systems, indicate that the equipment is supplied by multiple sources of power.

WARNING: To reduce the risk of injury from electric shock, remove all power cords to completely disconnect power from the system.

Server warnings and cautions

Before installing a server, be sure that you understand the following warnings and cautions.



WARNING: To reduce the risk of electric shock or damage to the equipment:

- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from the power supply to disconnect power to the equipment.
- Do not route the power cord where it can be walked on or pinched by items placed against it. Pay particular attention to the plug, electrical outlet, and the point where the cord extends from the server.



WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.



CAUTION: Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

Access panel



WARNING: To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.



CAUTION: For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

To remove the component:

1. Power down the server if performing a non-hot-plug installation or maintenance procedure ("[Power down the server](#)" on page 25).
2. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
3. Use the T-15 Torx screwdriver to loosen the security screw on the hood latch.
4. Lift up on the hood latch handle, and then remove the access panel.

To replace the component, reverse the removal procedure.

Remove the air baffle

CAUTION: For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

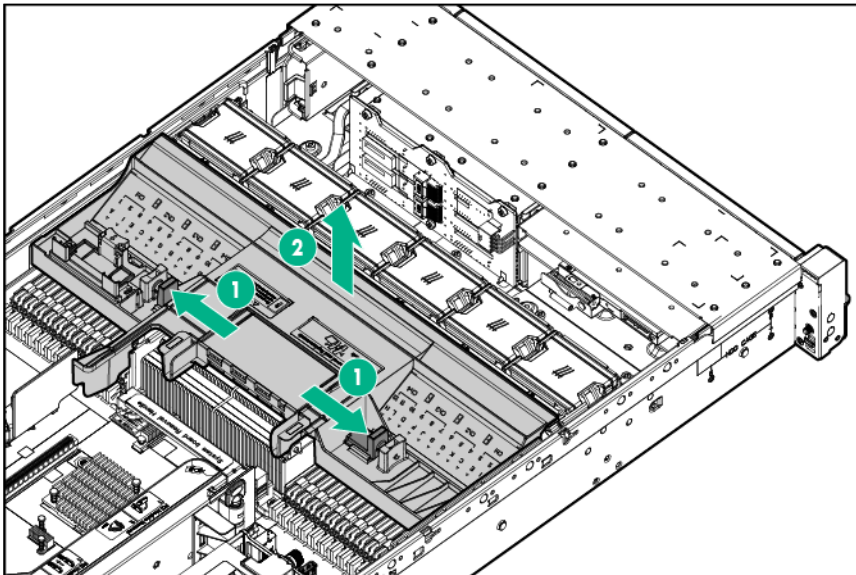
To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend or remove the server from the rack ("[Remove the server from the rack](#)" on page 27, "[Extend the server from the rack](#)" on page 26).
4. Remove the access panel ("[Access panel](#)" on page 30).

CAUTION: Do not detach the cable that connects the battery pack to the cache module. Detaching the cable causes any unsaved data in the cache module to be lost.

IMPORTANT: It is necessary to remove the PCIe riser cage only if there is a full-length expansion board installed.

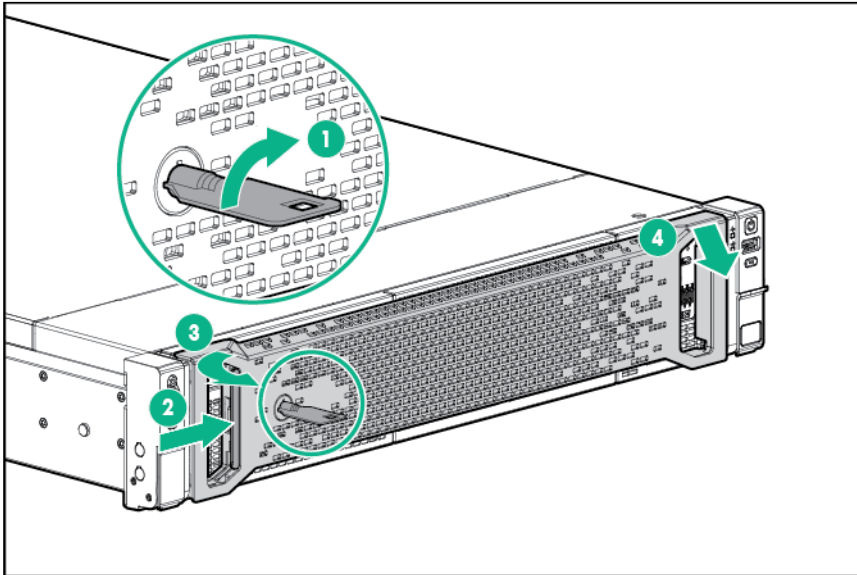
5. If a full-length expansion board is installed in the primary PCIe riser cage, release the expansion board retainer and remove the primary PCIe riser cage (on page 33, "[PCIe riser cage LED](#)" on page 87).
6. If a full-length expansion board is installed in the secondary PCIe riser cage, release the expansion board retainer and remove the secondary PCIe riser cage (on page 34).
7. Remove the air baffle.



To install the component, reverse the removal procedure.

2U rack bezel

To remove the component:



To replace the component, reverse the removal procedure.

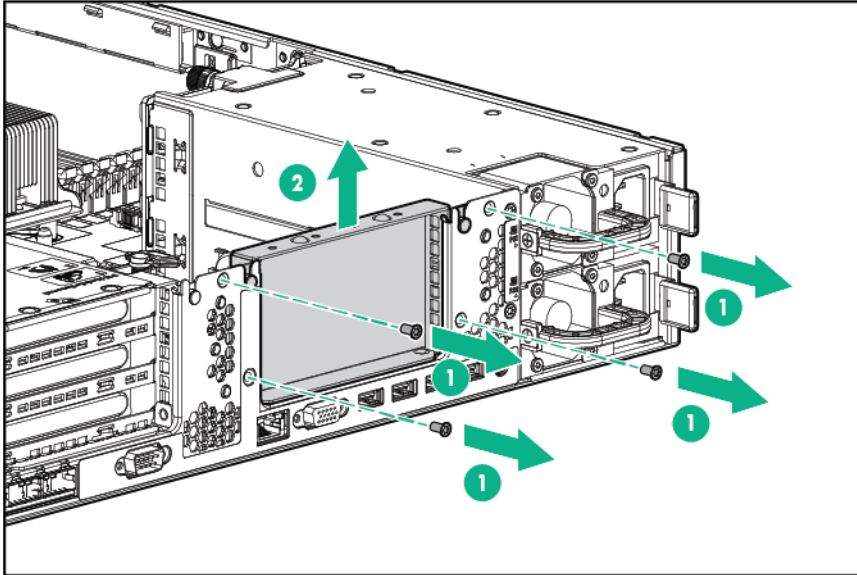
PCIe riser blank

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all PCI slots have either an expansion slot cover or an expansion board installed.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
4. Remove the access panel ("Access panel" on page 30).

5. Remove the PCIe riser blank.



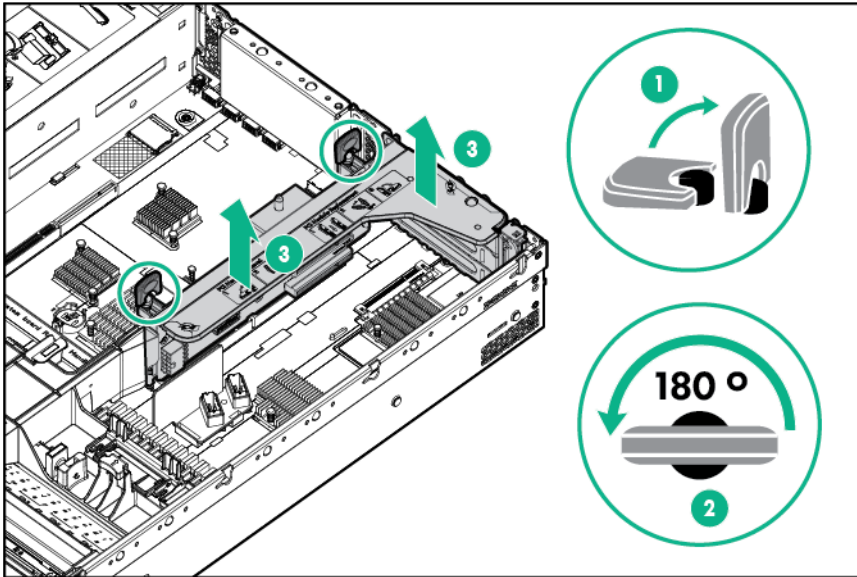
To replace the component, reverse the removal procedure.

Remove the primary PCIe riser cage

CAUTION: To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser cage.

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend the server from the rack (on page 26).
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove any installed full-length expansion boards ("[Full length expansion board](#)" on page 53).

6. Remove the PCIe riser cage.



To install the component, reverse the removal procedure.

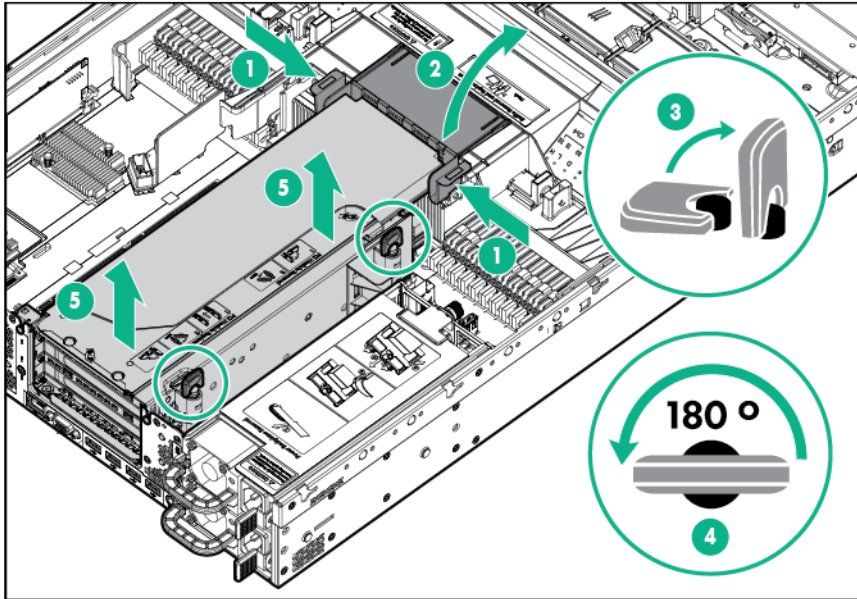
Remove the secondary PCIe riser cage

CAUTION: To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser cage.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend the server from the rack (on page 26).
4. Remove the access panel ("Access panel" on page 30).

5. If a full-length expansion board is installed in slot 4, release the full-length expansion board retainer, and then remove the PCIe riser cage.



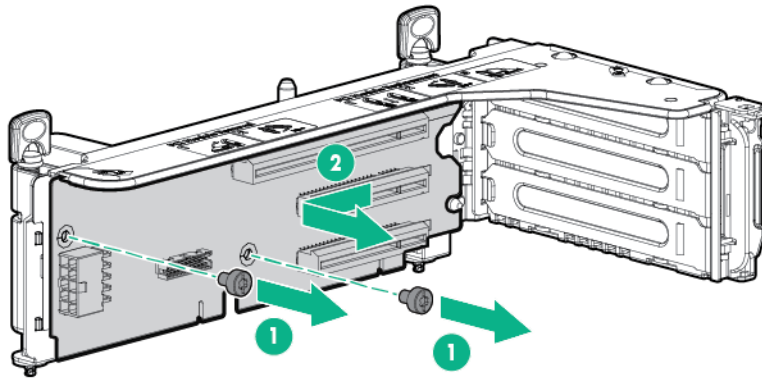
To install the component, reverse the removal procedure.

PCIe riser board

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. If any full-length expansion boards are installed, release the full-length expansion board retainer (on page 28).
6. Remove the PCIe riser cage ("[Remove the primary PCIe riser cage](#)" on page 33, "[PCIe riser cage LED](#)" on page 87).
7. Remove any expansion boards from the PCIe riser cage ("[Expansion boards](#)" on page 52).

8. Remove the PCIe riser board.

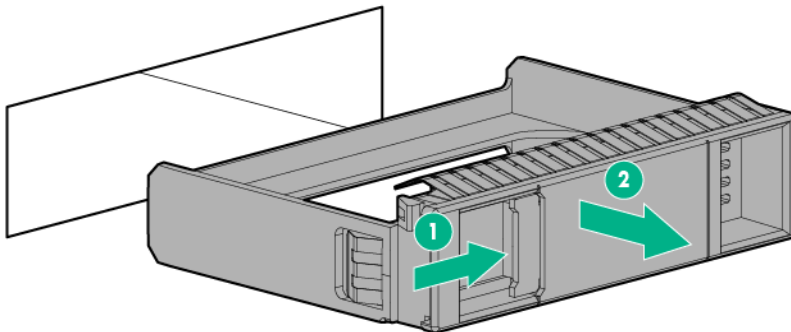


To replace the component, reverse the removal procedure.

Drive blank

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

Remove the drive blank.



To replace the LFF drive blank, slide the component into the bay until it clicks.

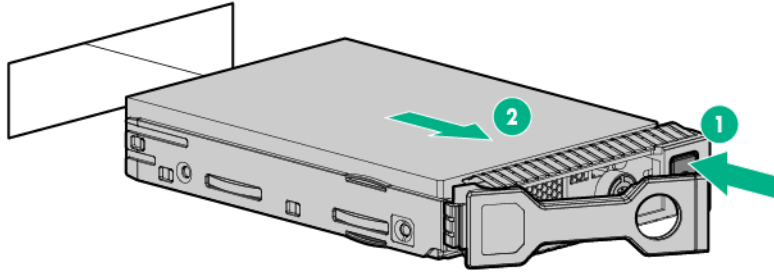
To replace the SFF drive blank, while pressing the release latch, slide the component into the bay until it is fully seated.

Hot-plug drive

CAUTION: For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

1. Determine the status of the drive from the hot-plug drive LED definitions (on page 86).
2. Back up all server data on the drive.

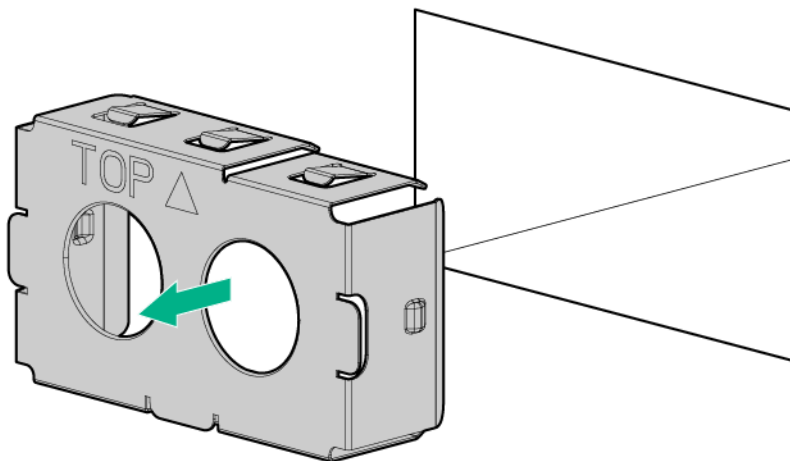
3. Remove the drive.



To replace the component, reverse the removal procedure.

Power supply blank

Remove the blank.



To replace the component, reverse the removal procedure.

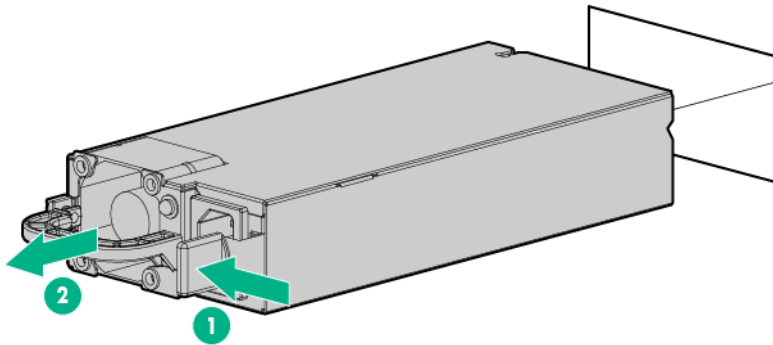
AC power supply

CAUTION: To prevent improper cooling and thermal damage, do not operate the server unless all bays are populated with either a component or a blank.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Access the product rear panel (on page 28).
4. Remove the power supply.

WARNING: To reduce the risk of personal injury from hot surfaces, allow the power supply or power supply blank to cool before touching it.

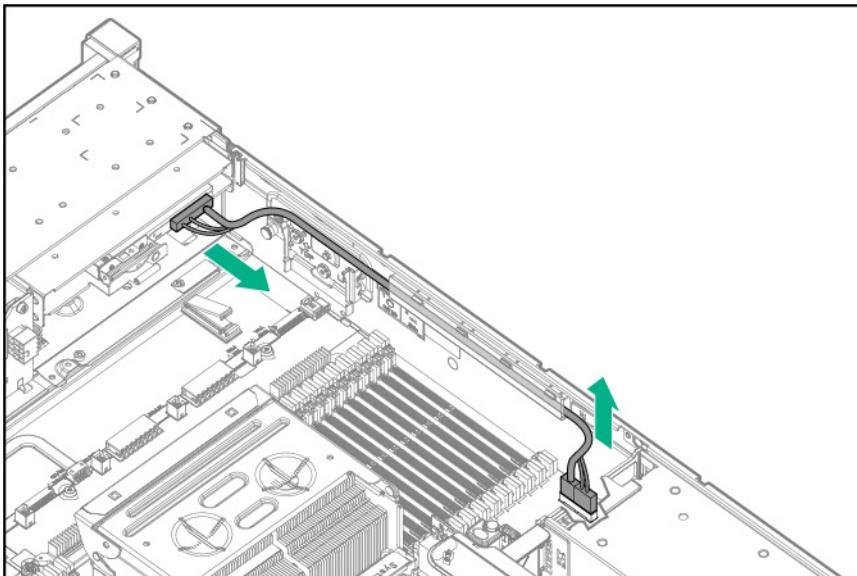


To replace the component, reverse the removal procedure.

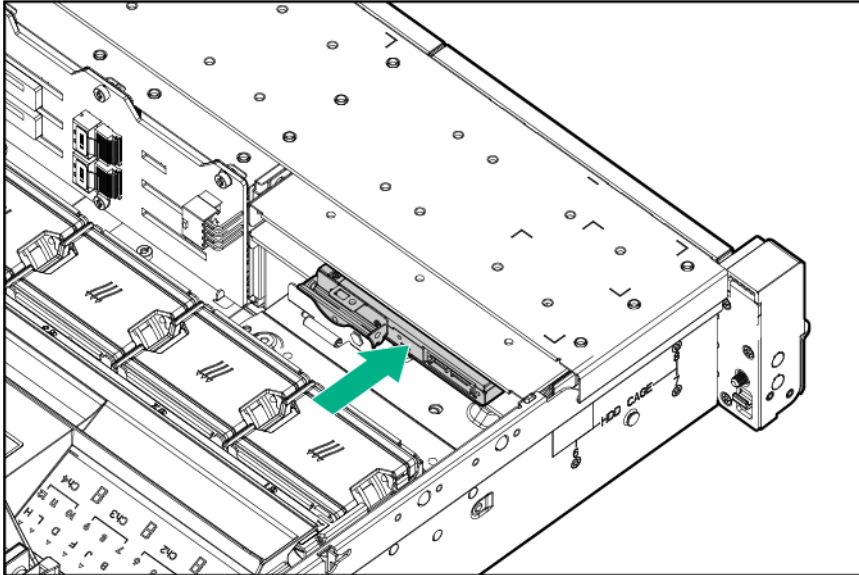
Optical drive

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Remove the fan cage ("[Fan cage](#)" on page 41).
7. Disconnect the optical drive cable.



8. Remove the optical drive.



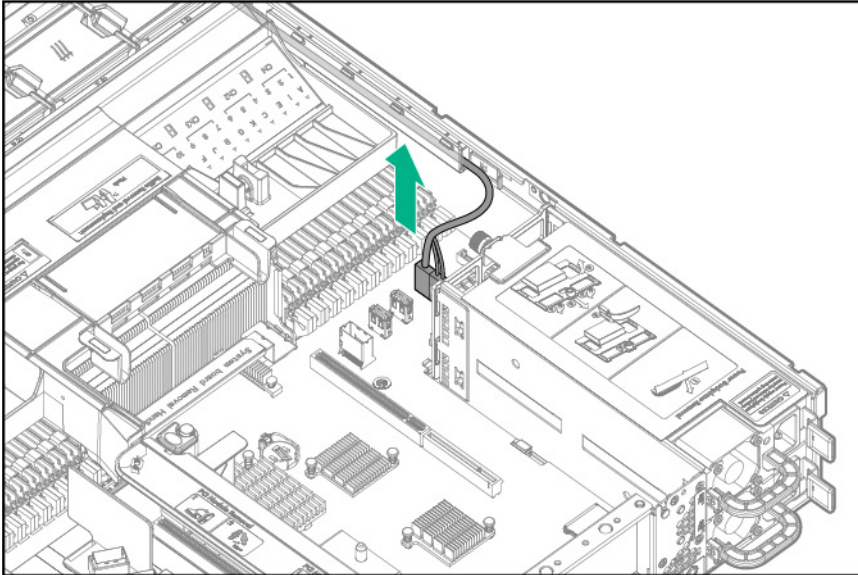
To replace the component, reverse the removal procedure.

Power supply backplane

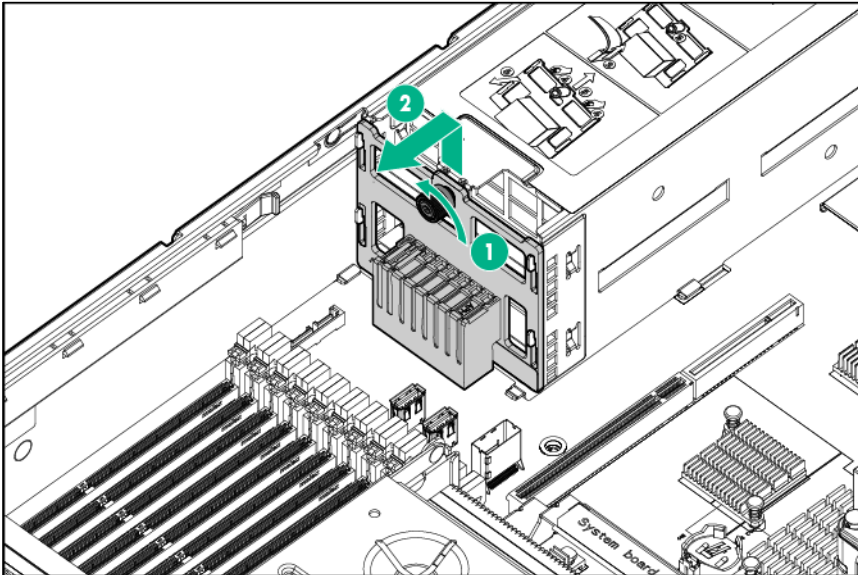
To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Remove all power supplies ("AC power supply" on page 37).
4. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
5. Remove the access panel ("Access panel" on page 30).

6. Disconnect the SATA cable.



7. Remove the power supply backplane.



To replace the component, reverse the removal procedure.

Hot-plug fan

The server supports variable fan speeds. The fans operate at minimum speed until a temperature change requires a fan speed increase to cool the server.

The server shuts down in the following temperature-related scenarios:

- At POST:
 - The BIOS suspends the server for 5 minutes if it detects a cautionary temperature level. If the cautionary temperature level is still detected after 5 minutes, the BIOS performs an orderly shutdown and enters Standby mode.
 - The BIOS performs an orderly shutdown if two or more fans have failed.
 - The server performs an immediate shutdown if it detects a critical temperature level.



IMPORTANT: An immediate shutdown is a hardware-controlled function and it overrides any firmware or software actions.

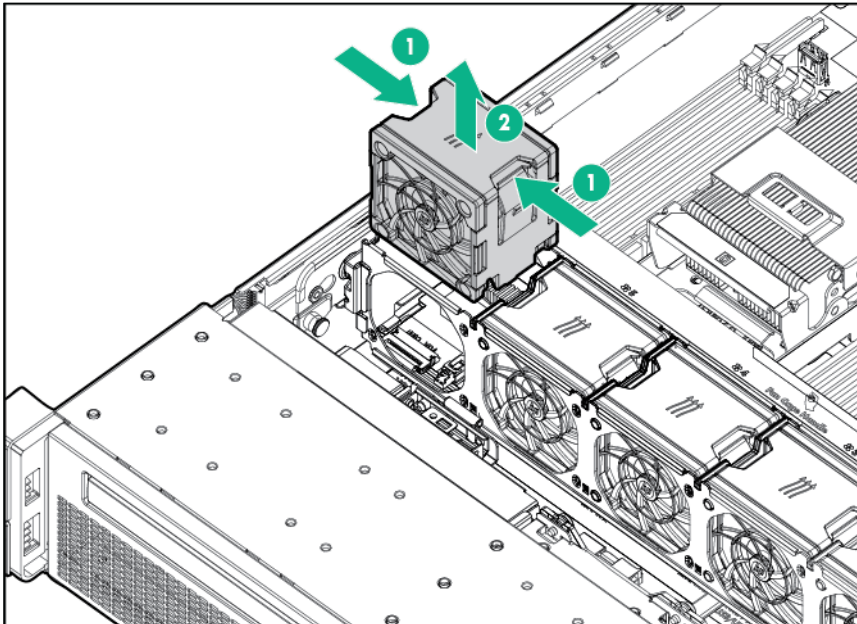
- In the operating system:
 - The Health Driver performs an orderly shutdown if it detects a cautionary temperature level. If the server detects a critical temperature level before the orderly shutdown occurs, the server performs an immediate shutdown. Additionally, the Health Driver performs an orderly shutdown if more than one fan is failed or removed.
 - When Thermal Shutdown is disabled in RBSU, the server performs an immediate shutdown if it detects a critical temperature level.



IMPORTANT: An immediate shutdown is a hardware-controlled function and it overrides any firmware or software actions.

To remove the component:

1. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
2. Remove the access panel ("[Access panel](#)" on page 30).
3. Remove the fan.



CAUTION: Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

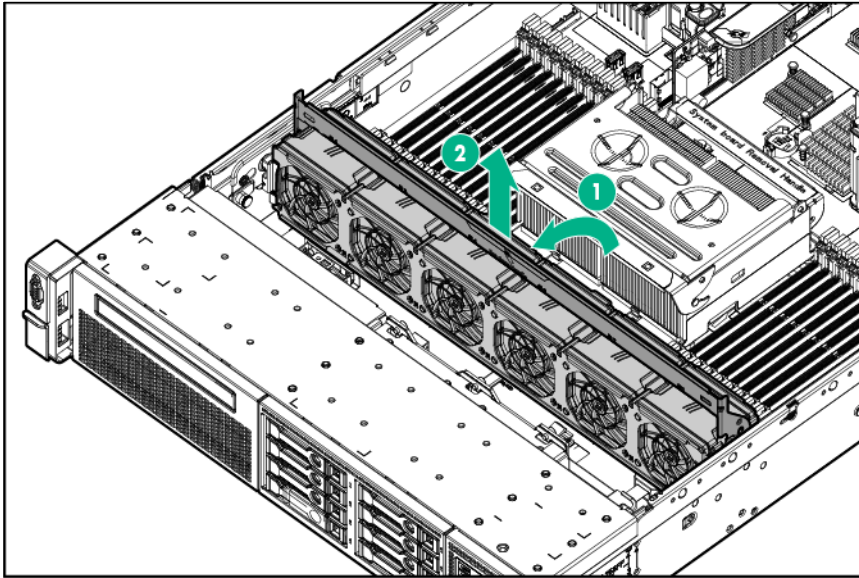
To replace the component, reverse the removal procedure.

Fan cage

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:

- a. Disconnect each power cord from the power source.
- b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Remove the fan cage.



CAUTION: Do not operate the server for long periods with the access panel open or removed. Operating the server in this manner results in improper airflow and improper cooling that can lead to thermal damage.

IMPORTANT: For optimum cooling, install fans in all primary fan locations. For more information, refer to the fan locations table ("[Hot-plug fans](#)" on page 89).

To replace the component, reverse the removal procedure.

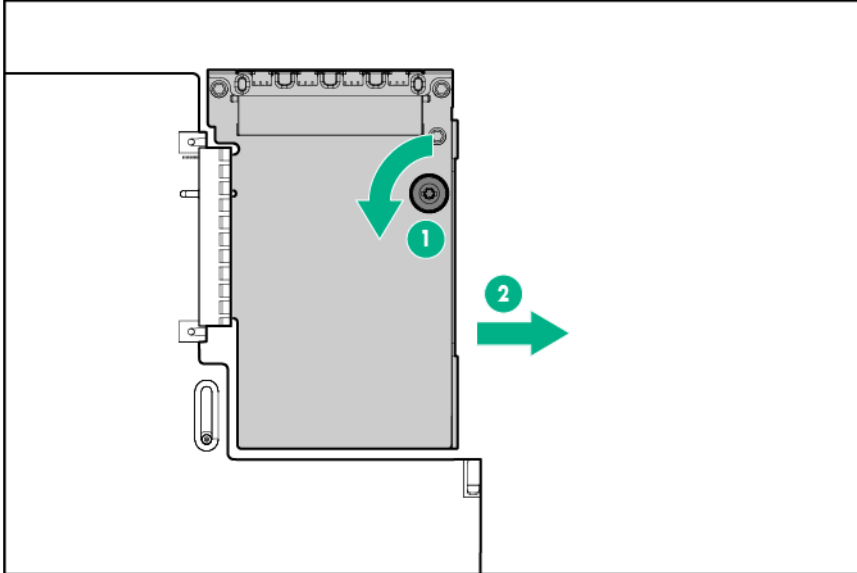
FlexibleLOM

WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Remove any attached network cables.
4. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
5. Remove the access panel ("[Access panel](#)" on page 30).
6. Remove the primary PCIe riser cage (on page 33, "[PCIe riser cage LED](#)" on page 87).

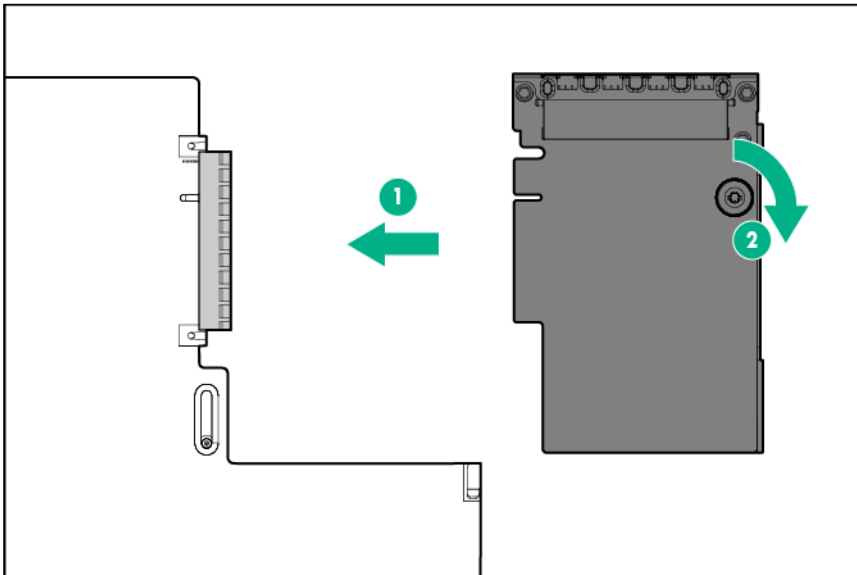
7. Loosen the thumbscrew.
8. Remove the existing FlexibleLOM.

Pull the FlexibleLOM toward the front of the server while removing it, to avoid catching it on the rear chassis.



To replace the component:

1. Firmly seat the FlexibleLOM in the slot, and then tighten the thumbscrew.

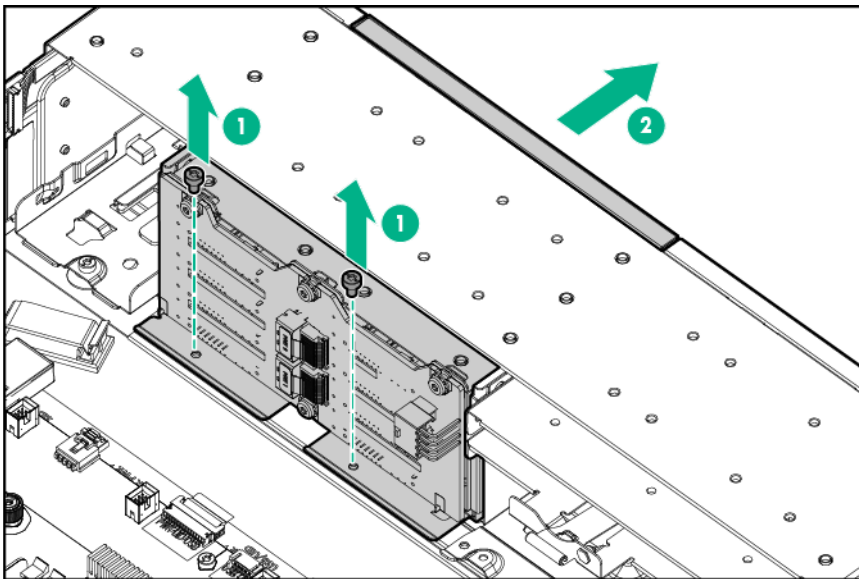


2. Install the PCIe riser cage ("[Remove the primary PCIe riser cage](#)" on page 33, "[PCIe riser cage LED](#)" on page 87).
3. Install the access panel ("[Access panel](#)" on page 30).
4. Slide the server into the rack.
5. Connect the LAN segment cables.
6. Connect each power cord to the server.
7. Connect each power cord to the power source.
8. Power up the server.

SFF hard drive cage

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove all hot-plug hard drives ("[Hot-plug drive](#)" on page 36).
6. Remove the air baffle (on page 31).
7. Remove the fan cage ("[Fan cage](#)" on page 41).
8. Disconnect all cables from the hard drive backplane.
9. Remove the hard drive cage.



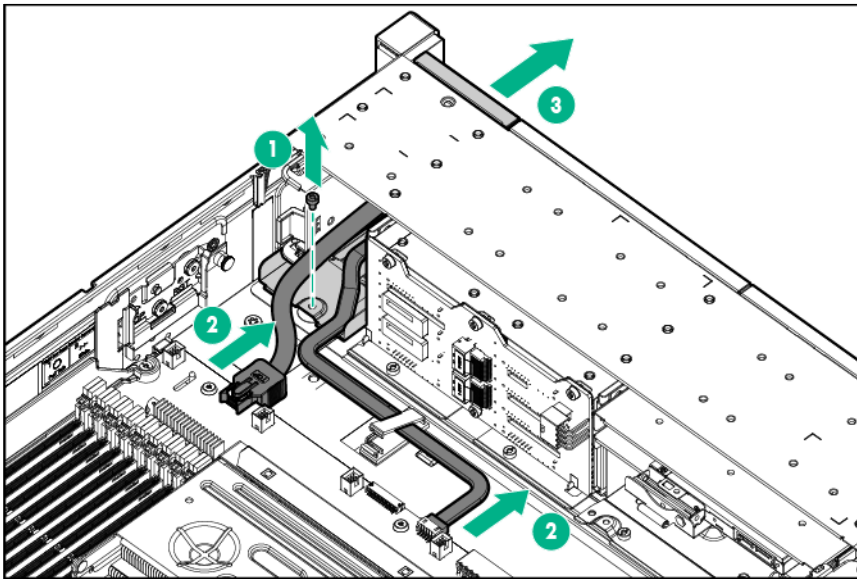
To replace the component, reverse the removal procedure.

Systems Insight Display

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Remove the fan cage ("[Fan cage](#)" on page 41).

7. Remove the Systems Insight Display:
 - a. Remove the screw from the rear of the Systems Insight Display.
 - b. Disconnect the Systems Insight Display cable and the USB cable from the system board, and disconnect the USB cable from the front of the Systems Insight Display.
 - c. Remove the Systems Insight Display.



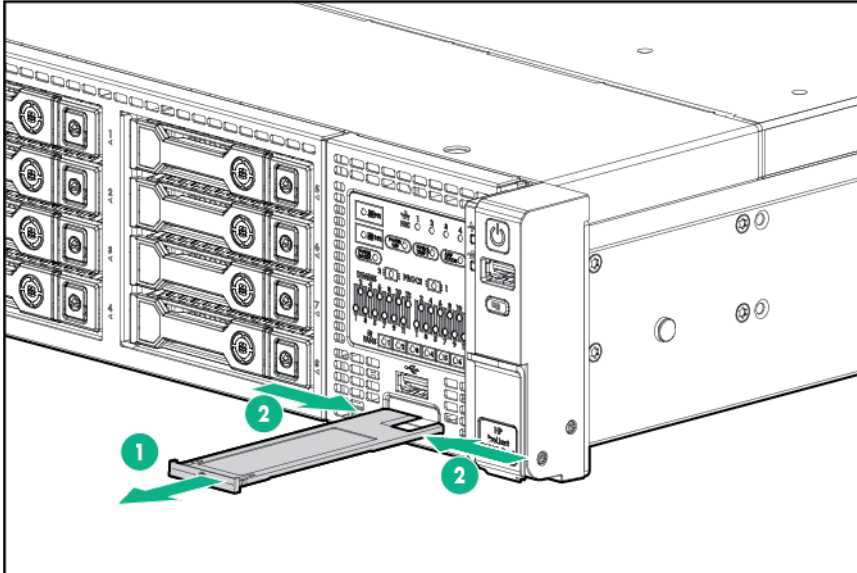
To replace the component, reverse the removal procedure.

Front panel assembly

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Remove the server from the rack (on page 27).
4. Remove the access panel ("[Access panel](#)" on page 30).

5. Remove the serial label pull tab, and retain it for the new front panel assembly.

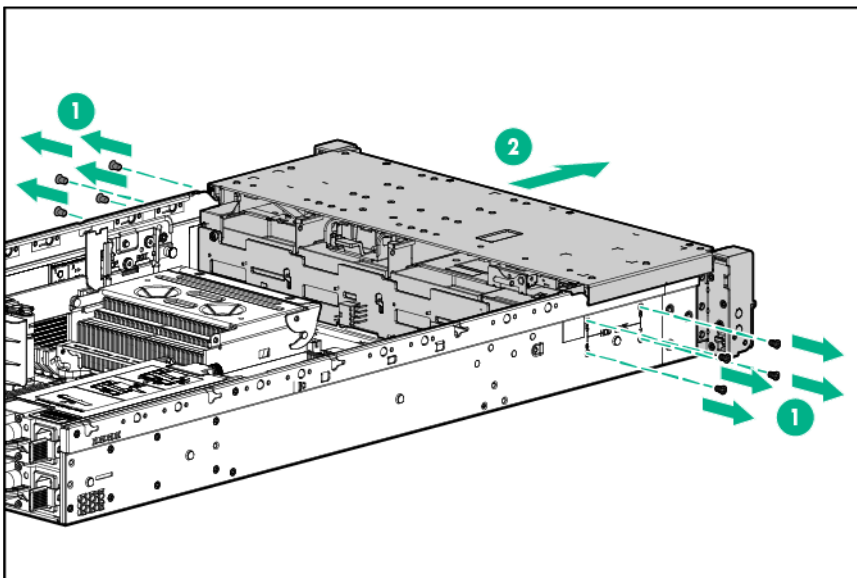


6. Remove the air baffle (on page 31).
7. Remove all drives ("Hot-plug drive" on page 36).
8. If installed, remove the optical drive ("Optical drive" on page 38).
9. Remove the fan cage ("Fan cage" on page 41).
10. Disconnect all cables from the front panel assembly.



IMPORTANT: If any cables in the front panel assembly need replacing, the entire front panel assembly must be replaced.

11. Remove the four T-10 Torx screws from each side, and then remove the front panel assembly.



To replace the component, reverse the removal procedure.

Flash-backed write cache procedures

Two types of procedures are provided for the FBWC option:

- Removal and replacement of failed components:
 - Removing the cache module ("[Flash-backed write cache module](#)" on page 47)
 - Removing the capacitor pack ("[Flash-backed write cache capacitor pack](#)" on page 48)
- Recovery of cached data from a failed server ("[Recovering data from the flash-backed write cache](#)" on page 51)



CAUTION: Do not detach the cable that connects the battery pack or capacitor pack to the cache module. Detaching the cable causes all data in the cache module to be lost.

Flash-backed write cache module

To remove the component:



CAUTION: The cache module connector does not use the industry-standard DDR3 mini-DIMMs. Do not use the controller with cache modules designed for other controller models, because the controller can malfunction and you can lose data. Also, do not transfer this cache module to an unsupported controller model, because you can lose data.

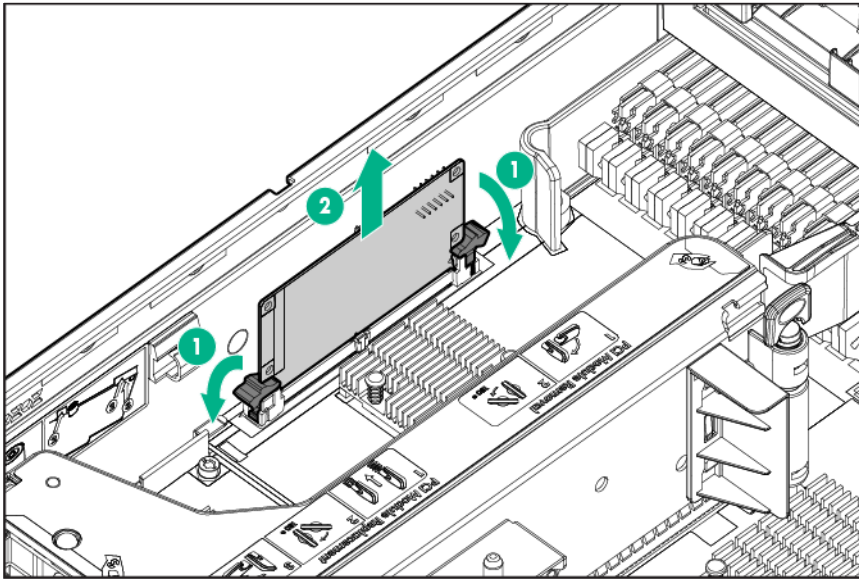
1. Back up all data.
2. Close all applications.
3. Power down the server (on page 25).
4. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.



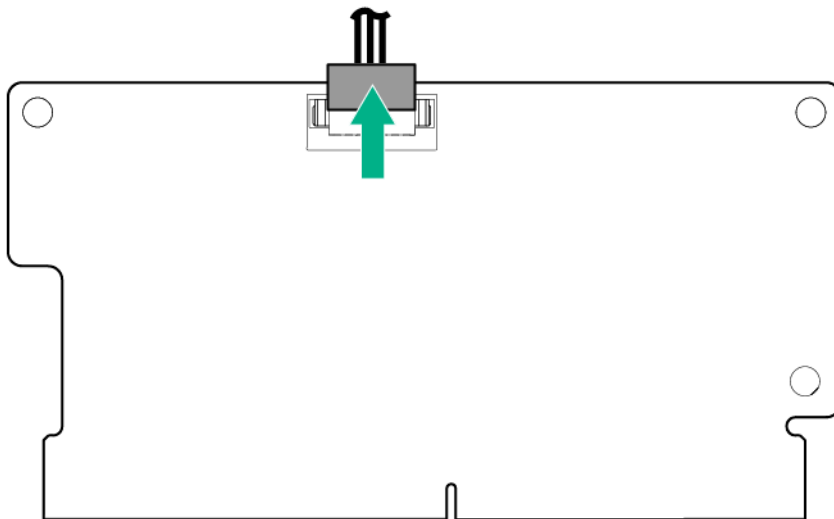
CAUTION: In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

5. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
6. Remove the access panel ("[Access panel](#)" on page 30).
7. If it is populated with expansion boards, remove the PCIe riser cage for better access ("[Remove the primary PCIe riser cage](#)" on page 33, "[PCIe riser cage LED](#)" on page 87).
8. If the existing cache module is connected to a capacitor pack, observe the FBWC module LEDs:
 - If the amber LED is flashing, data is trapped in the cache. Restore system power, and restart this procedure from step 1.
 - If the amber LED is not illuminated, remove the controller from the server, and then continue with the next step.

9. Open the ejector latches on each side of the cache module connector. Normally, the cache module is ejected from the cache module connector. If the module is not ejected automatically, remove the cache module.



10. If the cache module is connected to a capacitor pack, disconnect the capacitor pack cable from the connector on the top of the cache module.



To replace the component, reverse the removal procedure.



CAUTION: To prevent damage to the cache module during installation, be sure the cache module is fully inserted before pressing down.

Flash-backed write cache capacitor pack

To remove the component:

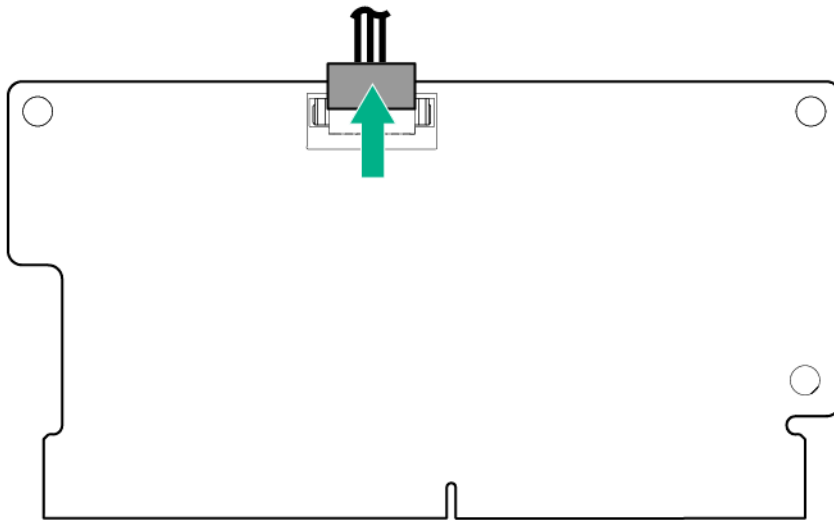
1. Back up all data.
2. Close all applications.

3. Power down the server (on page 25).
4. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.



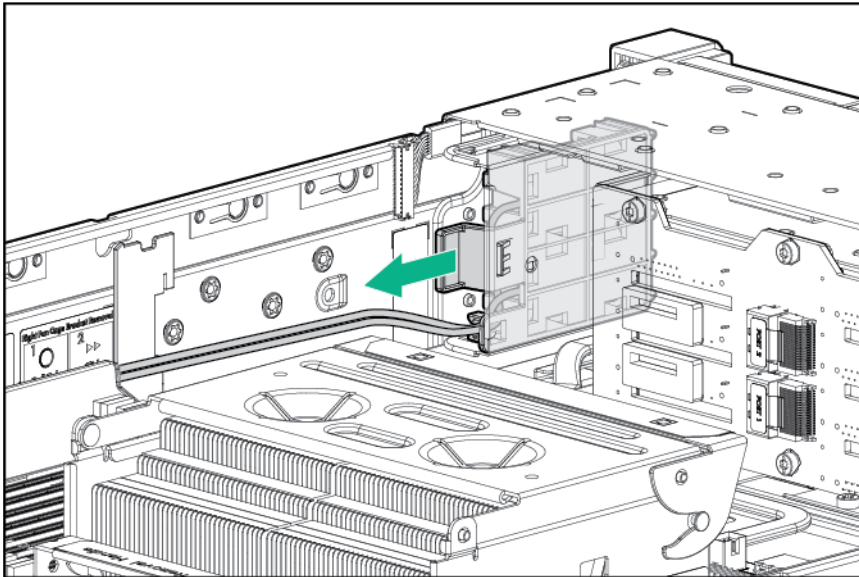
CAUTION: In systems that use external data storage, be sure that the server is the first unit to be powered down and the last to be powered back up. Taking this precaution ensures that the system does not erroneously mark the drives as failed when the server is powered up.

5. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
6. Remove the access panel ("[Access panel](#)" on page 30).
7. If it is populated with expansion boards, remove the PCIe riser cage for better access ("[Remove the primary PCIe riser cage](#)" on page 33, "[PCIe riser cage LED](#)" on page 87).
8. If the capacitor pack is connected to the cache module, disconnect the capacitor pack cable from the connector on the top of the cache module.

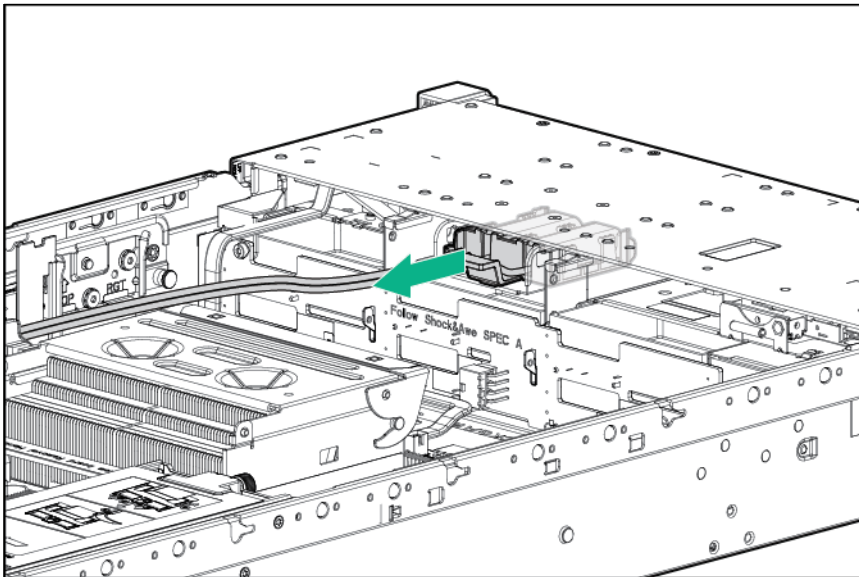


9. Disconnect the SAS hard drive backplane ribbon cable, and then remove the right fan bracket.
10. Remove the capacitor pack.

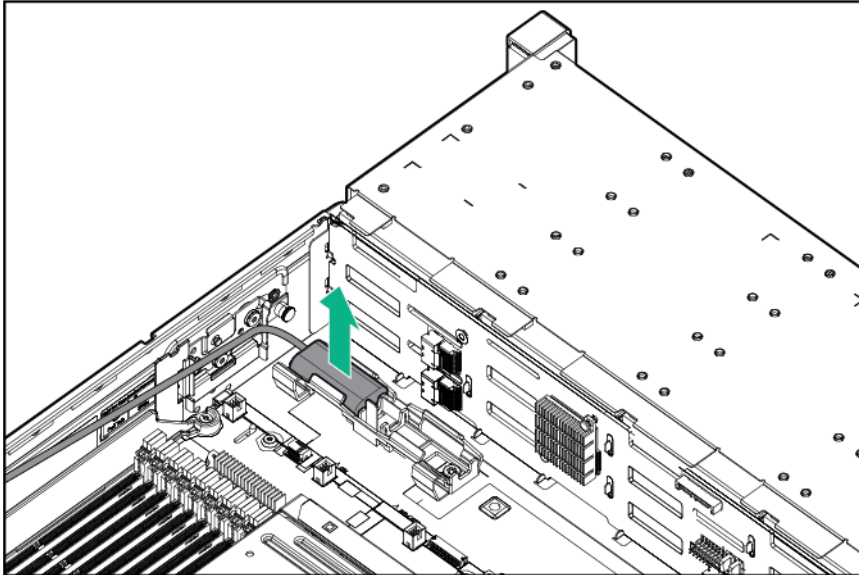
- o 8 or 16 SFF configuration



- o 8 LFF configuration



- 12 LFF or 25 SFF configuration



To replace the component, reverse the removal procedure.

Recovering data from the flash-backed write cache

If the server fails, use the following procedure to recover data temporarily stored in the FBWC.

⚠ CAUTION: Before starting this procedure, read the information about protecting against electrostatic discharge.

1. Perform one of the following:
 - Set up a recovery server using an identical server model. Do not install any internal drives or FBWC in this server. (Hewlett Packard Enterprise recommends this option.)
 - Find a server that has enough empty drive bays to accommodate all the drives from the failed server and that meets all the other requirements for drive and array migration.
2. Power down the failed server ("[Power down the server](#)" on page 25).
3. Transfer the drives from the failed server to the recovery server.
4. Perform one of the following:
 - If the array controller has failed, remove the cache module and capacitor pack from the failed array controller, and install the cache module and capacitor pack on an identical array controller model in the recovery server.
 - If the server has failed, remove the controller ("[Half-length expansion board](#)" on page 52), cache module, and capacitor pack from the failed server, and install the controller, cache module, and capacitor pack in the recovery server.
5. Power up the recovery server. If there was data in the cache at the time of the controller or server failure, a 1792 POST message appears, stating that valid data was flushed from the cache. This data is now stored on the drives in the recovery server. You can now transfer the drives (and controller, if one is used) to another server.

If the drives are migrated to different drive positions or there are volumes present in the recovery server, a 1724 POST message appears, stating that logical drive configuration has been updated automatically.

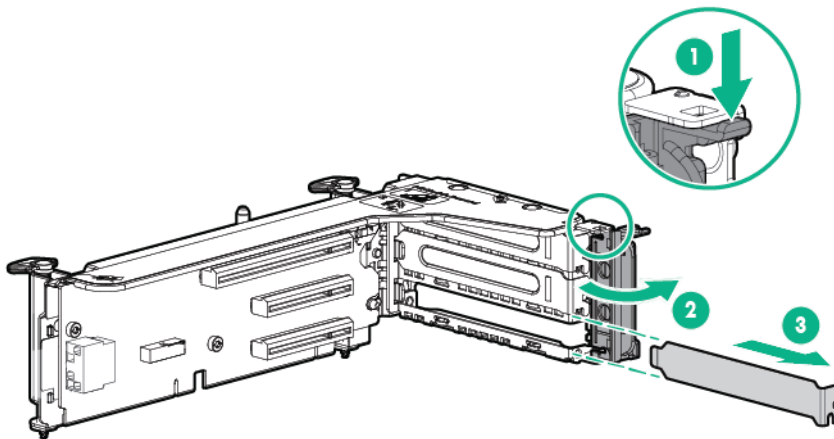
Expansion slot blanks

⚠ WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

⚠ CAUTION: For proper cooling, do not operate the server without the access panel, baffles, expansion slot covers, or blanks installed. If the server supports hot-plug components, minimize the amount of time the access panel is open.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
4. Remove the access panel ("Access panel" on page 30).
5. Disconnect any external cables that are connected to the expansion board.
6. Disconnect any internal cables that are connected to the expansion board.
7. Remove the PCIe riser cage ("Remove the secondary PCIe riser cage" on page 34, "Remove the primary PCIe riser cage" on page 33).
8. Remove the expansion slot blank.



To replace the component, reverse the removal procedure.

Expansion boards

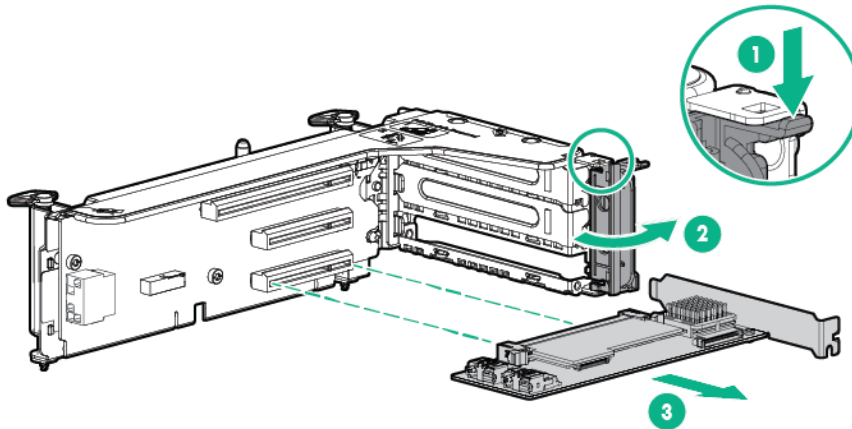
Half-length expansion board



WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
4. Remove the access panel ("Access panel" on page 30).
5. Disconnect any external cables that are connected to the expansion board.
6. Disconnect any internal cables that are connected to the expansion board.
7. Remove the PCIe riser cage ("Remove the primary PCIe riser cage" on page 33, "PCIe riser cage LED" on page 87).
8. Remove the expansion board.



To replace the component, reverse the removal procedure.

Full length expansion board

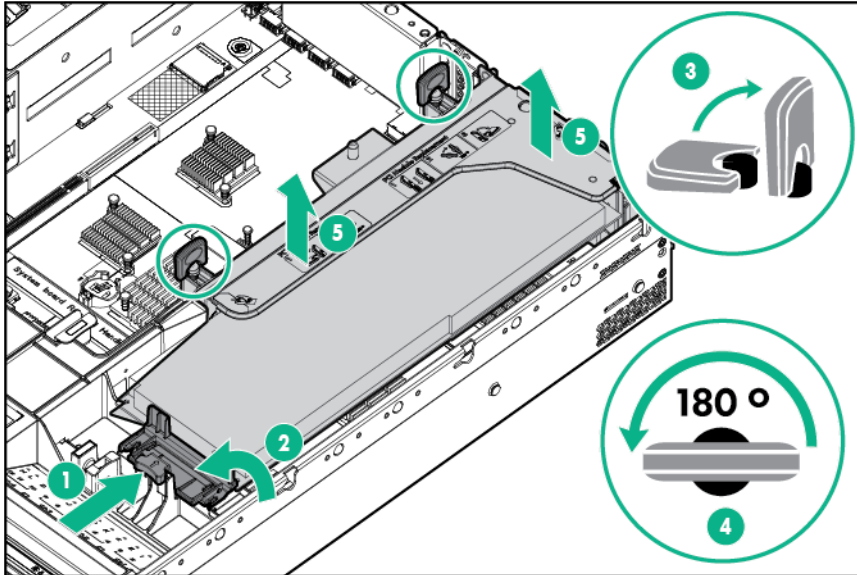


CAUTION: To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser cage.

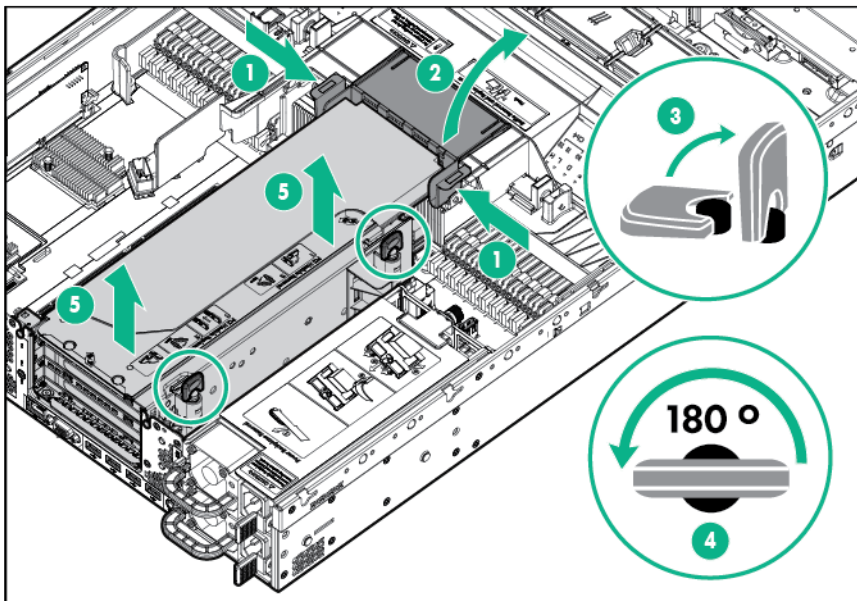
To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.

3. Extend ("Extend the server from the rack" on page 26) or remove ("Remove the server from the rack" on page 27) the server from the rack.
4. Remove the access panel ("Access panel" on page 30).
5. Disconnect any external cables that are connected to the expansion board.
6. Disconnect any internal cables that are connected to the expansion board.
7. If a full-length expansion board is installed in slot 1, release the full-length expansion board retainer, and then remove the primary PCIe riser cage.



8. If a full-length expansion board is installed in slot 4, release the full-length expansion board retainer, and then remove the secondary PCIe riser cage.



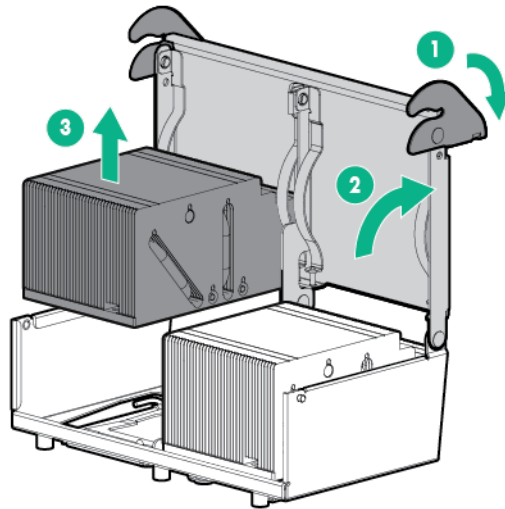
9. Remove the full-length expansion board.
To replace the component, reverse the removal procedure.

Heatsink

-
- ⚠ WARNING:** To reduce the risk of personal injury from hot surfaces, allow the drives and the internal system components to cool before touching them.
-
- ⚠ CAUTION:** The heatsink thermal interface media is not reusable and must be replaced if the heatsink is removed from the processor after it has been installed.
-
- ⚠ CAUTION:** To avoid thermal shutdown, all fans must be installed in a dual processor configuration.
-

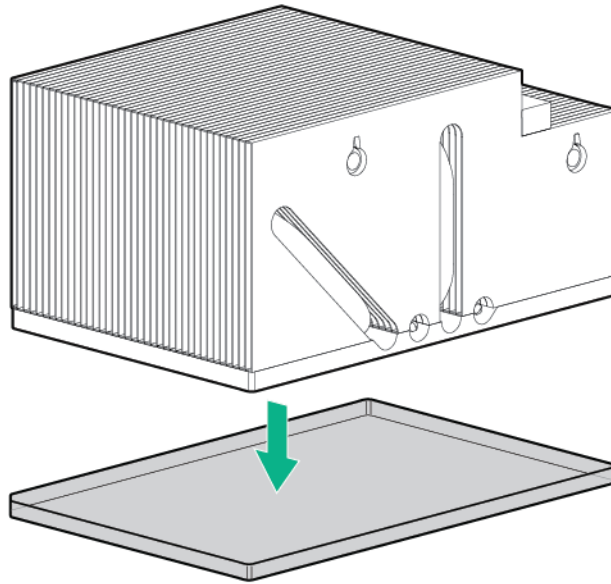
To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Remove the heatsink.

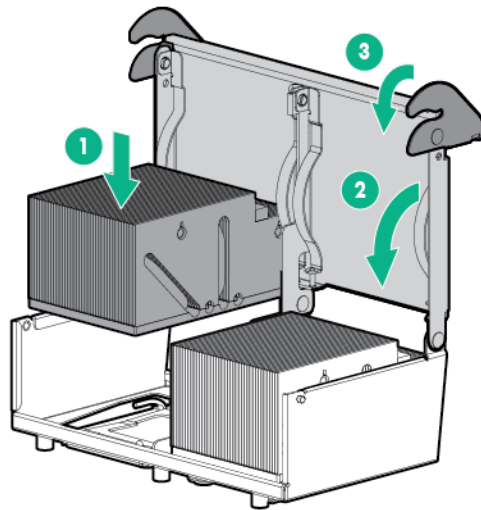


To replace the component:

1. Remove the thermal interface protective cover from the heatsink.



2. Install the heatsink.



3. Install the air baffle ("[Remove the air baffle](#)" on page 31).
4. Install the access panel ("[Access panel](#)" on page 30).
5. Slide the server into the rack.
6. Connect each power cord to the server.
7. Connect each power cord to the power source.
8. Power up the server.

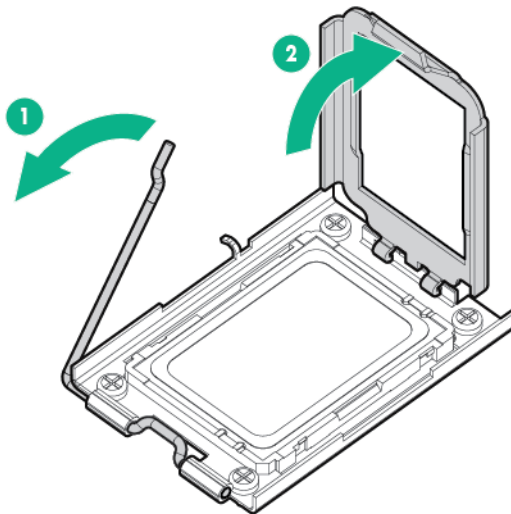
Processor

△ **CAUTION:** To avoid damage to the processor and system board, only authorized personnel should attempt to replace or install the processor in this server.

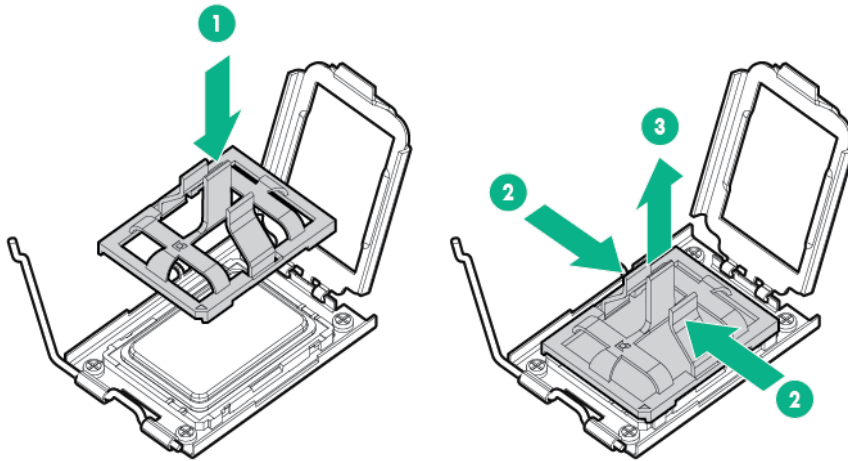
△ **CAUTION:** To prevent possible server malfunction and damage to the equipment, multiprocessor configurations must contain processors with the same part number.

To remove a processor:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend or remove the server from the rack ("[Extend the server from the rack](#)" on page 26).
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Open the processor socket retaining bracket and the processor locking lever.



- Using the processor tool, remove the processor from the system board.



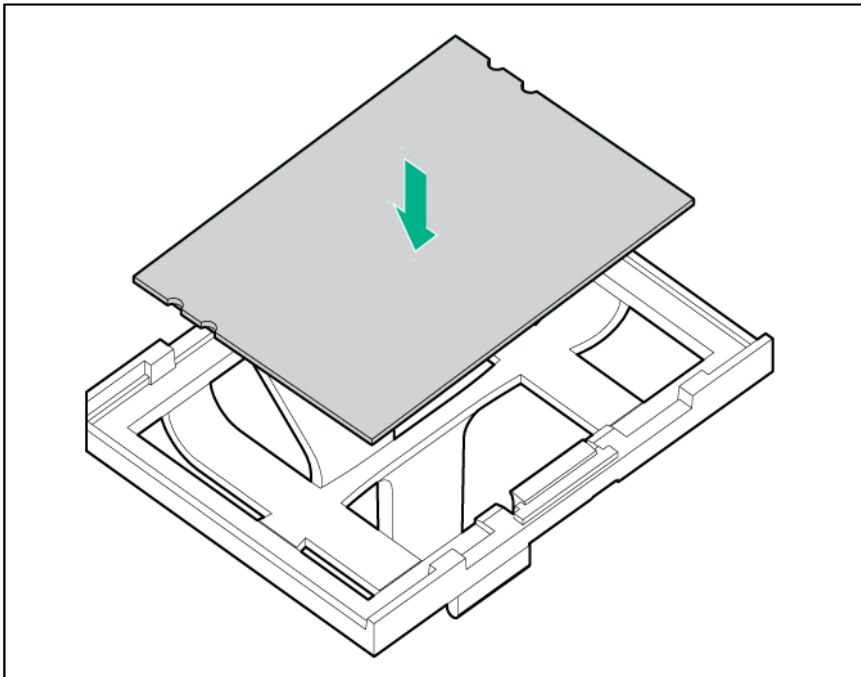
CAUTION: To avoid damage to the processor, do not touch the bottom of the processor, especially the contact area.

To replace a processor:

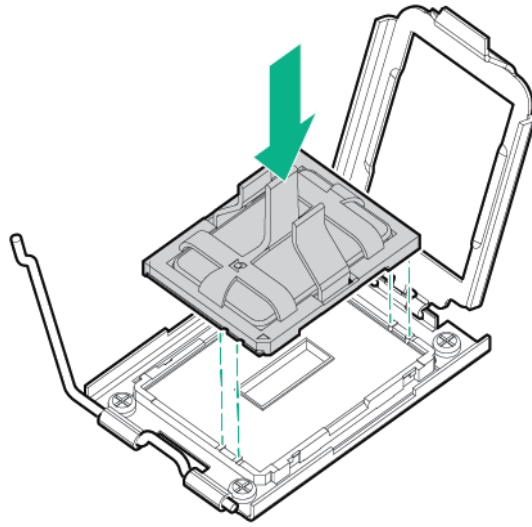


IMPORTANT: Be sure the processor remains inside the processor installation tool.

- If the processor has separated from the installation tool, carefully re-insert the processor in the tool. Handle the processor by the edges only, and do not touch the bottom of the processor, especially the contact area.



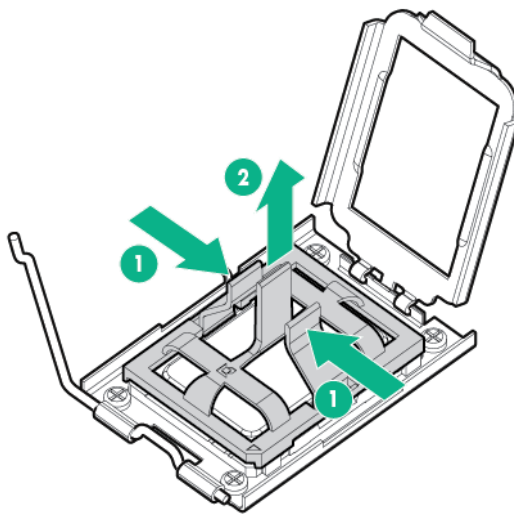
- The processor fits one way into the socket. Use the alignment guides on the processor and socket to properly align the processor with the socket. Install the spare processor. **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.**



⚠ CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED. To avoid damage to the system board:

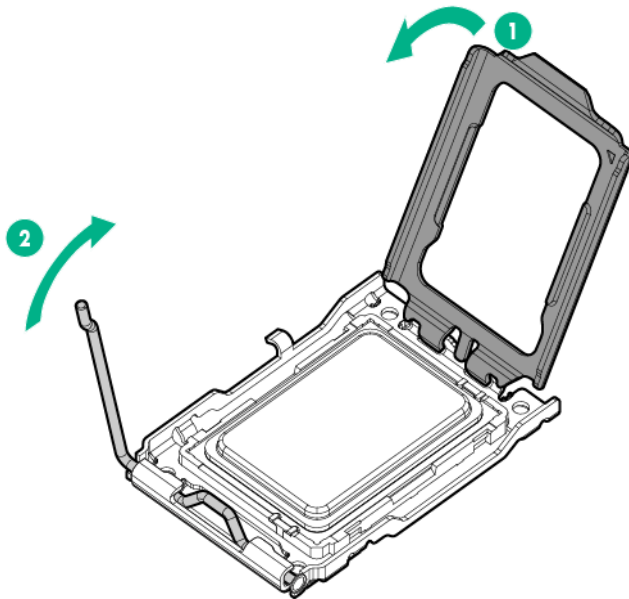
- Never install or remove a processor without using the processor installation tool.
- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

- Press the tabs on the processor tool to release the processor, and then remove the processor tool.

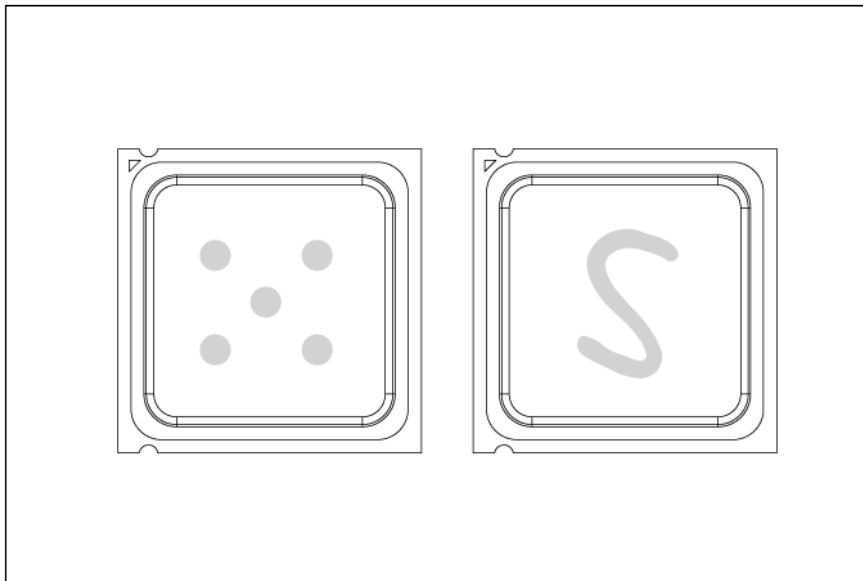


- Close the processor socket retaining bracket and the processor locking lever.

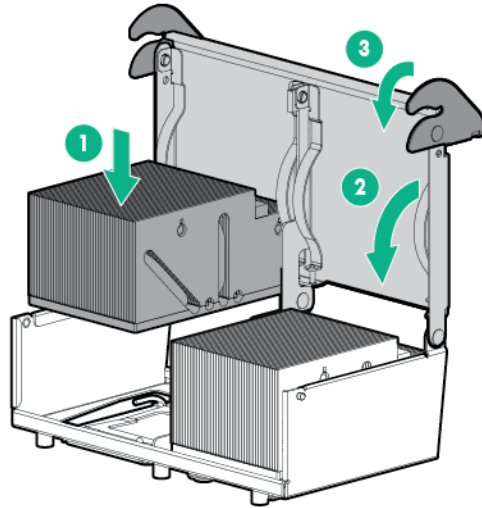
⚠ CAUTION: Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.



5. Clean the old thermal grease from the heatsink with the alcohol swab. Allow the alcohol to evaporate before continuing.
6. Apply all the grease to the top of the processor in one of the following patterns to ensure even distribution.



1. Install the heatsink.



2. Install the air baffle.
3. Install the access panel ("[Access panel](#)" on page [30](#)).
4. Install the server into the rack.
5. Connect each power cord to the server.
6. Connect each power cord to the power source.
7. Power up the server.

DIMMs



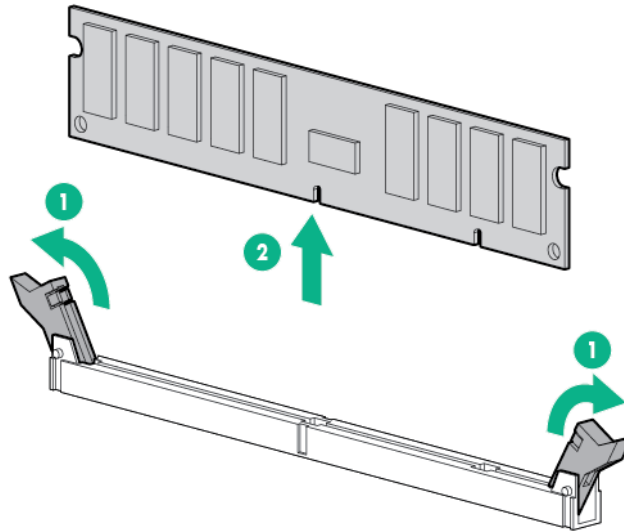
IMPORTANT: This server does not support mixing RDIMMs and UDIMMs. Attempting to mix these two types causes the server to halt during BIOS initialization.

To identify the DIMMs installed in the server, see "[DIMM slot locations](#) (on page [85](#))."

To remove the component:

1. Power down the server (on page [25](#)).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page [26](#)) or remove ("[Remove the server from the rack](#)" on page [27](#)) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page [30](#)).
5. Remove the air baffle (on page [31](#)).

6. Remove the DIMM.



To replace the component, reverse the removal procedure.

For DIMM configuration information, see the server user guide.

System battery

If the server no longer automatically displays the correct date and time, you may need to replace the battery that provides power to the real-time clock.



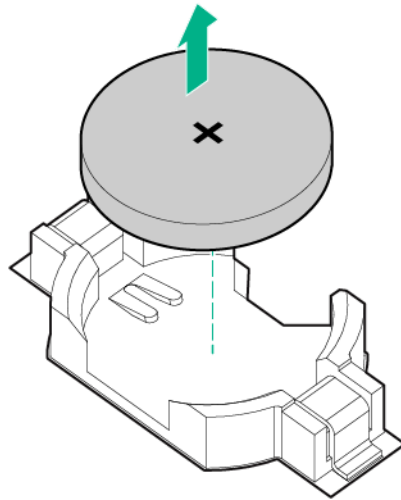
WARNING: The computer contains an internal lithium manganese dioxide, a vanadium pentoxide, or an alkaline battery pack. A risk of fire and burns exists if the battery pack is not properly handled. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose the battery to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
- Replace only with the spare designated for this product.

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. If installed, remove the secondary PCIe riser cage (on page 34).
6. Locate the battery ("[System board components](#)" on page 83).

7. Remove the battery.



To replace the component, reverse the removal procedure.

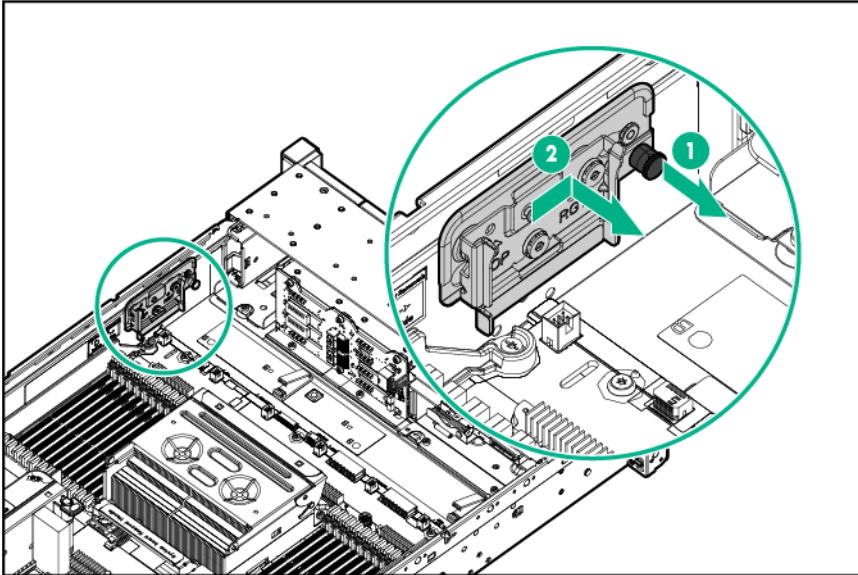
For more information about battery replacement or proper disposal, contact an authorized reseller or an authorized service provider.

System board

To remove the component:

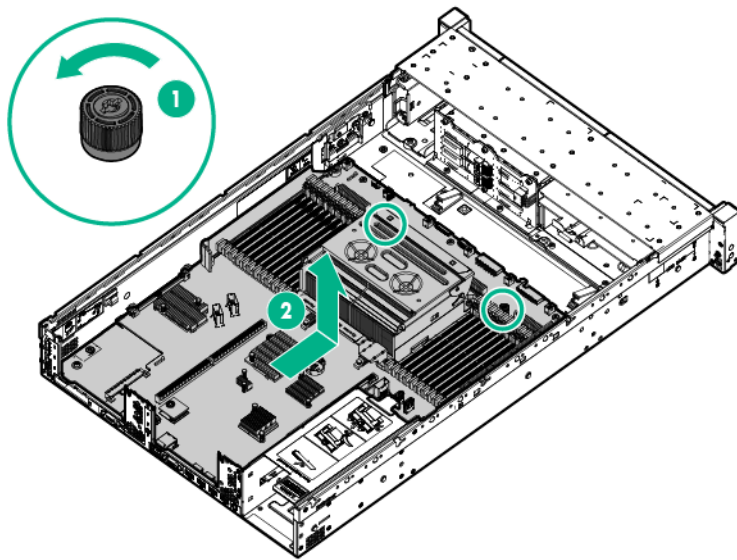
1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Remove the server from the rack (on page 27).
4. Remove all power supplies ("AC power supply" on page 37).
5. Remove the access panel ("Access panel" on page 30).
6. Remove the air baffle (on page 31).
7. Remove the PCIe riser cage ("Remove the secondary PCIe riser cage" on page 34, "Remove the primary PCIe riser cage" on page 33).
8. If installed, remove the secondary PCIe riser cage (on page 34).
9. If installed, remove the FBWC capacitor pack ("Flash-backed write cache capacitor pack" on page 48).
10. If installed, remove the cache module ("Flash-backed write cache module" on page 47).
11. Remove the FlexibleLOM ("FlexibleLOM" on page 42).
12. Remove all DIMMs ("DIMMs" on page 61).
13. Remove the fan cage ("Fan cage" on page 41).
14. Remove the power supply backplane ("Power supply backplane" on page 39).
15. Disconnect all cables connected to the system board.
16. Remove the heatsink.
17. Remove the processor ("Processor" on page 56).

18. Remove left and right fan cage brackets.



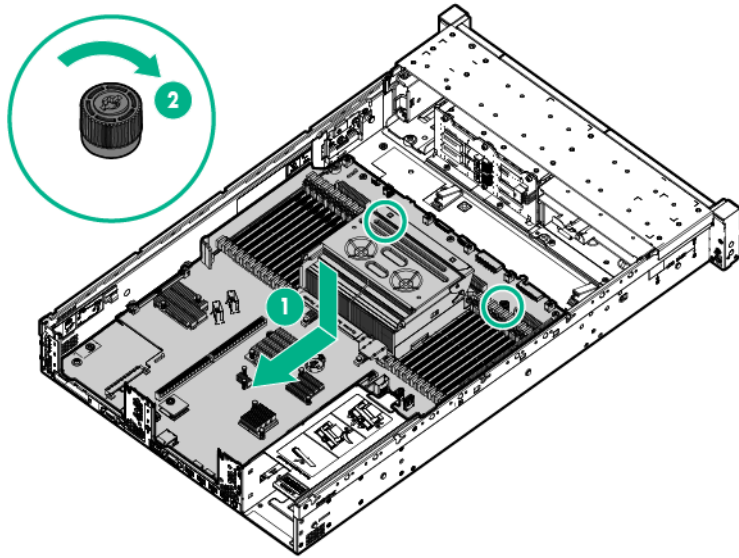
19. Loosen the system board thumbscrews.

20. Remove the system board, using the handle to lift it out of the chassis.

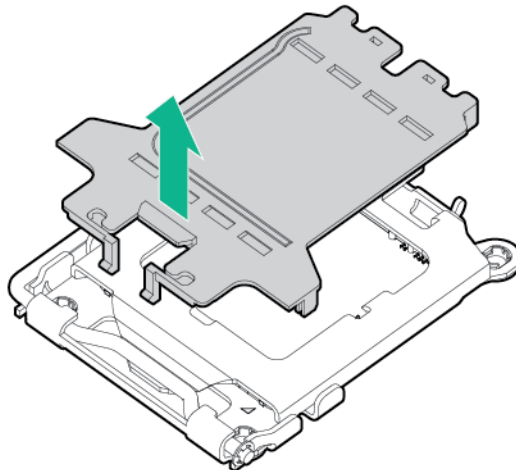


To replace the component:

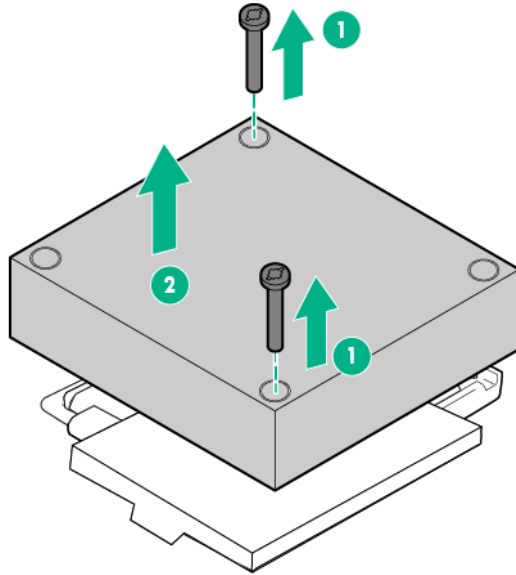
1. Install the spare system board.



2. Prepare the processor socket on the spare system board.
 - a. Remove the processor socket protective cover.



- b. Open the processor retaining latch and the processor socket retaining bracket.

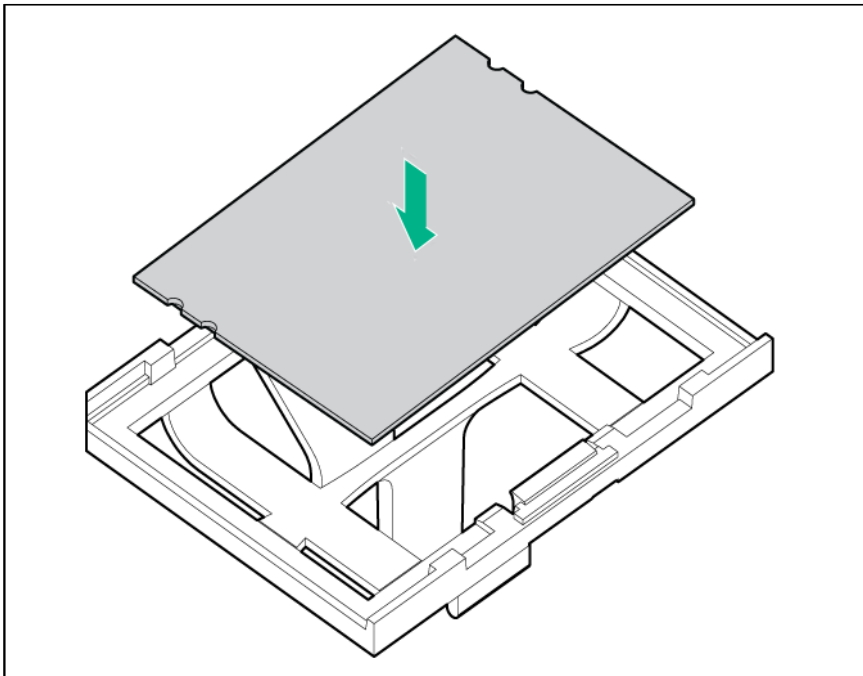


3. Install the processor socket cover onto the processor socket of the failed system board.
4. Install the processor on the spare system board.

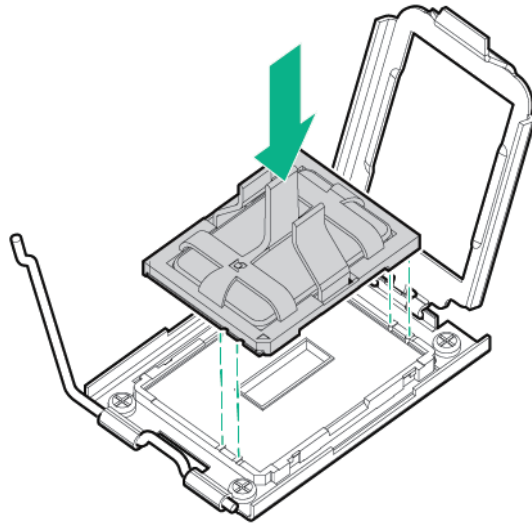


IMPORTANT: Be sure the processor remains inside the processor installation tool.

5. If the processor has separated from the installation tool, carefully re-insert the processor in the tool. Handle the processor by the edges only, and do not touch the bottom of the processor, especially the contact area.



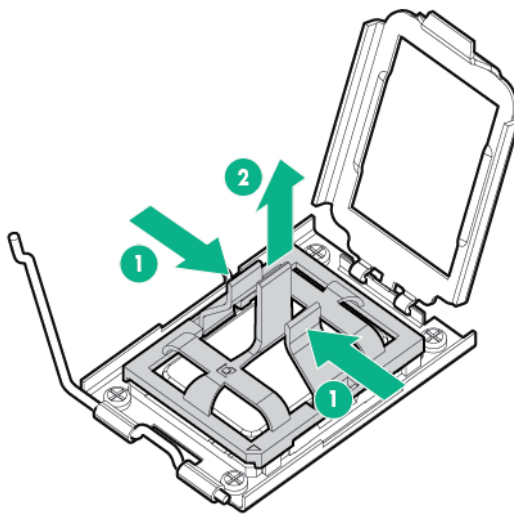
- The processor fits one way into the socket. Use the alignment guides on the processor and socket to properly align the processor with the socket. Install the spare processor. **THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED.**



CAUTION: THE PINS ON THE SYSTEM BOARD ARE VERY FRAGILE AND EASILY DAMAGED. To avoid damage to the system board:

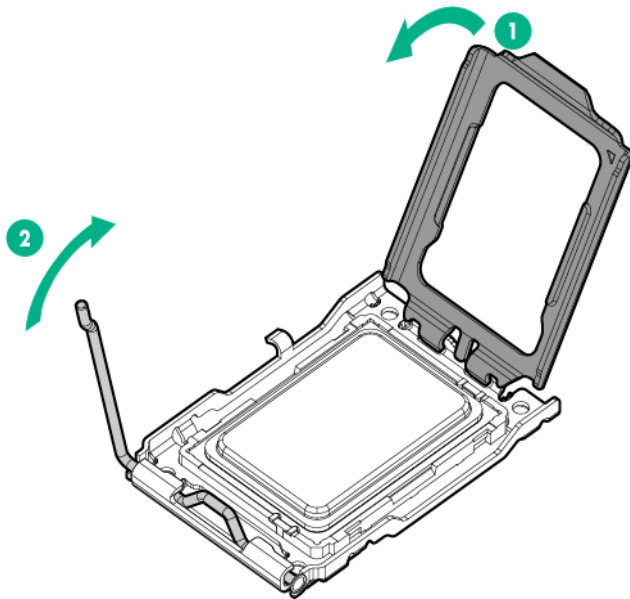
- Never install or remove a processor without using the processor installation tool.
- Do not touch the processor socket contacts.
- Do not tilt or slide the processor when lowering the processor into the socket.

- Press the tabs on the processor tool to release the processor, and then remove the processor tool.

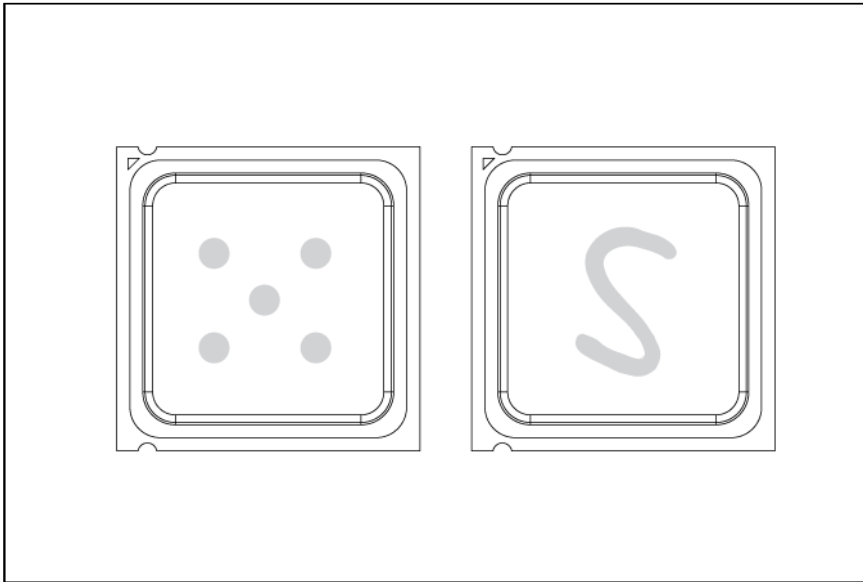


- Close the processor socket retaining bracket and the processor locking lever.

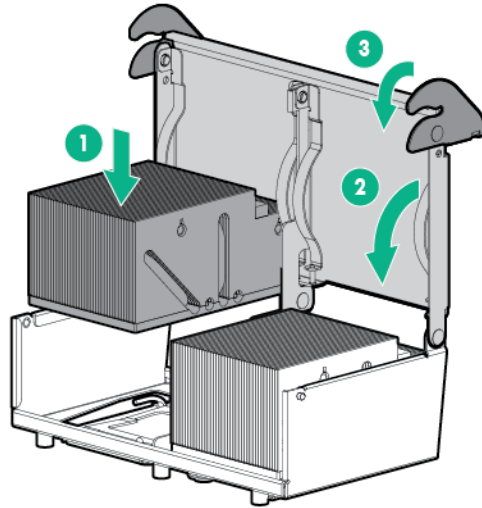
CAUTION: Be sure to close the processor socket retaining bracket before closing the processor locking lever. The lever should close without resistance. Forcing the lever closed can damage the processor and socket, requiring system board replacement.



9. Clean the old thermal grease from the heatsink with the alcohol swab. Allow the alcohol to evaporate before continuing.
10. Apply all the grease to the top of the processor in one of the following patterns to ensure even distribution.



11. Install the heatsink.



IMPORTANT: Install all components with the same configuration that was used on the failed system board.

12. Install all components removed from the failed system board.
13. Install the access panel ("[Access panel](#)" on page 30).
14. Install the power supplies ("[AC power supply](#)" on page 37).
15. Power up the server.

After you replace the system board, you must re-enter the server serial number and the product ID.

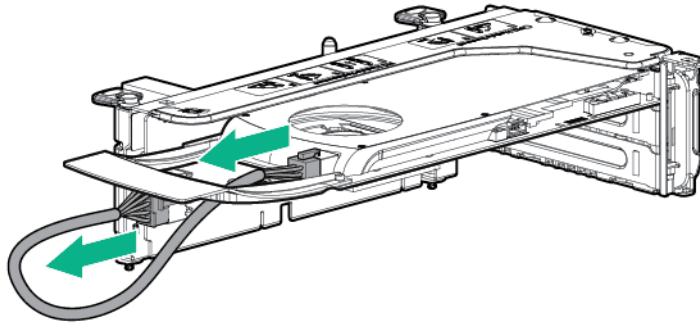
1. During the server startup sequence, press the **F9** key to access RBSU.
2. Select the **Advanced Options** menu.
3. Select **Service Options**.
4. Select **Serial Number**. The following warning appears:
Warning: The serial number should **ONLY** be modified by qualified service personnel. This value should always match the serial number located on the chassis.
5. Press the **Enter** key to clear the warning.
6. Enter the serial number and press the **Enter** key.
7. Select **Product ID**. The following warning appears:
Warning: The Product ID should **ONLY** be modified by qualified service personnel. This value should always match the Product ID located on the chassis.
8. Enter the product ID and press the **Enter** key.
9. Press the **Esc** key to close the menu.
10. Press the **Esc** key to exit RBSU.
11. Press the **F10** key to confirm exiting RBSU. The server automatically reboots.

150W PCIe power cable option



WARNING: To reduce the risk of personal injury, electric shock, or damage to the equipment, remove the power cord to remove power from the server. The front panel Power On/Standby button does not completely shut off system power. Portions of the power supply and some internal circuitry remain active until AC power is removed.

Disconnect the cable as indicated.



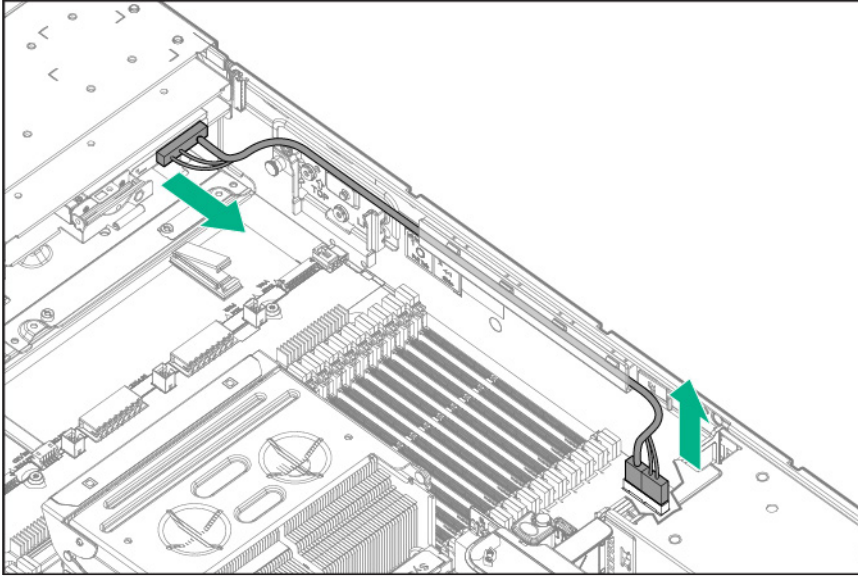
To replace the component, reverse the removal procedure.

Chipset SATA cable option

To remove the component:

1. Power down the server (on page 25).
2. Remove all power:
 - a. Disconnect each power cord from the power source.
 - b. Disconnect each power cord from the server.
3. Extend ("[Extend the server from the rack](#)" on page 26) or remove ("[Remove the server from the rack](#)" on page 27) the server from the rack.
4. Remove the access panel ("[Access panel](#)" on page 30).
5. Remove the air baffle (on page 31).
6. Remove the fan cage ("[Fan cage](#)" on page 41).

7. Disconnect the Chipset SATA cable from the system board and the hard drive backplane and remove from the cable guide.



To replace the component, reverse the removal procedure.

HP Trusted Platform Module

The TPM is not a customer-removable part.



CAUTION: Any attempt to remove an installed TPM from the system board breaks or disfigures the TPM security rivet. Upon locating a broken or disfigured rivet on an installed TPM, administrators should consider the system compromised and take appropriate measures to ensure the integrity of the system data.

If you suspect a TPM board failure, leave the TPM installed and remove the system board. Contact a Hewlett Packard Enterprise authorized service provider for a replacement system board and TPM board.

Troubleshooting

Troubleshooting resources

The *ProLiant Gen8 Troubleshooting Guide, Volume I: Troubleshooting* provides procedures for resolving common problems and comprehensive courses of action for fault isolation and identification, issue resolution, and software maintenance on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hpe.com/support/Gen9_TSG_en)
- French (http://www.hpe.com/support/Gen9_TSG_fr)
- Spanish (http://www.hpe.com/support/Gen9_TSG_es)
- German (http://www.hpe.com/support/Gen9_TSG_de)
- Japanese (http://www.hpe.com/support/Gen9_TSG_ja)
- Simplified Chinese (http://www.hpe.com/support/Gen9_TSG_zh_cn)

The *ProLiant Gen8 Troubleshooting Guide, Volume II: Error Messages* provides a list of error messages and information to assist with interpreting and resolving error messages on ProLiant servers and server blades. To view the guide, select a language:

- English (http://www.hpe.com/support/Gen9_EMG_en)
- French (http://www.hpe.com/support/Gen9_EMG_fr)
- Spanish (http://www.hpe.com/support/Gen9_EMG_es)
- German (http://www.hpe.com/support/Gen9_EMG_de)
- Japanese (http://www.hpe.com/support/Gen9_EMG_ja)
- Simplified Chinese (http://www.hpe.com/support/Gen9_EMG_zh_cn)

HPE Insight Diagnostics

The Insight Diagnostics is a proactive server management tool, available in both offline and online versions, that provides diagnostics and troubleshooting capabilities to assist IT administrators who verify server installations, troubleshoot problems, and perform repair validation.

The Insight Diagnostics Offline Edition performs various in-depth system and component testing while the OS is not running. To run this utility, boot the server using Intelligent Provisioning.

The Insight Diagnostics Online Edition is a web-based application that captures system configuration and other related data needed for effective server management. Available in Microsoft Windows and Linux versions, the utility helps to ensure proper system operation.

For more information or to download the utility, see the Hewlett Packard Enterprise website (<http://www.hpe.com/servers/diags>). The Insight Diagnostics Online Edition is also available in the SPP.

HPE Insight Diagnostics survey functionality

HPE Insight Diagnostics (on page 72) provides survey functionality that gathers critical hardware and software information on ProLiant servers.

This functionality supports operating systems that may not be supported by the server. For operating systems supported by the server, see the Hewlett Packard Enterprise website (<http://www.hpe.com/info/supportos>).

If a significant change occurs between data-gathering intervals, the survey function marks the previous information and overwrites the survey data files to reflect the latest changes in the configuration.

Survey functionality is installed with every SmartStart-assisted Insight Diagnostics installation, or it can be installed through the HPE PSP.

NOTE: The current version of SmartStart provides the memory spare part numbers for the server. To download the latest version, see the Hewlett Packard Enterprise website (<http://www.hpe.com/support/hpesc>).

HPE ROM-Based Setup Utility

RBSU is a configuration utility embedded in HPE ProLiant servers that performs a wide range of configuration activities that can include the following:

- Configuring system devices and installed options
- Enabling and disabling system features
- Displaying system information
- Selecting the primary boot controller
- Configuring memory options
- Language selection

For more information on RBSU, see the *ROM-Based Setup Utility User Guide* on the Documentation CD or the RBSU Information Library (<http://www.hpe.com/info/rbsu/docs>).

Integrated Management Log

The IML records hundreds of events and stores them in an easy-to-view form. The IML timestamps each event with 1-minute granularity.

You can view recorded events in the IML in several ways, including the following:

- From within HPE SIM
- From within operating system-specific IML viewers:
 - For Windows: IML Viewer
 - For Linux: IML Viewer Application
- From within the iLO web interface
- From within Insight Diagnostics ("[HPE Insight Diagnostics](#)" on page 72)

USB support and functionality

USB support

Hewlett Packard Enterprise provides both standard USB 2.0 support and legacy USB 2.0 support. Standard support is provided by the OS through the appropriate USB device drivers. Before the OS loads, Hewlett Packard Enterprise provides support for USB devices through legacy USB support, which is enabled by default in the system ROM.

Legacy USB support provides USB functionality in environments where USB support is not available normally. Specifically, Hewlett Packard Enterprise provides legacy USB functionality for the following:

- POST
- RBSU
- Diagnostics
- DOS
- Operating environments which do not provide native USB support

Internal USB functionality

An internal USB connector is available for use with security key devices and USB drive keys. This solution provides for use of a permanent USB key installed in the internal connector, avoiding issues of clearance on the front of the rack and physical access to secure data.

External USB functionality

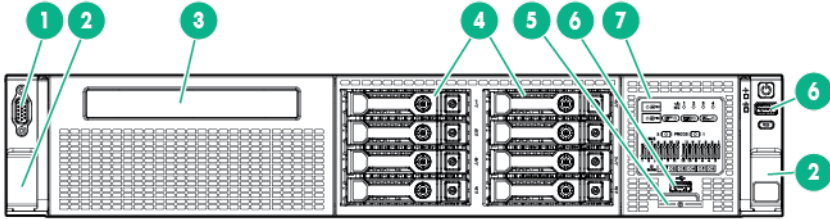
Hewlett Packard Enterprise provides external USB support to enable local connection of USB devices for server administration, configuration, and diagnostic procedures.

For additional security, external USB functionality can be disabled through RBSU.

Component identification

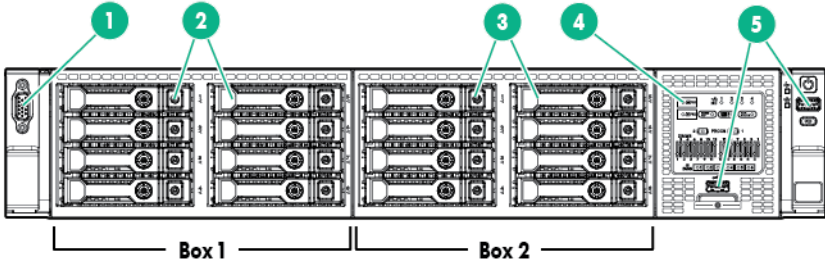
Front panel components

- 8 drive SFF configuration



Item	Description
1	Video connector
2	Quick release levers (2)
3	SATA optical drive bay
4	SFF drive bays
5	Serial number label
6	USB connectors (2)
7	Systems Insight Display

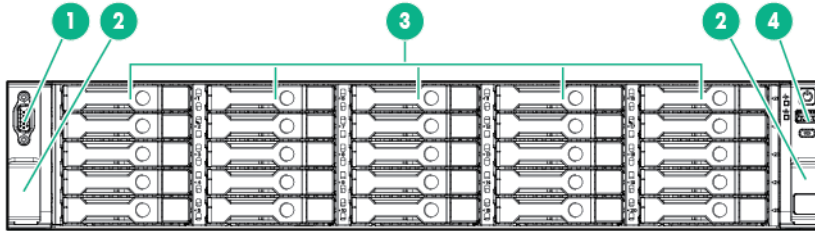
- 16 drive SFF configuration (with optional drive cage)



Item	Description
1	Video connector
2	Drive bays (box 1)
3	Drive bays (box 2)

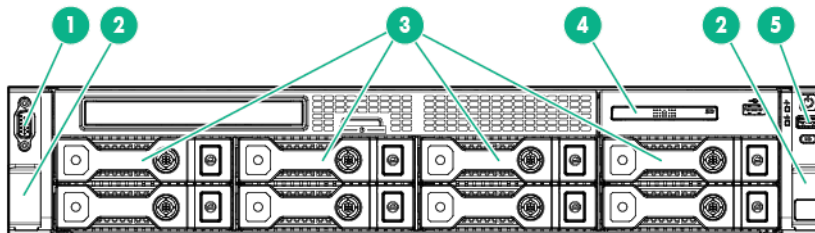
Item	Description
4	Systems Insight Display
5	USB connectors (2)

- 25 SFF drive configuration



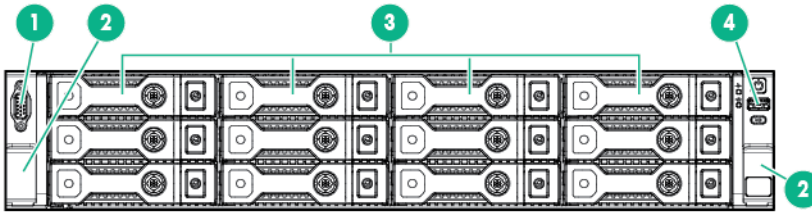
Item	Description
1	Video connector
2	Quick release levers (2)
3	Drive bays
4	USB connector

- 8 drive LFF configuration



Item	Description
1	Video connector
2	Quick release levers (2)
3	Drive bays
4	Systems Insight Display
5	USB connector

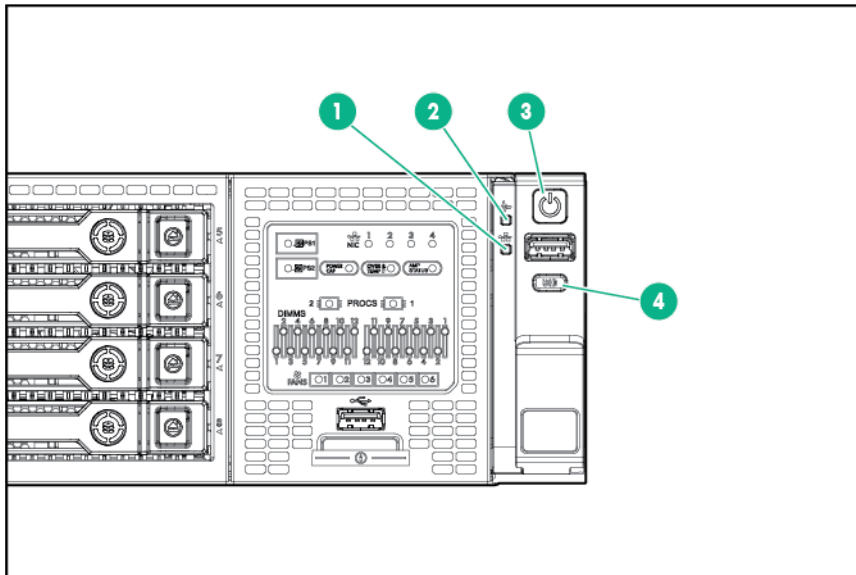
- 12 drive LFF configuration



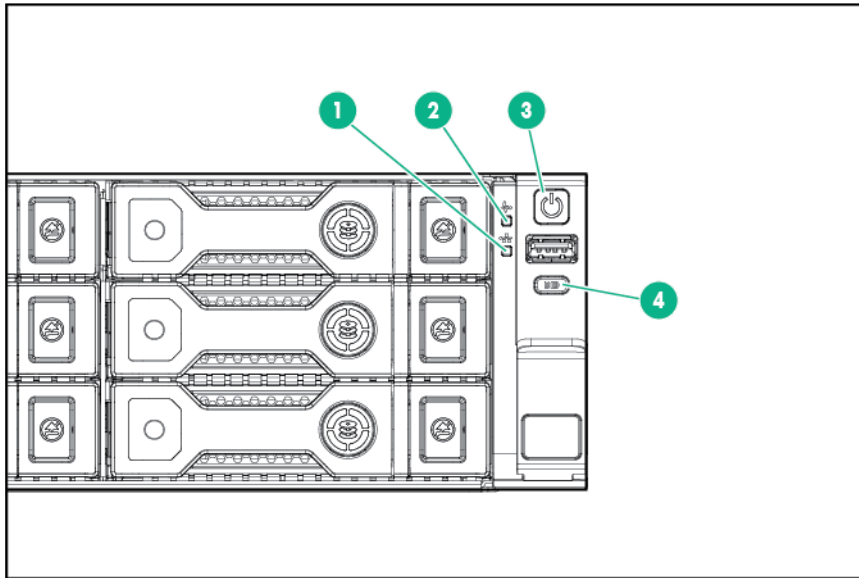
Item	Description
1	Video connector
2	Quick release levers (2)
3	Drive bays
4	USB connector

Front panel LEDs and buttons

- SFF



- LFF



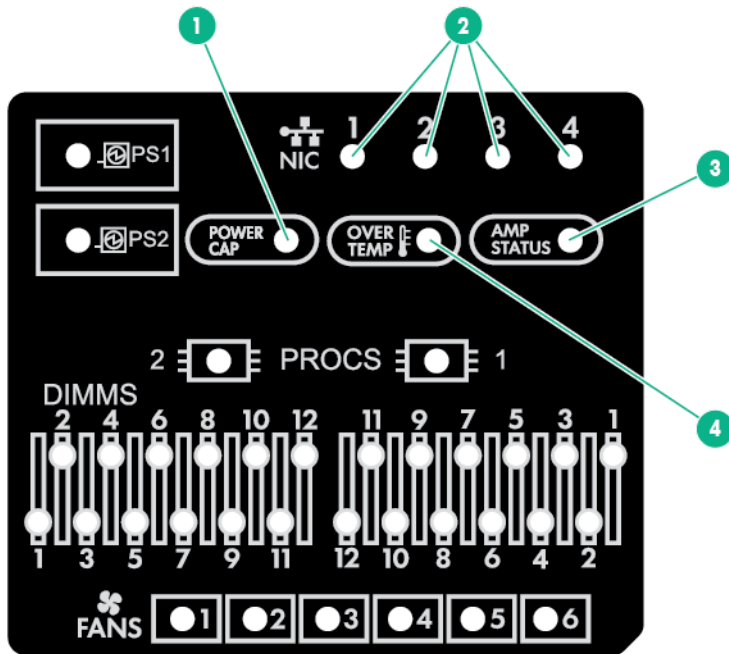
Item	Description	Status
1	NIC status LED	Solid green = Link to network Flashing green (1 Hz/cycle per sec) = Network active Off = No network activity
2	Health LED	Solid green = Normal Flashing amber = System degraded Flashing red (1 Hz/cycle per sec) = System critical Fast-flashing red (4 Hz/cycles per sec) = Power fault*
3	Power On/Standby button and system power LED	Solid green = System on Flashing green (1 Hz/cycle per sec) = Performing power on sequence Solid amber = System in standby Off = No power present**
4	UID button/LED	Solid blue = Activated Flashing blue (1 Hz/cycle per sec) = Remote management or firmware upgrade in progress Off = Deactivated

* To identify components in a degraded or critical state, see the Systems Insight Display LEDs ("[Systems Insight Display](#)" on page 44), check iLO/BIOS logs, and reference the server troubleshooting guide.

** Facility power is not present, power cord is not attached, no power supplies are installed, power supply failure has occurred, or the power button cable is disconnected.

Systems Insight Display LEDs

The Systems Insight Display LEDs represent the system board layout. The display, available on 8 SFF, 16 SFF, and 8 LFF configurations, enables diagnosis with the access panel installed.



Item	Description	Status
1	Power cap	Off = System is in standby, or no cap is set. Solid green = Power cap applied
2	NIC link/activity	Off = No link to network. If the power is off, view the rear panel RJ-45 LEDs for status. Flashing green = Network link and activity Solid green = Network link
3	AMP status	Off = AMP modes disabled Solid green = AMP mode enabled Solid amber = Failover Flashing amber = Invalid configuration
4	Over temp	Off = Normal Solid amber = High system temperature detected
—	All other LEDs	Off = Normal Amber = Failure For more information on the activation of these LEDs, see "Systems Insight Display LED combinations (on page 80)."

Systems Insight Display LED combinations

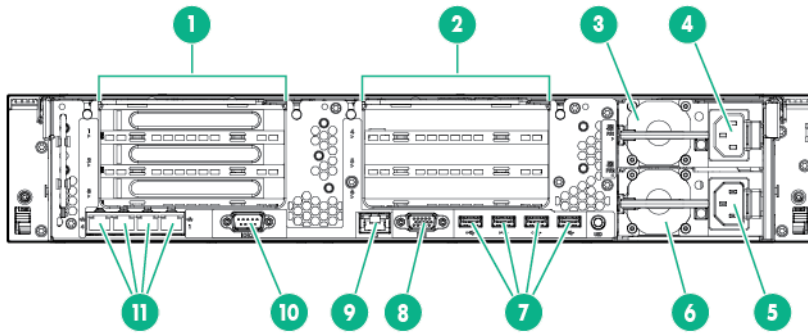
When the health LED on the front panel illuminates either amber or red, the server is experiencing a health event. Combinations of illuminated Systems Insight Display LEDs, the system power LED, and the health LED indicate system status.

Systems Insight Display LED and color	Health LED	System power LED	Status
Processor (amber)	Red	Amber	One or more of the following conditions may exist: <ul style="list-style-type: none"> Processor in socket X has failed. Processor X is not installed in the socket. Processor X is unsupported. ROM detects a failed processor during POST.
Processor (amber)	Amber	Green	Processor in socket X is in a pre-failure condition.
DIMM (amber)	Red	Green	One or more DIMMs have failed.
DIMM (amber)	Amber	Green	DIMM in slot X is in a pre-failure condition.
Over temp (amber)	Amber	Green	The Health Driver has detected a cautionary temperature level.
Over temp (amber)	Red	Amber	The server has detected a hardware critical temperature level.
Fan (amber)	Amber	Green	One fan has failed or has been removed.
Fan (amber)	Red	Green	Two or more fans have failed or been removed.
Power supply (amber)	Red	Amber	One or more of the following conditions may exist: <ul style="list-style-type: none"> Only one power supply is installed and that power supply is in standby. Power supply fault System board fault
Power supply (amber)	Amber	Green	One or more of the following conditions may exist: <ul style="list-style-type: none"> Redundant power supply is installed and only one power supply is functional. AC power cord is not plugged into redundant power supply. Redundant power supply fault Power supply mismatch at POST or power supply mismatch through hot-plug addition
Power cap (off)	—	Amber	Standby
Power cap (off)	—	Flashing green	Waiting for power
Power cap (off)	—	Green	Power is available.



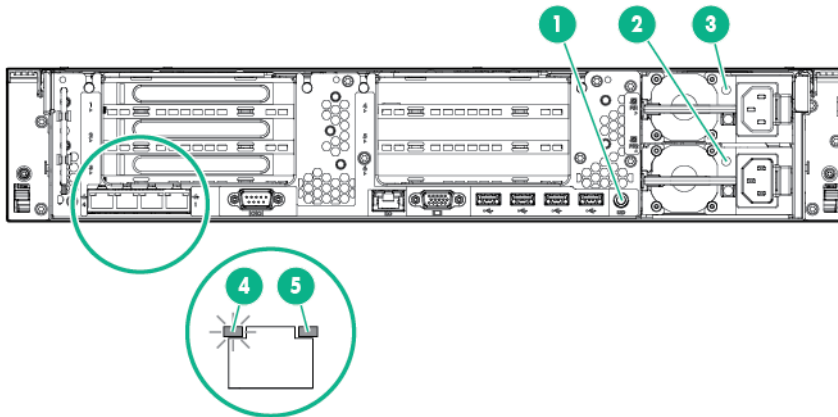
IMPORTANT: If more than one DIMM slot LED is illuminated, further troubleshooting is required. Test each bank of DIMMs by removing all other DIMMs. Isolate the failed DIMM by replacing each DIMM in a bank with a known working DIMM.

Rear panel components



Item	Description
1	PCIe slots 1–3 (top to bottom)
2	PCIe slots 4–6, optional (top to bottom)
3	Power supply 1 (PS1)
4	PS1 power connector
5	PS2 power connector, optional
6	Power supply 2 (PS2), optional
7	USB connectors (4)
8	Video connector
9	iLO connector
10	Serial connector
11	FlexibleLOM ports (Shown: 4x1Gb/Optional: 2x10Gb); port 1 on right side

Rear panel LEDs and buttons



Item	Description	Status
1	UID LED/button	Off = Deactivated Solid blue = Activated Flashing blue = System being managed remotely
2	Power supply 2 LED	Off = System is off or power supply has failed. Solid green = Normal

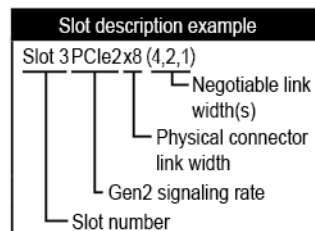
Item	Description	Status
3	Power supply 1 LED	Off = System is off or power supply has failed. Solid green = Normal
4	NIC activity LED	Off = No network activity Solid green = Link to network Flashing green = Network activity
5	NIC link LED	Off = No network link Green = Network link

Non-hot-plug PCIe riser board slot definitions

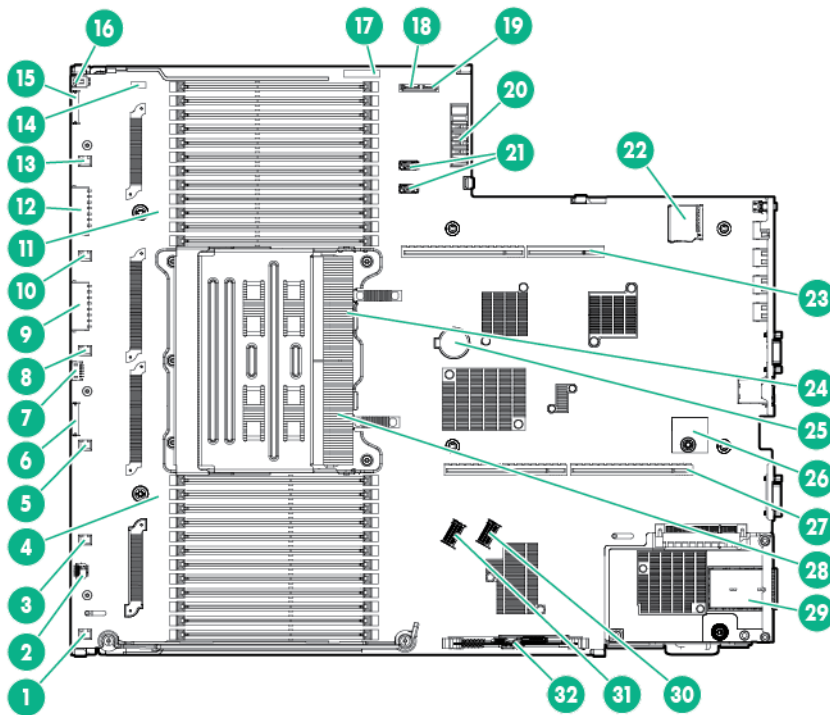
Primary Slot - form factor	PCIe 2 riser slot description	Secondary Slot - form factor	PCIe 2 x16 riser slot description
1 - FL/FH	PCIe2 x16 (8,4,1)	4 - FL/FH	PCIe2 x16 (16, 8, 4, 1)
2 - HL/FH	PCIe2 x8 (8,4,1)	5 - HL/FH	PCIe2 x16 (8, 4, 1)
3 - HL/FH	PCIe2 x8 (4,1)	6 - HL/FH	PCIe2 x8 (8, 4, 1)

Notes:

- "Primary" denotes the riser cage is installed in the primary riser connector.
- "Secondary" denotes the riser cage is installed in the secondary riser connector.
- Installing the riser cages listed in the table above in either the primary or secondary riser connectors determines the form factor of the PCI cards supported by those riser cages.
- FL/FH denotes full-length, full-height. HL/FH denotes half-length, full-height. LP denotes low profile.
- The riser cages support a maximum power of 150 W with a Hewlett Packard Enterprise power cable. This cable must be used for PCIe card wattages greater than 75 W.



System board components



Item	Description
1	Fan connector 6
2	Systems Insight Display connector
3	Fan connector 5
4	Processor 1 DIMM slots
5	Fan connector 4
6	Front I/O connector
7	Front USB connector
8	Fan connector 3
9	First drive cage
10	Fan connector 2
11	Processor 2 DIMM slots
12	Second drive cage
13	Fan connector 1
14	NMI jumper
15	Front video connector
16	Discovery services connector
17	System maintenance switch
18	SATA optical drive connector
19	SATA drive port 1
20	Power supply backplane connector
21	USB connector
22	SD card slot
23	Secondary (processor 2) PCIe riser connector
24	Processor 2 socket

Item	Description
25	System battery
26	TPM connector
27	Primary (processor 1) PCIe riser connector
28	Processor 1 socket
29	FlexibleLOM
30	SAS port 1i
31	SAS port 2i
32	SAS cache module connector

System maintenance switch

Position	Default	Function
S1	Off	Off = iLO security is enabled. On = iLO security is disabled.
S2	Off	Off = System configuration can be changed. On = System configuration is locked.
S3	Off	Reserved
S4	Off	Reserved
S5	Off	Off = Power-on password is enabled. On = Power-on password is disabled.
S6	Off	Off = No function On = ROM reads system configuration as invalid.
S7	—	Reserved
S8	—	Reserved
S9	—	Reserved
S10	—	Reserved
S11	—	Reserved
S12	—	Reserved

To access the redundant ROM, set S1, S5, and S6 to on.

When the system maintenance switch position 6 is set to the On position, the system is prepared to erase all system configuration settings from both CMOS and NVRAM.



CAUTION: Clearing CMOS and/or NVRAM deletes configuration information. Be sure to properly configure the server or data loss could occur.

NMI functionality

An NMI crash dump enables administrators to create crash dump files when a system is hung and not responding to traditional debug mechanisms.

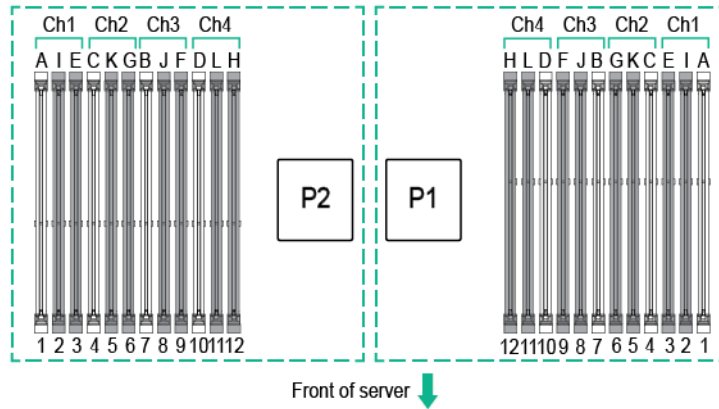
Crash dump log analysis is an essential part of diagnosing reliability problems, such as hangs in operating systems, device drivers, and applications. Many crashes freeze a system, and the only available action for administrators is to cycle the system power. Resetting the system erases any information that could support problem analysis, but the NMI feature preserves that information by performing a memory dump before a hard reset.

To force the OS to invoke the NMI handler and generate a crash dump log, the administrator can use the iLO Virtual NMI feature.

For more information, see the Hewlett Packard Enterprise website (<http://www.hpe.com/support/NMI>).

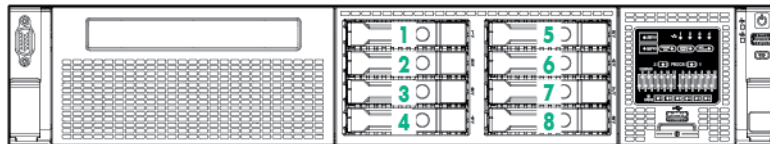
DIMM slot locations

DIMM slots are numbered sequentially (1 through 12) for each processor. The supported AMP modes use the letter assignments for population guidelines.

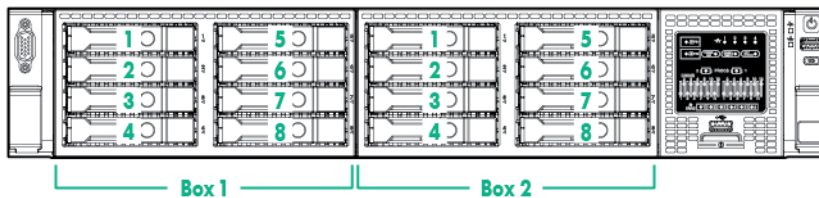


SAS and SATA device numbers

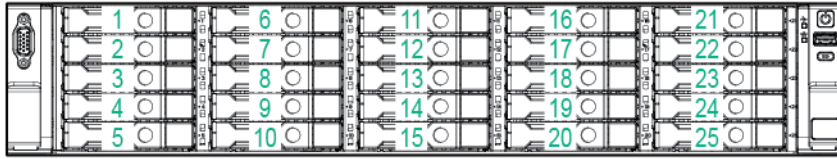
- 8 SFF device bay numbering



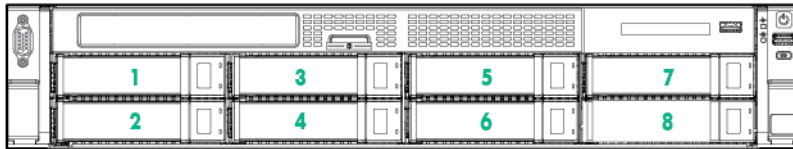
- 16 SFF device bay numbering



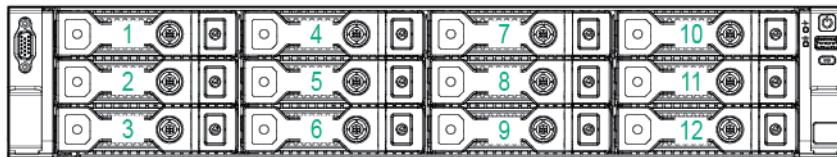
- 25 SFF device bay numbering



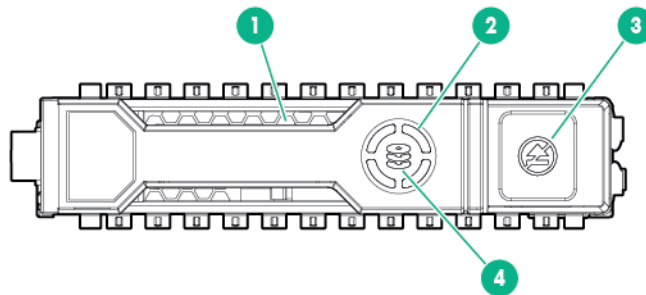
- 8 LFF device bay numbering



- 12 LFF device bay numbering



Hot-plug drive LED definitions



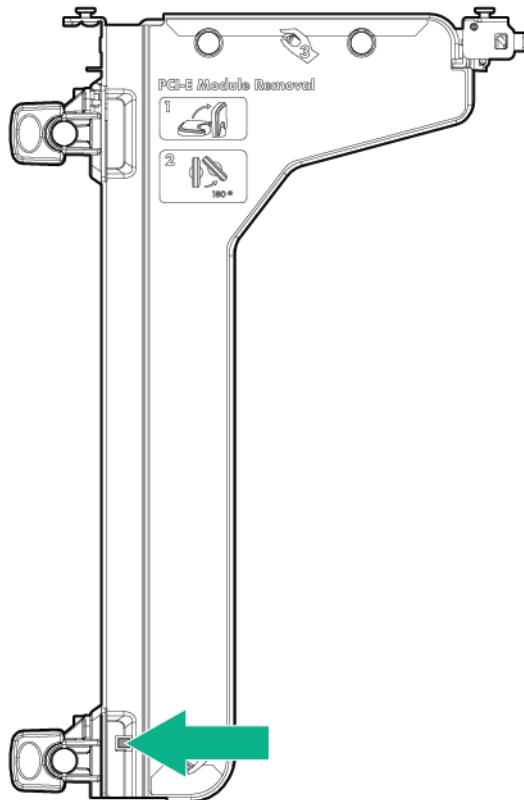
Item	LED	Status	Definition
1	Locate	Solid blue	The drive is being identified by a host application.
		Flashing blue	The drive carrier firmware is being updated or requires an update.
2	Activity ring	Rotating green	Drive activity

Item	LED	Status	Definition
		Off	No drive activity
3	Do not remove	Solid white	Do not remove the drive. Removing the drive causes one or more of the logical drives to fail.
		Off	Removing the drive does not cause a logical drive to fail.
4	Drive status	Solid green	The drive is a member of one or more logical drives.
		Flashing green	The drive is rebuilding or performing a RAID migration, strip size migration, capacity expansion, or logical drive extension, or is erasing.
		Flashing amber/green	The drive is a member of one or more logical drives and predicts the drive will fail.
		Flashing amber	The drive is not configured and predicts the drive will fail.
		Solid amber	The drive has failed.
		Off	The drive is not configured by a RAID controller.

PCIe riser cage LED



CAUTION: To prevent damage to the server or expansion boards, power down the server and remove all AC power cords before removing or installing the PCIe riser cage.



Status

On = AC power is connected.

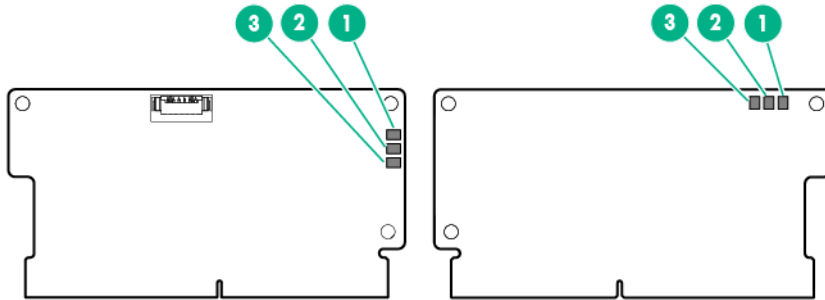
Status

Off = AC power is disconnected.

Missing = Riser cage is not installed, or power might not be connected.

FBWC module LEDs (P222, P420, P421)

The FBWC module has three single-color LEDs (one amber and two green). The LEDs are duplicated on the reverse side of the cache module to facilitate status viewing.



1 - Amber	2 - Green	3 - Green	Interpretation
Off	Off	Off	The cache module is not powered.
Off	Flashing 0.5 Hz	Flashing 0.5 Hz	The cache microcontroller is executing from within its boot loader and receiving new flash code from the host controller.
Off	Flashing 1 Hz	Flashing 1 Hz	The cache module is powering up, and the capacitor pack is charging.
Off	Off	Flashing 1 Hz	The cache module is idle, and the capacitor pack is charging.
Off	Off	On	The cache module is idle, and the capacitor pack is charged.
Off	On	On	The cache module is idle, the capacitor pack is charged, and the cache contains data that has not yet been written to the drives.
Off	Flashing 1 Hz	Off	A backup is in progress.
Off	On	Off	The current backup is complete with no errors.
Flashing 1 Hz	Flashing 1 Hz	Off	The current backup failed, and data has been lost.
Flashing 1 Hz	Flashing 1 Hz	On	A power error occurred during the previous or current boot. Data may be corrupt.
Flashing 1 Hz	On	Off	An overtemperature condition exists.
Flashing 2 Hz	Flashing 2 Hz	Off	The capacitor pack is not attached.
Flashing 2 Hz	Flashing 2 Hz	On	The capacitor has been charging for 10 minutes, but has not reached sufficient charge to perform a full backup.
On	On	Off	The current backup is complete, but power fluctuations occurred during the backup.
On	On	On	The cache module microcontroller has failed.

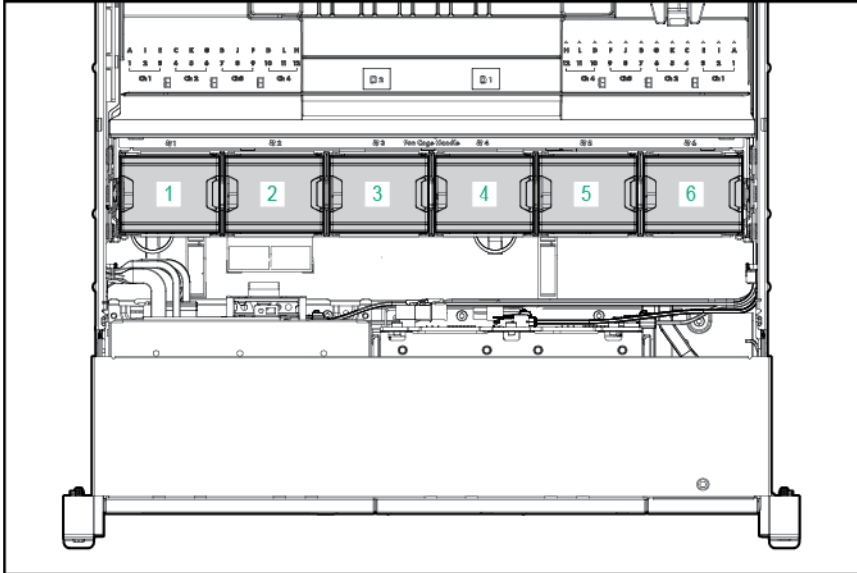
Hot-plug fans



CAUTION: To avoid damage to server components, fan blanks must be installed in fan bays 1 and 2 in a single-processor configuration.

The only two valid fan configurations are listed in the following table.

Configuration	Fan bay 1	Fan bay 2	Fan bay 3	Fan bay 4	Fan bay 5	Fan bay 6
1 processor	Fan blank	Fan blank	Fan	Fan	Fan	Fan
2 processors	Fan	Fan	Fan	Fan	Fan	Fan



For a single-processor configuration, four fans and two blanks are required in specific fan bays for redundancy. A fan failure or missing fan causes a loss of redundancy. A second fan failure or missing fan causes an orderly shutdown of the server.

Installing more than the required number of fans in a single-processor configuration is not a supported configuration.

For a dual-processor configuration, six fans are required for redundancy. A fan failure or missing fan causes a loss of redundancy. A second fan failure or missing fan causes an orderly shutdown of the server.

The server supports variable fan speeds. The fans operate at minimum speed until a temperature change requires a fan speed increase to cool the server. The server shuts down during the following temperature-related scenarios:

- At POST and in the OS, iLO performs an orderly shutdown if a cautionary temperature level is detected. If the server hardware detects a critical temperature level before an orderly shutdown occurs, the server performs an immediate shutdown.
- When the Thermal Shutdown feature is disabled in RBSU, iLO does not perform an orderly shutdown when a cautionary temperature level is detected. Disabling this feature does not disable the server hardware from performing an immediate shutdown when a critical temperature level is detected.

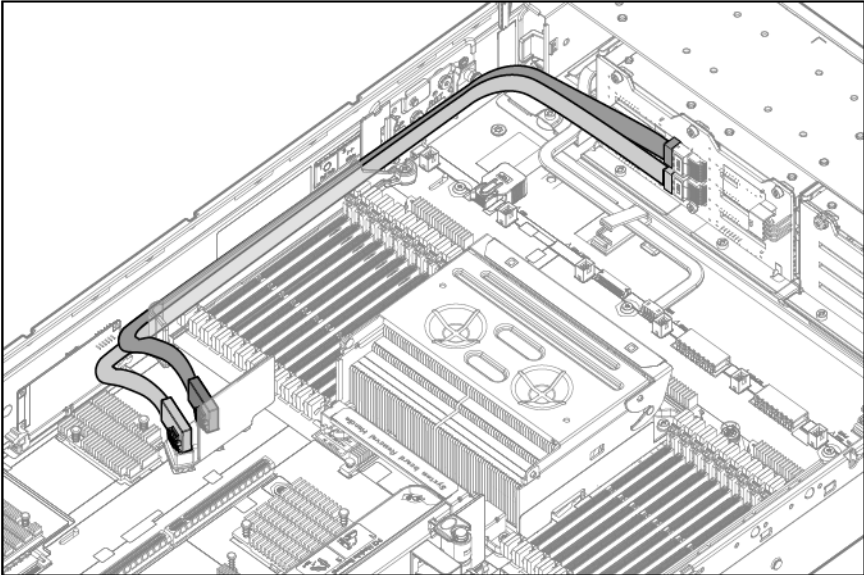


CAUTION: A thermal event can damage server components when the Thermal Shutdown feature is disabled in RBSU.

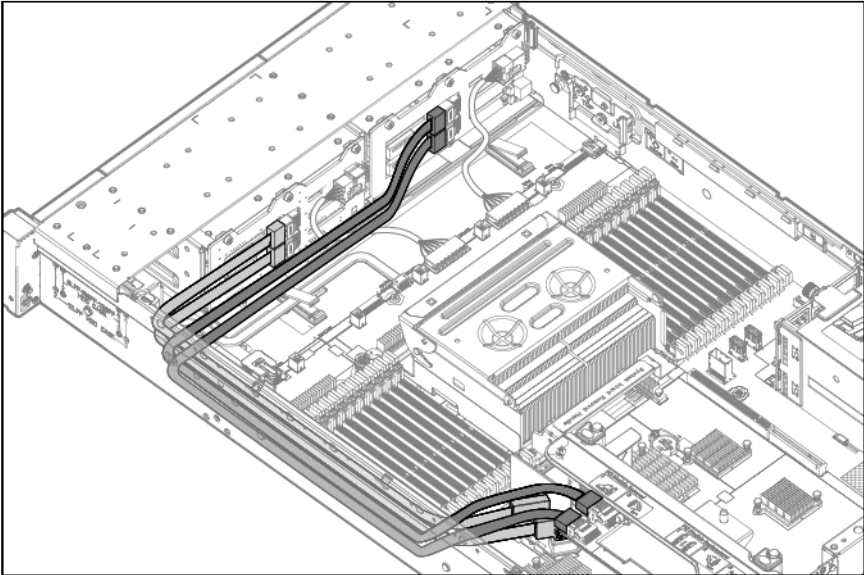
Cabling

SAS hard drive cabling

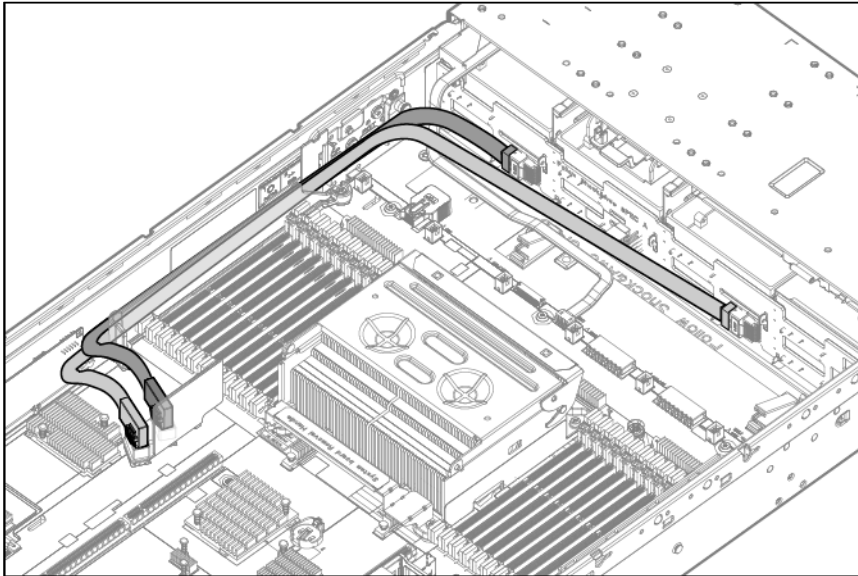
- SFF hard drive cabling



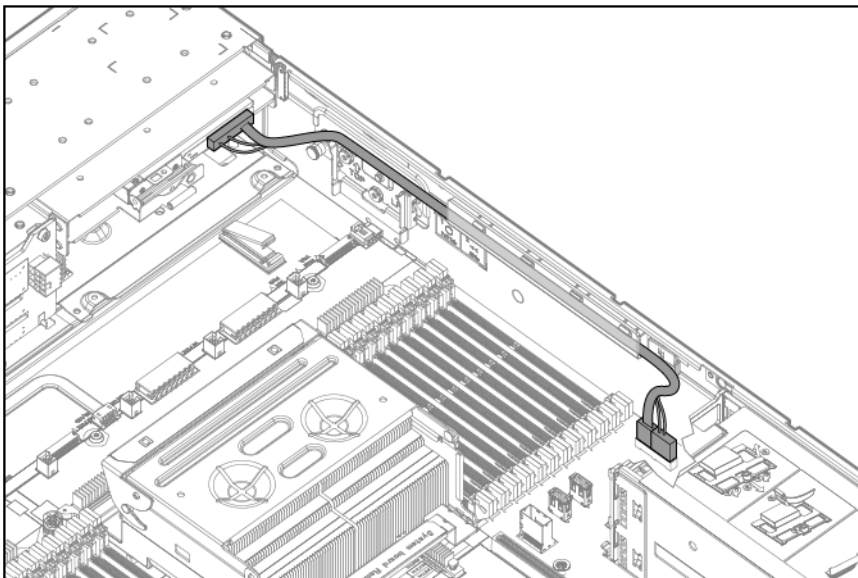
- SFF cabling, with optional drive cage



- LFF hard drive cabling

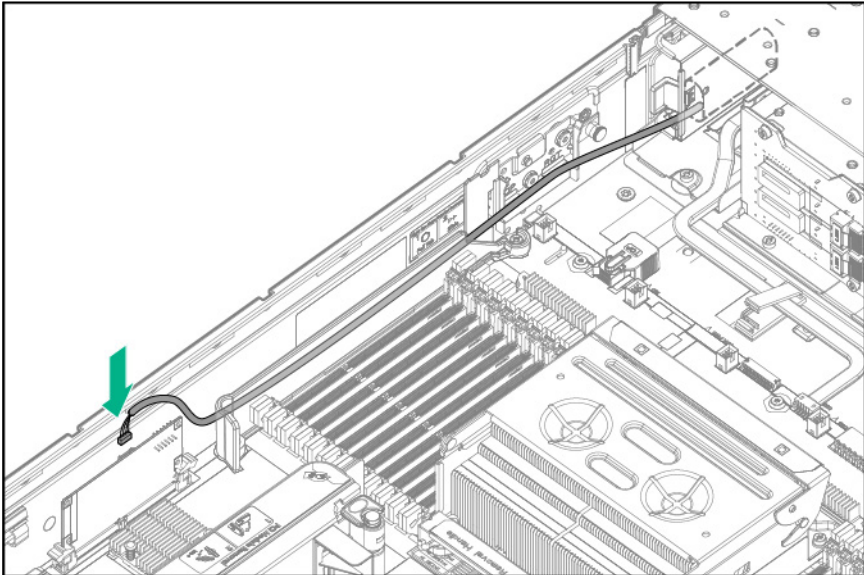


Optical drive cabling

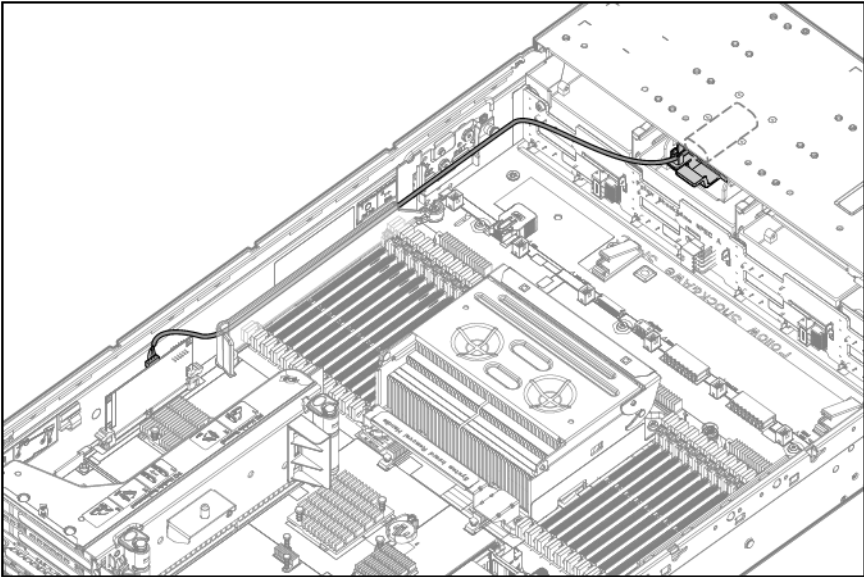


FBWC cabling

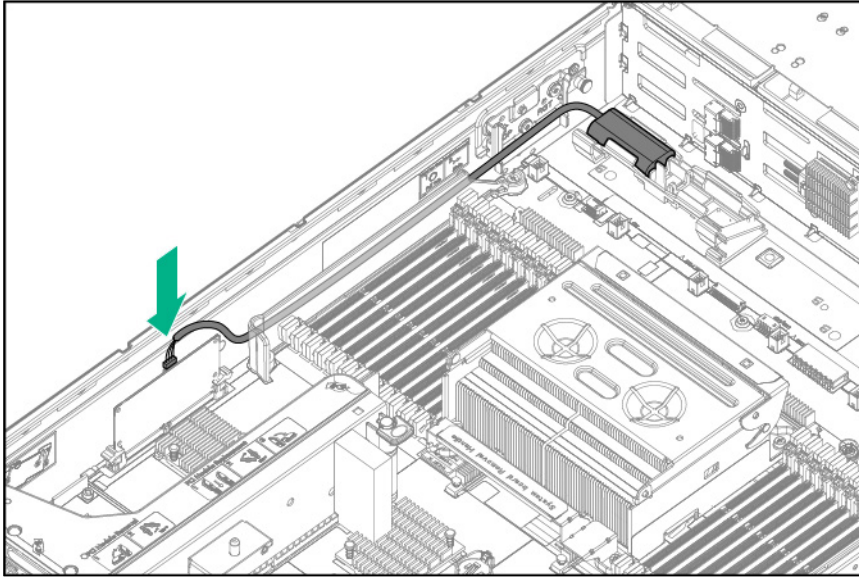
- 8 or 16 drive SFF



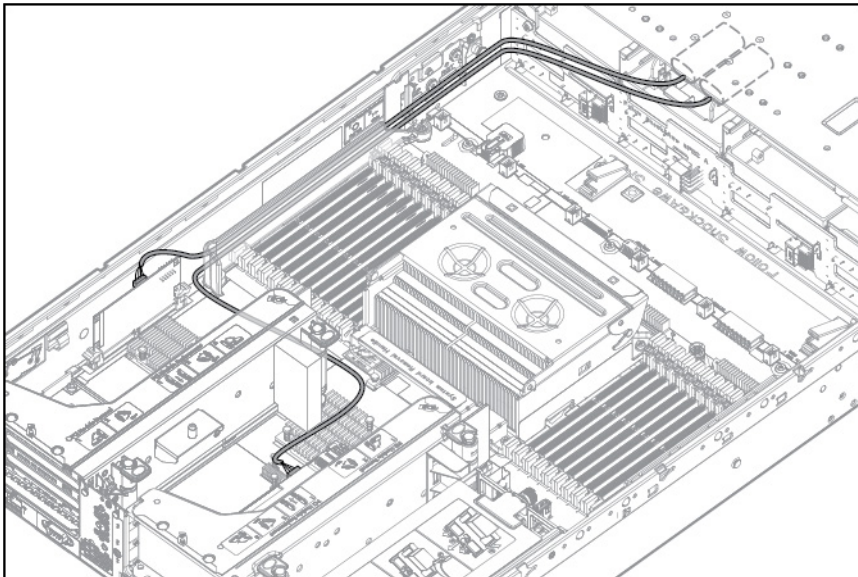
- 8 drive LFF



- 12 LFF or 25 SFF



- PCIe option
Depending on the server configuration, you may need to remove the primary PCIe riser cage (on page 33) before cabling to a PCIe expansion board.



Specifications

Environmental specifications

Specification	Value
Temperature range*	
Operating	10°C to 35°C (50°F to 95°F)
Shipping	-30°C to 50°C (-22°F to 122°F)
Storage	-30°C to 60°C (-22°F to 140°F)
Maximum wet bulb temperature	28°C (82.4°F)
Relative humidity (noncondensing)**	
Operating	10% to 90%
Non-operating	5% to 95%

* All temperature ratings shown are for sea level. An altitude derating of 1°C per 300 m (1.8°F per 1,000 ft) to 3048 m (10,000 ft) is applicable. No direct sunlight allowed.

** Storage maximum humidity of 95% is based on a maximum temperature of 45°C (113°F). Altitude maximum for storage corresponds to a pressure minimum of 70 KPa.

Mechanical specifications

Specification	Value
Height	8.73 cm (3.44 in)
Depth, SFF	69.85 cm (27.50 in)
Depth, LFF	74.93 cm (29.5 in)
Width	44.55 cm (17.54 in)
Weight, 8 LFF	22.63-30.19 kg (49.9-65.5 lb)
Weight, 12 LFF	20.02-32.66 kg (44.1-72 lb)
Weight, 8 SFF	23.53-28.08 kg (51.9-61.9 lb)
Weight, 16 SFF	19.92 kg–27.76 kg (43.9 lb–61.2 lb)
Weight, 25 SFF	21.15 kg–28.37 kg (46.6 lb–62.5 lb)

Power supply specifications

Depending on installed options, the server is configured with one of the following power supplies:

- 460 W CS Gold power supply (92% efficiency) (on page [95](#))
- 460 W CS Platinum Plus power supply (94% efficiency) (on page [95](#))
- 750 W CS Gold power supply (92% efficiency) (on page [95](#))
- 750 W CS Platinum Plus power supply (94% efficiency) (on page [96](#))
- 750 W 48V CS DC power supply (94% efficiency) (on page [96](#))
- 1200 W CS Platinum Plus power supply (90% efficiency) (on page [97](#))

For detailed power supply specifications, see the quickspecs on the Hewlett Packard Enterprise website (<http://www.hpe.com/info/Quickspecs-Moonshot-1500Chassis>).

460 W CS Gold power supply (92% efficiency)

Specification	Value
Input requirements	
Rated input voltage	100V to 240V AC
Rated input frequency	50 Hz or 60 Hz
Rated input current	5.5A to 2.2A
Rated input power	526 W at 100 V AC input 505 W at 200 V AC input
Btus per hour	1794 at 100 V AC input 1725 at 200 V AC input
Power supply output	
Rated steady-state power	460 W at 100 V to 120 V AC input 460 W at 200 V to 240 V AC input
Maximum peak power	460 W at 100 V to 120 V AC input 460 W at 200 V to 240 V AC input

460 W CS Platinum Plus power supply (94% efficiency)

Specification	Value
Input requirements	
Rated input voltage	100V to 240V AC
Rated input frequency	50 Hz or 60 Hz
Rated input current	5.2A to 2.1A
Rated input power	509 W at 115 V AC input 495 W at 230 V AC input
Btus per hour	1764 at 100 V AC 1694 at 200 V AC
Power supply output	
Rated steady-state power	460 W at 100 V to 120 V AC input 460 W at 200 V to 240 V AC input
Maximum peak power	460 W at 100 V to 120 V AC input 460 W at 200 V to 240 V AC input

750 W CS Gold power supply (92% efficiency)

Specification	Value
Input requirements	
Rated input voltage	100V to 240V AC
Rated input frequency	50 to 60 Hz
Rated input current	8.9A to 3.6A
Rated input power	857 W at 100 V AC input 824 W at 200 V AC input
Btus per hour	2925 at 100 V AC input 2812 at 200 V AC input
Power supply output	

Rated steady-state power	750 W at 100 V to 120 V AC input 750 W at 200 V to 240 V AC input
Maximum peak power	750 W at 100 V to 120 V AC input 750 W at 200 V to 240 V AC input

750 W CS Platinum Plus power supply (94% efficiency)

Specification	Value
Input requirements	
	—
Rated input voltage	100V to 240V AC
Rated input frequency	50 Hz to 60 Hz
Rated input current	8.5A to 3.5A
Maximum rated input power	831 W at 115 V AC input 808 W at 230 V AC input
Btus per hour	2878 at 100 V AC 2769 at 200 V AC
Power supply output	
	—
Rated steady-state power	750 W at 100 V to 120 V AC input 750 W at 200 V to 240 V AC input
Maximum peak power	750 W at 100 V to 120 V AC input 750 W at 200 V to 240 V AC input

750 W 48V CS DC power supply (94% efficiency)

Specification	Value
Input requirements	
	—
Rated input voltage	-36V to -72V DC -48V DC, nominal input
Rated input frequency	DC
Rated input current	2.3A at -36V DC 12A at -72V DC 17A at -48V DC, nominal input
Rated input power	840 W at -36V DC input 830 W at -72V DC input 820 W at -48V DC, nominal input
Btus per hour	2865 at -36V DC input 2830 at -72V DC input 2796 at -48V DC, nominal input
Power supply output	
	—
Rated steady-state power	750 W
Rated peak power	750 W



CAUTION: This equipment is designed to permit the connection of the earthed conductor of the DC supply circuit to the earthing conductor at the equipment.

If this connection is made, all of the following must be met:

- This equipment must be connected directly to the DC supply system earthing electrode conductor or to a bonding jumper from an earthing terminal bar or bus to which the DC supply system earthing electrode conductor is connected.
- This equipment must be located in the same immediate area (such as adjacent cabinets) as any other equipment that has a connection between the earthed conductor of the same DC

supply circuit and the earthing conductor, and also the point of earthing of the DC system. The DC system must be earthed elsewhere.

- The DC supply source is to be located within the same premises as the equipment.
 - Switching or disconnecting devices must not be in the earthed circuit conductor between the DC source and the point of connection of the earthing electrode conductor.
-



CAUTION: To reduce the risk of electric shock or energy hazards:

- This equipment must be installed by trained service personnel, as defined by the NEC and IEC 60950-1, Second Edition, the standard for Safety of Information Technology Equipment.
 - Connect the equipment to a reliably grounded SELV source. An SELV source is a secondary circuit that is designed so normal and single fault conditions do not cause the voltages to exceed a safe level (60 V DC).
 - The branch circuit overcurrent protection must be rated 24 A.
-

1200 W CS Platinum Plus Power Supply (90% efficiency)

Specification	Value
Input requirements	—
Rated input voltage	100V AC to 240V AC
Rated input frequency	50 Hz to 60 Hz
Rated input current	9.1A to 5.5A
Maximum rated input power	897 W at 100V AC input 1321 W at 200V AC input
Btus per hour	3061 at 100V AC input 4506 at 200V AC input
Power supply output	—
Rated steady-state power	800 W at 100V AC input 900 W at 120V AC input 1200 W at 200V to 240V AC input
Maximum peak power	800 W at 100V AC input 900 W at 120V AC input 1200 W at 200V to 240V AC input

Acronyms and abbreviations

FBWC

flash-backed write cache

iLO

Integrated Lights-Out

IML

Integrated Management Log

NMI

nonmaskable interrupt

NVRAM

nonvolatile memory

PCIe

Peripheral Component Interconnect Express

POST

Power-On Self Test

RBSU

ROM-Based Setup Utility

SAS

serial attached SCSI

SATA

serial ATA

SR

semi-rigid

STR

straight (connector)

TPM

Trusted Platform Module

UID

unit identification

USB

universal serial bus

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Index

1

150W PCIe power cable 69

A

AC power supply 37, 95, 96, 97
access panel 30
air baffle 31

B

battery 62
blue screen event 84
buttons 75

C

cable management arm 28
cables 90
cabling 90, 91
cache module 46
cautions 30
chipset SATA cable 70
components 15, 25, 75
components, identification 15, 75
connectors 75
crash dump analysis 84
CSR (customer self repair) 5
customer self repair (CSR) 5

D

data recovery 51
DC power supply 95, 96, 97
diagnostic tools 72
diagnostics utility 72
DIMM slot locations 85
DIMMs 61, 85
drive LEDs 86
drives 36, 86

E

environmental specifications 94
error messages 72
expansion boards 52, 53
expansion slot blanks 52, 53
extending server from rack 26
external USB functionality 74

F

fan cage 41
fans 40
FBWC cabling 92
FBWC module 88
features 75
flash-backed write cache capacitor pack 48
flash-backed write cache module 47
flash-backed write cache procedures 46, 51
FlexibleLOM 42
front panel assembly 45
front panel components 75

H

half-length expansion board 52
hard drive bays 75
hard drive blanks 36
hard drive cage 44
hard drive LEDs 86
hard drives, determining status of 86
heatsink 54
hot-plug fans 28, 40, 88
HPE Insight Diagnostics 72
HPE Technical Support 5

I

illustrated parts catalog 15
iLO (Integrated Lights-Out) 73
IML (Integrated Management Log) 73
Insight Diagnostics 72
Integrated Lights-Out (iLO) 73
Integrated Management Log (IML) 73
internal USB functionality 74

L

LEDs 86
LEDs, front panel 86
LEDs, hard drive 86
LEDs, SAS hard drive 86
LEDs, troubleshooting 72, 87

M

maintenance 25
mechanical components 15
mechanical specifications 94
memory dump 84

N

NIC connectors 81

O

operating system crash 84
optical drive 38, 75
optical drive cable 91

P

part numbers 15
PCI expansion slot definitions 82
PCI expansion slots 82
PCI riser cage 33, 34
PCIe riser blank 32
PCIe riser cage 34
POST error messages 72
power cables 69
power supplies 37, 94, 95, 96, 97
power supply 37
power supply backplane 39
power supply blank 37
power supply specifications 94, 95, 96, 97
powering down 25
preparation procedures 25
problem diagnosis 72
processors 56

R

rack, extending server from 29
RBSU (ROM-Based Setup Utility) 73
rear panel components 81
rear panel LEDs 81
rear panel, accessing 28
recovering the data from the cache 51
removal and replacement procedures 25
removing server from rack 27

S

safety considerations 29
SAS and SATA device numbers 85
spare part numbers 15, 19
specifications 94, 95, 96, 97
specifications, environmental 94
specifications, mechanical 94
specifications, power 94, 95, 96, 97
specifications, server 94
switches 84
symbols on equipment 29
system battery 62
system board components 83
system board replacement 63
system components 19, 75
system maintenance switch 84
system power LED 77

Systems Insight Display 27, 44, 75, 79, 80
Systems Insight Display LEDs 79, 80

T

technical support 5
tools 25
TPM (Trusted Platform Module) 71
TPM connector 83
troubleshooting 72

U

UID LED 84
USB connector 75
USB support 73, 74
utilities, deployment 73

V

video connector 75

W

warnings 30